



Relion® 670 series

Line differential protection RED670 ANSI Installation and commissioning manual



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This product complies with the directive of the Council of the European Communities on the approximation of the laws of the Member States relating to electromagnetic compatibility (EMC Directive 2004/108/EC) and concerning electrical equipment for use within specified voltage limits (Low-voltage directive 2006/95/EC). This conformity is the result of tests conducted by ABB in accordance with the product standards EN 50263 and EN 60255-26 for the EMC directive, and with the product standards EN 60255-1 and EN 60255-27 for the low voltage directive. The IED is designed in accordance with the international standards of the IEC 60255 series and ANSI C37.90.

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Section 1 Introduction

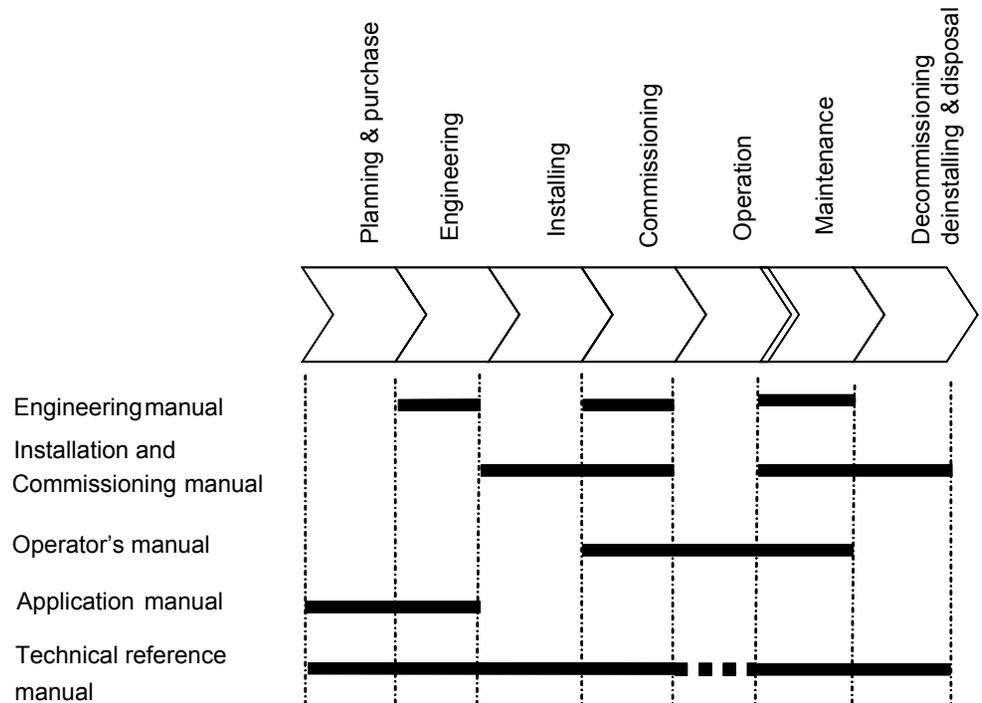
About this chapter

This chapter introduces the user to the manual.

1.1 Introduction to the installation and commissioning manual

1.1.1 About the complete set of manuals for an IED

The user's manual (UM) is a complete set of five different manuals:



IEC09000744-1-en.vsd

The Application Manual (AM) contains application descriptions, setting guidelines and setting parameters sorted per function. The application manual should be used to

find out when and for what purpose a typical protection function could be used. The manual should also be used when calculating settings.

The Technical Reference Manual (TRM) contains application and functionality descriptions and it lists function blocks, logic diagrams, input and output signals, setting parameters and technical data sorted per function. The technical reference manual should be used as a technical reference during the engineering phase, installation and commissioning phase, and during normal service.

The Installation and Commissioning Manual (ICM) contains instructions on how to install and commission the protection IED. The manual can also be used as a reference during periodic testing. The manual covers procedures for mechanical and electrical installation, energizing and checking of external circuitry, setting and configuration as well as verifying settings and performing directional tests. The chapters are organized in the chronological order (indicated by chapter/section numbers) in which the protection IED should be installed and commissioned.

The Operator's Manual (OM) contains instructions on how to operate the protection IED during normal service once it has been commissioned. The operator's manual can be used to find out how to handle disturbances or how to view calculated and measured network data in order to determine the cause of a fault.

The Engineering Manual (EM) contains instructions on how to engineer the IEDs using the different tools in PCM600. The manual provides instructions on how to set up a PCM600 project and insert IEDs to the project structure. The manual also recommends a sequence for engineering of protection and control functions, LHMI functions as well as communication engineering for IEC 61850 and DNP3.

1.1.2

About the installation and commissioning manual

The installation and commissioning manual contains the following chapters:

- The chapter [Safety information](#) presents warning and note signs, that the user should pay attention to.
- The chapter [Overview](#) is a summary of the major tasks faced when installing and commissioning an IED.
- The chapter [Unpacking and checking the IED](#) explains how to take delivery of the IED.
- The chapter [Installing the IED](#) explains how to install the IED.
- The chapter [Checking the external optical and electrical connections](#) explains how to check that the IED is properly connected to the protection system.
- The chapter [Energizing the IED](#) explains how to start the IED.
- The chapter [Set up PCM 600 communication link per IED](#) describes the communication between PCM600 and the IED.
- The chapter [Establishing connection and verifying the SPA/IEC- communication](#) contains explains how to enter SPA/IEC settings and verifying the communication.

- The chapter [Establishing connection and verifying the LON communication](#) contains a reference to another document.
- The chapter [Establishing connection and verifying the IEC 61850 communication](#) contains explains how to enter IEC 61850 settings and verifying the communication.
- The chapter [Configuring the IED and changing settings](#)” explains how to write settings and configure the IED.
- The chapter [Verifying settings by secondary injection](#) contains instructions on how to verify that each included function operates correctly according to the set values.
- The chapter [Commissioning and maintenance of the fault clearing system](#) discusses maintenance tests and other periodic maintenance measures.
- The chapter [Fault tracing and repair](#) explains how to troubleshoot.
- The chapter [Glossary](#) is a list of terms, acronyms and abbreviations used in ABB technical documentation.

1.1.3 Intended audience

General

The installation and commissioning manual addresses the personnel responsible for the installation, commissioning, maintenance and taking the protection in and out of normal service.

Requirements

The installation and commissioning personnel must have a basic knowledge in handling electronic equipment. The commissioning and maintenance personnel must be well experienced in using protection equipment, test equipment, protection functions and the configured functional logics in the protection.

1.1.4 Related documents

Documents related to RED670	Identity number
Operator's manual	1MRK 505 184-UUS
Installation and commissioning manual	1MRK 505 185-UUS
Technical reference manual	1MRK 505 183-UUS
Application manual	1MRK 505 186-UUS
Buyer's guide	1MRK 505 188-BUS
Sample specification	SA2005-001281
Connection diagram, Single breaker arr. Three-pole tripping arr.	1MRK 002 801-BA
Connection diagram, Single breaker arr. Single-pole tripping arr.	1MRK 002 801-CA
Connection diagram, Multi breaker arr. Three-pole tripping arr.	1MRK 002 801-DA

Table continues on next page

Documents related to RED670	Identity number
Connection diagram, Multi breaker arr. Single-pole tripping arr.	1MRK 002 801-EA
Configuration diagram A, Single breaker with single or double busbars	1MRK 004 500-82
Configuration diagram B, Single breakers with single or double busbars	1MRK 004 500-83
Configuration diagram C, Multi breakers such as breaker-and-a-half or ring busbar arr.	1MRK 004 500-84
Configuration diagram D, Multi breakers such as breaker-and-a-half or ring busbar arr.	1MRK 004 500-85
Setting example 1, 230 kV Short cable line with breaker-and-a-halfCB arr.	1MRK 505 175-WEN
Connection and Installation components	1MRK 513 003-BEN
Test system, COMBITEST	1MRK 512 001-BEN
Accessories for IED 670	1MRK 514 012-BEN
Getting started guide IED 670	1MRK 500 080-UUS
SPA and LON signal list for IED 670, ver. 1.1	1MRK 500 083-WEN
IEC 61850 Data objects list for IED 670, ver. 1.1	1MRK 500 084-WEN
Generic IEC 61850 IED Connectivity package	1KHA001027-UEN
Protection and Control IED Manager PCM 600 Installation sheet	1MRS755552
Engineering guide IED 670 products	1MRK 511 179-UEN

More information can be found on www.abb.com/substationautomation.

1.1.5

Revision notes

Revision	Description
C	No functionality added. Changes made in content due to problem reports.

Section 2 Safety information

About this chapter

This chapter contains safety information. Warning signs are presented which urge the user to be careful during certain operations in order to avoid injuries to humans or damage to equipment.

2.1 Warning signs



Strictly follow the company and country safety regulations. Working in a high voltage environment requires serious approach to avoid human injuries and damage to equipment.



Do not touch circuitry during operation. Potentially lethal voltages and currents are present.



Always avoid touching the circuitry when covers are removed. The product contains electronic circuits which can be damaged if exposed to static electricity (ESD). Lethal high voltage circuits are also exposed when covers are removed.



Always use suitable isolated test pins when measuring signals in open circuitry. Potentially lethal voltages and currents are present.



Never connect or disconnect a wire and/or a connector to or from a IED during normal operation. Hazardous voltages and currents are present that may be lethal. Operation may be disrupted and IED and measuring circuitry may be damaged.



Always connect the IED to protective ground, regardless of the operating conditions. This also applies to special occasions such as

bench testing, demonstrations and off-site configuration. Operating the IED without proper grounding may damage both IED and measuring circuitry and may cause injuries in case of an accident.



Never disconnect the secondary connection of current transformer circuit without short-circuiting the transformer's secondary winding. Operating a current transformer with the secondary winding open will cause a massive potential build-up that may damage the transformer and may cause injuries to humans.



Never remove any screw from a powered IED or from a IED connected to powered circuitry. Potentially lethal voltages and currents are present.



Take adequate measures to protect the eyes. Never look into the laser beam.

2.2

Caution signs



Always transport PCBs (modules) using certified conductive bags. Always handle modules using a conductive wrist strap connected to protective ground and on a suitable antistatic surface. Electrostatic discharge (ESD) may cause damage to the module since electronic circuits are sensitive to this phenomena.



Do not connect live wires to the IED. Internal circuitry may be damaged



Always use a conductive wrist strap connected to protective ground when replacing modules. Electrostatic discharge (ESD) may damage the module and IED circuitry.



Take care to avoid electrical shock if accessing wiring and connection IEDs when installing and commissioning.



Changing the active setting group will inevitably change the IEDs operation. Be careful and check regulations before making the change.

2.3

Note signs



The protection assembly is designed for a maximum continuous current of four times rated value.

Section 3 Overview

About this chapter

This chapter outlines the installation and commissioning of the IED.

3.1 Commissioning and installation overview

The settings for each function must be calculated before the commissioning task can start. A configuration, done in the configuration and programming tool, must also be available if the IED does not have a factory configuration downloaded.

The IED is unpacked and visually checked. It is preferably mounted in a cubicle or on a wall. The connection to the protection system has to be checked in order to verify that the installation is successful.

Section 4 Unpacking and checking the IED

About this chapter

This chapter describes the delivery and the unpacking of the IED

4.1 Taking delivery, unpacking and checking

Procedure

1. Remove the transport casing.
2. Visually inspect the IED.
3. Check that all items are included in accordance with the delivery documents.
Once the IED has been started make sure that the software functions ordered have been included in the delivery.
4. Check for transport damages.
If transport damage is discovered appropriate action must be taken against the latest carrier and the nearest ABB office or representative should be informed. ABB should be notified immediately if there are any discrepancies in relation to the delivery documents.
5. Storage
If the IED is to be stored before installation, this must be done in the original transport casing in a dry and dust free place. Observe the environmental requirements stated in the technical data.

Section 5 Installing the IED

About this chapter

This chapter describes how to install the IED.

5.1 Overview

The mechanical and electrical environmental conditions at the installation site must be within the limits described in the IED technical data. Dusty, damp places, places susceptible to rapid temperature variations, powerful vibrations and shocks, surge voltages of high amplitude and fast rise time, strong induced magnetic fields or similar extreme conditions should be avoided.

Sufficient space must be available in front of and at the rear of the IED to allow access for maintenance and future modifications. Flush mounted IEDs should be mounted so that IED modules can be added and replaced without excessive dismantling.

5.2 Dimensions

5.2.1 Case without rear cover

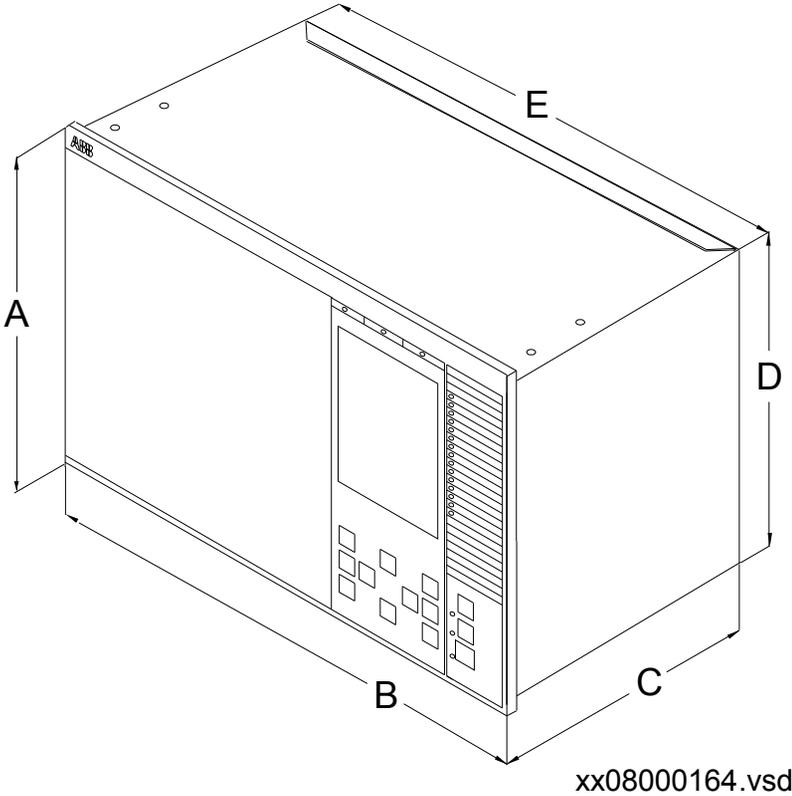


Figure 1: Case without rear cover

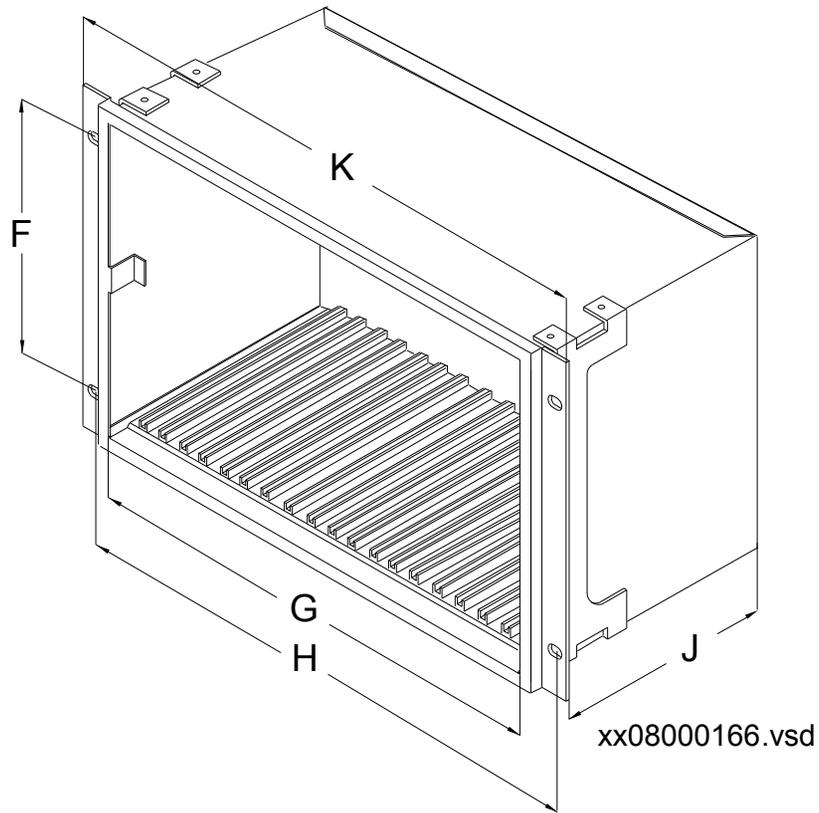


Figure 2: Case without rear cover with 19" rack mounting kit

Case size (inches)	A	B	C	D	E	F	G	H	J	K
6U, 1/2 x 19"	10.47	8.81	7.92	9.96	8.10	7.50	8.02	-	7.39	-
6U, 3/4 x 19"	10.47	13.23	7.92	9.96	12.52	7.50	12.44	-	7.39	-
6U, 1/1 x 19"	10.47	17.65	7.92	9.96	16.94	7.50	16.86	18.31	7.39	19.00
The H and K dimensions are defined by the 19" rack mounting kit										

5.2.2 Case with rear cover

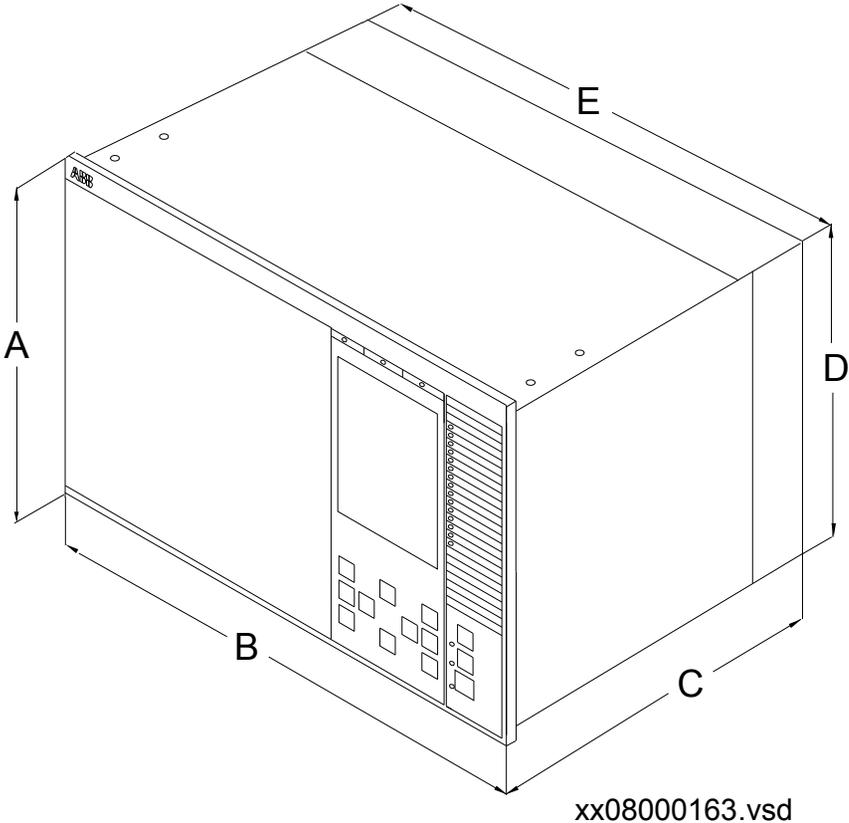


Figure 3: Case with rear cover

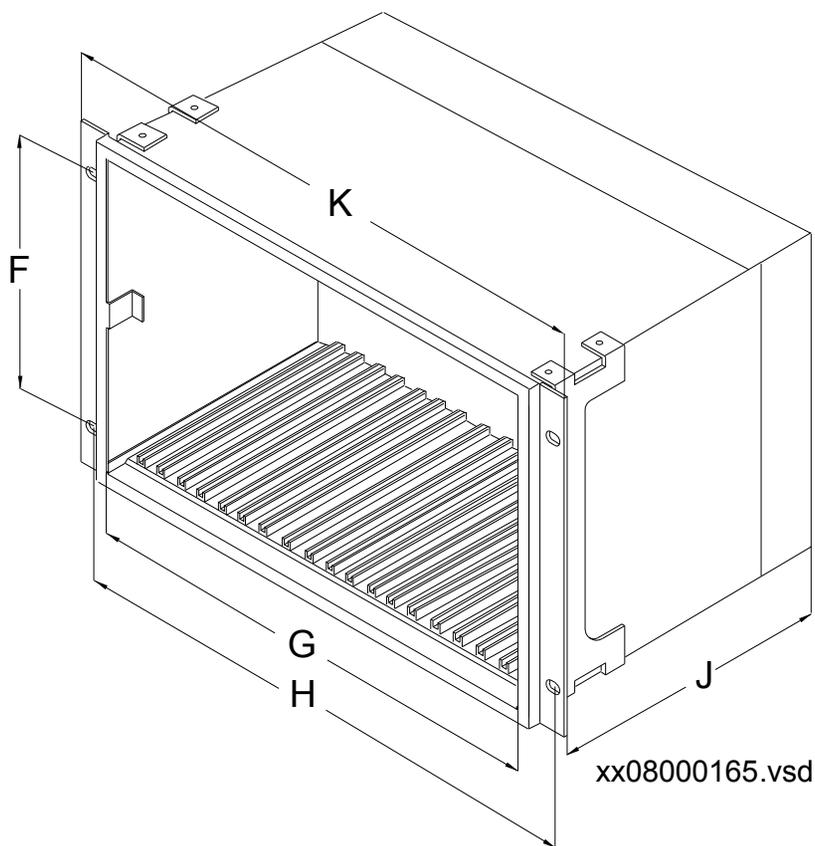


Figure 4: Case with rear cover and 19" rack mounting kit

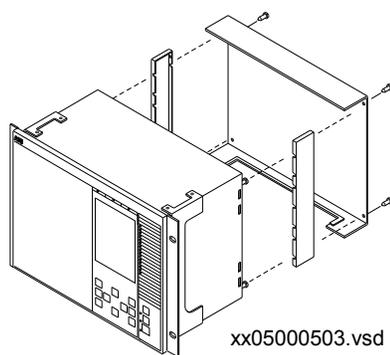
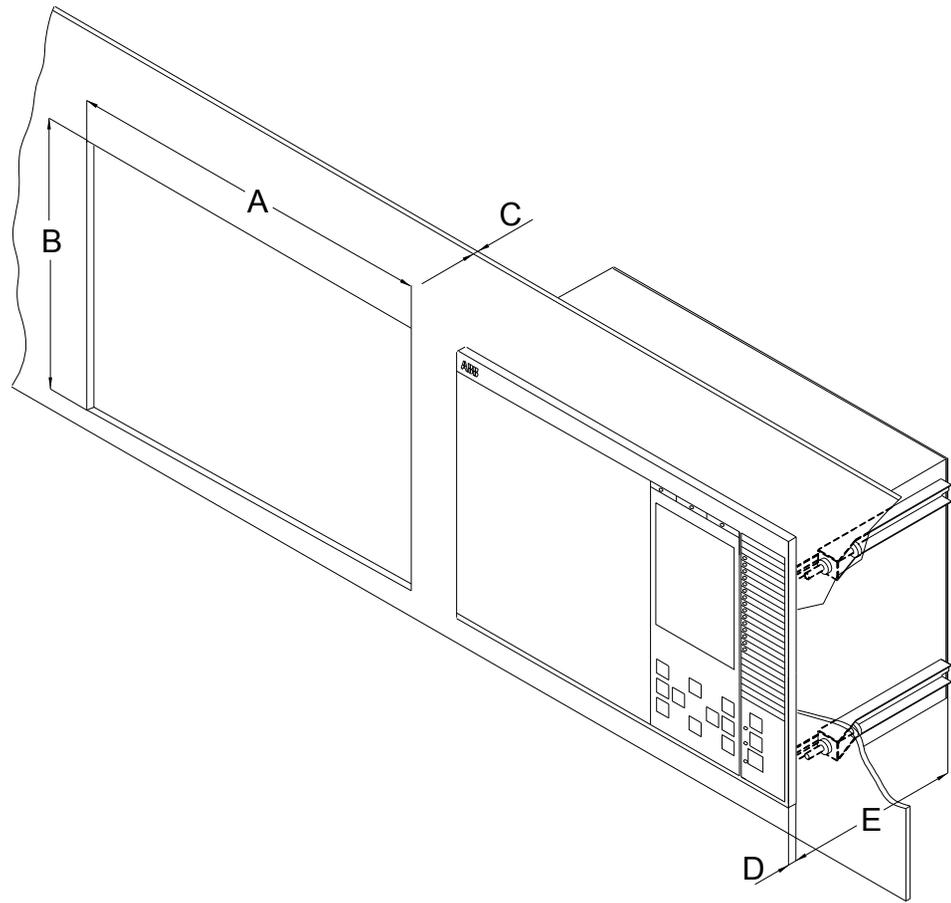


Figure 5: Rear cover case with details

Case size (inches)	A	B	C	D	E	F	G	H	J	K
6U, 1/2 x 19"	10.47	8.81	9.53	10.07	8.10	7.50	8.02	-	9.00	-
6U, 3/4 x 19"	10.47	13.23	9.53	10.07	12.52	7.50	12.4	-	9.00	-
6U, 1/1 x 19"	10.47	17.65	9.53	10.07	16.86	7.50	16.86	18.31	9.00	19.00

The H and K dimensions are defined by the 19" rack mounting kit.

5.2.3 Flush mounting dimensions



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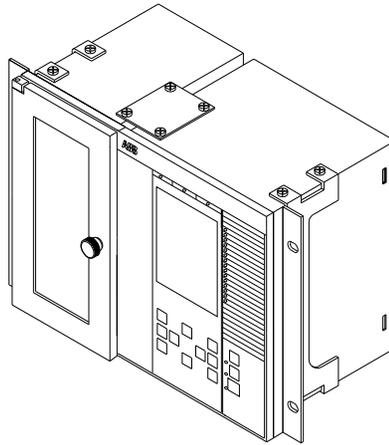
Figure 6: Flush mounting

Case size Tolerance	Cut-out dimensions (inches)			
	A +0.04	B +0.04	C	D
6U, 1/2 x 19"	8.27	10.01	0.16–0.39	0.49
6U, 3/4 x 19"	12.69	10.01	0.16–0.39	0.49
6U, 1/1 x 19"	17.11	10.01	0.16–0.39	0.49

E = 188.6 mm without rear protection cover, 229.6 mm with rear protection cover

5.2.4

Side-by-side flush mounting dimensions



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Figure 7: A 1/2 x 19" size 670 series IED side-by-side with RHGS6.

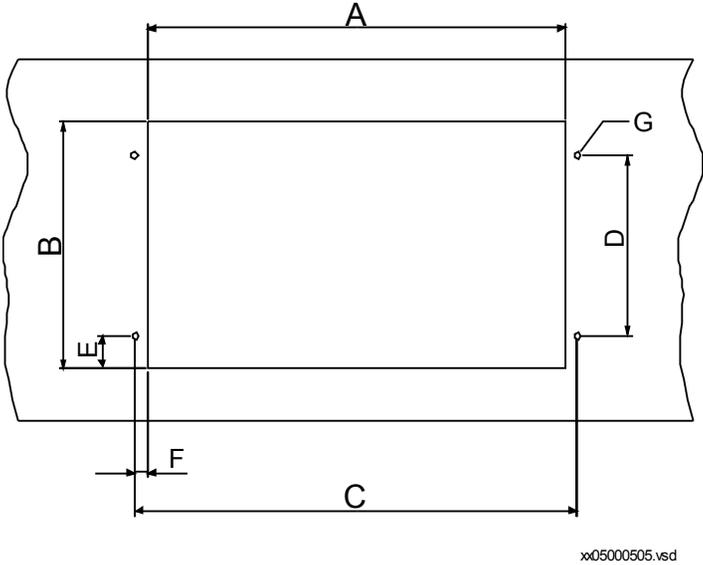


Figure 8: Panel-cut out dimensions for side-by-side flush mounting

Case size (inches) Tolerance	A ±0.04	B ±0.04	C ±0.04	D ±0.04	E ±0.04	F ±0.04	G ±0.04
6U, 1/2 x 19"	8.42	10.21	9.46	7.50	1.35	0.52	0.25 diam
6U, 3/4 x 19"	12.85	10.21	13.89	7.50	1.35	0.52	0.25 diam
6U, 1/1 x 19"	17.27	10.21	18.31	7.50	1.35	0.52	0.25 diam

5.2.5 Wall mounting dimensions

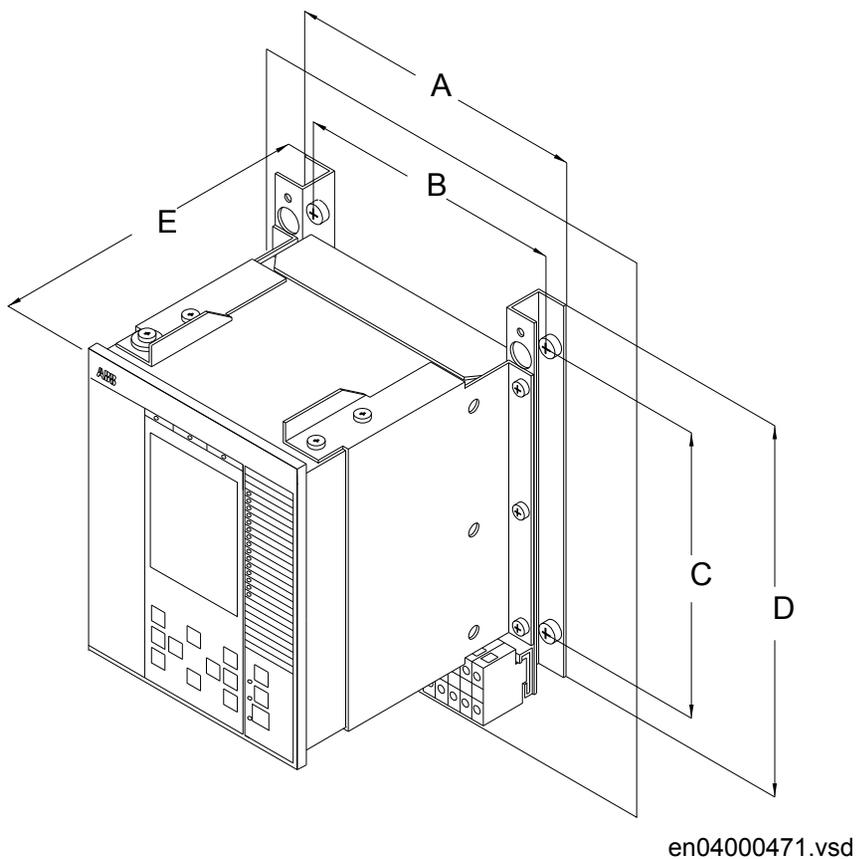


Figure 9: Wall mounting

Case size (inches)	A	B	C	D	E
6U, 1/2 x 19"	10.50	10.52	10.74	15.36	9.57
6U, 3/4 x 19"	15.92	14.94	10.74	15.36	9.57
6U, 1/1 x 19"	20.31	19.33	10.74	15.36	9.57

5.3 Mounting methods and details

5.3.1 Mounting the IED

The IED can be rack, wall or flush mounted with the use of different mounting kits, see figure [10](#).

An additional box of type RHGS can be mounted to one side of a 1/2 or 3/4 IED.

The different mounting kits contain all parts needed including screws and assembly instructions. The following mounting kits are available:

- Flush mounting kit
- 19" Panel (rack) mounting kit
- Wall mounting kit
- Side-by-side mounting kit

The same mounting kit is used for side-by-side rack mounting and side-by-side flush mounting.



The mounting kits must be ordered separately when ordering an IED. They are available as options on the ordering sheet in *Accessories for 670 series IED*, see section ["Related documents"](#).



Generally, all the screws included in delivered mounting kits are of Torx type and a screwdriver of the same type is needed (Tx10, Tx15, Tx20 and Tx25).



If other type of screws are to be used, be sure to use the dimensions of the screws that are given in this guide.

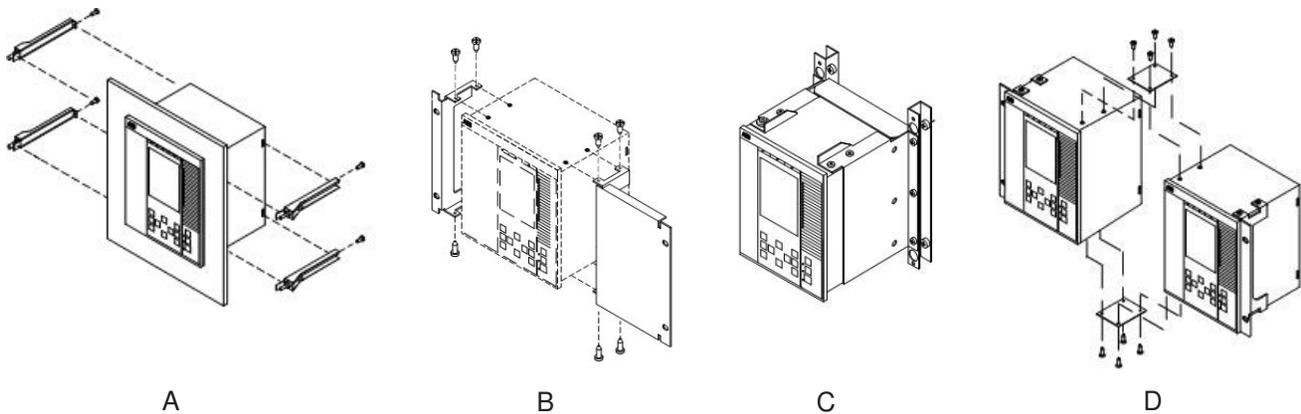


Figure 10: Different mounting methods

Description

- A Flush mounting
- B 19" Panel rack mounting
- C Wall mounting
- D Side-by-side rack or flush mounting

5.3.2 Flush mounting

5.3.2.1 Overview

The flush mounting kit are utilized for case sizes:

- 1/2 x 19"
- 3/4 x 19"
- 1/1 x 19"
- 1/4 x 19" (RHGS6 6U)

Only a single case can be mounted in each cut-out on the cubicle panel, for class IP54 protection.

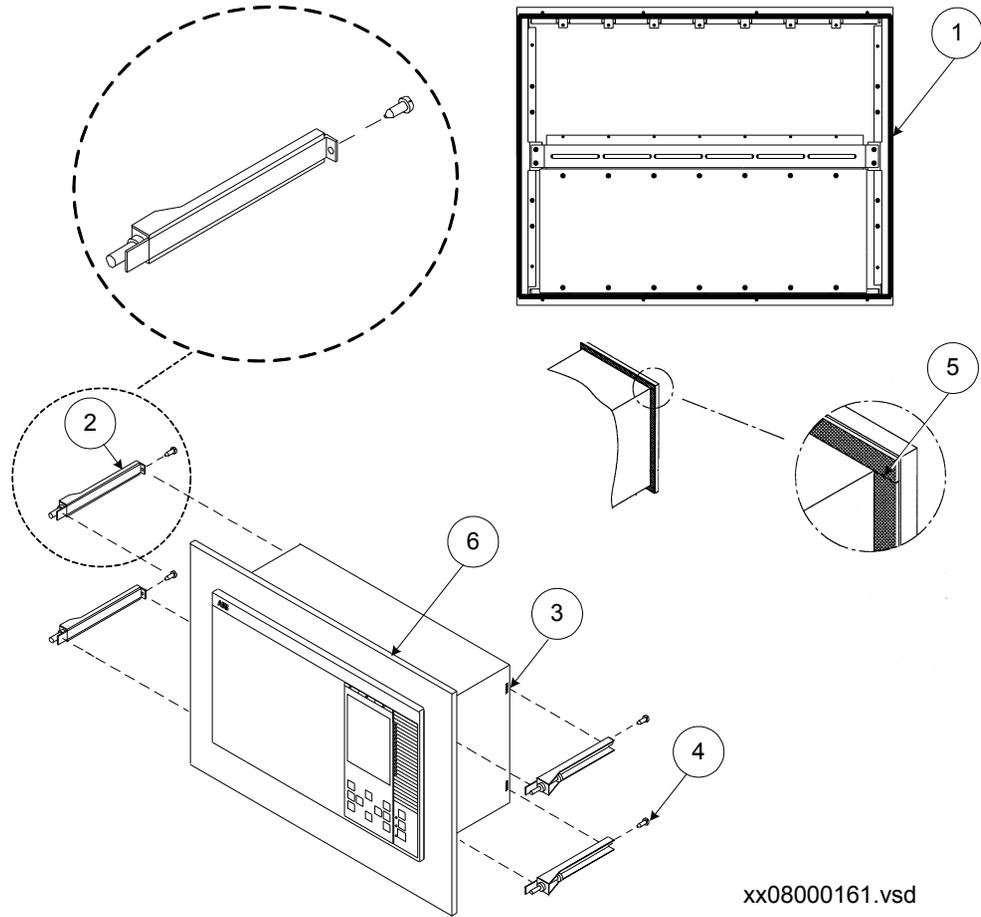


Flush mounting cannot be used for side-by-side mounted IEDs when IP54 class must be fulfilled. Only IP20 class can be obtained when mounting two cases side-by-side in one (1) cut-out.



To obtain IP54 class protection, an additional factory mounted sealing must be ordered when ordering the IED.

5.3.2.2 Mounting procedure for flush mounting



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Figure 11: Flush mounting details.

PosNo	Description	Quantity	Type
1	Sealing strip, used to obtain IP54 class. The sealing strip is factory mounted between the case and front plate.	-	-
2	Fastener	4	-
3	Groove	-	-
4	Screw, self tapping	4	2.9x9.5 mm
5	Joining point of sealing strip	-	-
6	Panel	-	-

Procedure

1. Cut an opening in the panel (6).
See section "[Flush mounting dimensions](#)" regarding dimensions.
2. Carefully press the sealing strip (1) around the IEDs collar. Cut the end of the sealing strip a few mm to long to make the joining point (5) tight.
The sealing strip is delivered with the mounting kit. The strip is long enough for the largest available IED.
3. Insert the IED into the opening (cut-out) in the panel.
4. Add and lock the fasteners (2) to the IED.
Thread a fastener into the groove at the back end of the IED. Insert and lightly fasten the locking screw (4). Next, thread a fastener on the other side of the IED, and lightly fasten its locking screw. Lock the front end of the fastener in the panel, using the M5x25 screws.
Repeat the procedure with the remaining two fasteners.

5.3.3 19" panel rack mounting

5.3.3.1 Overview

All IED sizes can be mounted in a standard 19" cubicle rack by using the for each size suited mounting kit which consists of two mounting angles and fastening screws for the angles.

The mounting angles are reversible which enables mounting of IED size 1/2 x 19" or 3/4 x 19" either to the left or right side of the cubicle.



Please note that the separately ordered rack mounting kit for side-by-side mounted IEDs, or IEDs together with RHGS cases, is to be selected so that the total size equals 19".



When mounting the mounting angles, be sure to use screws that follows the recommended dimensions. Using screws with other dimensions than the original may damage the PCBs inside the IED.

5.3.3.2

Mounting procedure for 19" panel rack mounting

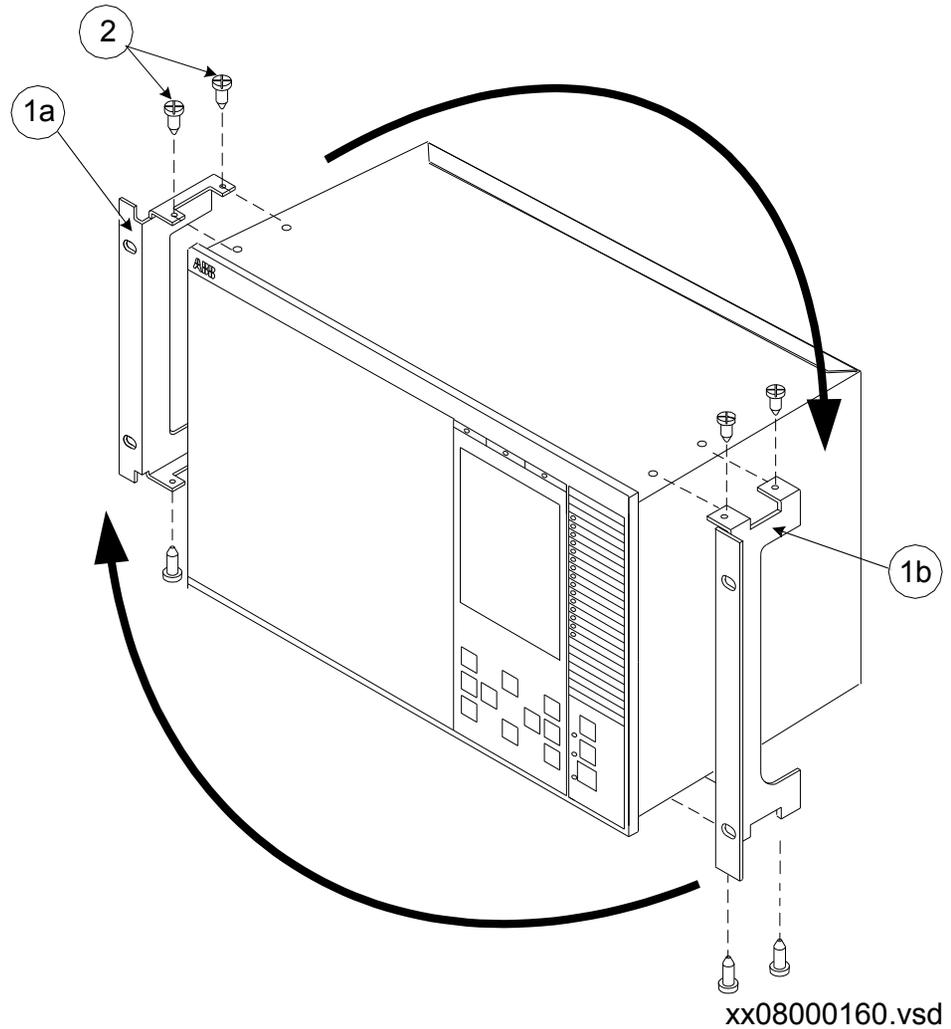


Figure 12: 19" panel rack mounting details

Pos	Description	Quantity	Type
1a, 1b	Mounting angels, which can be mounted, either to the left or right side of the case.	2	-
2	Screw	8	M4x6

Procedure

- Carefully fasten the mounting angles (1a, 1b) to the sides of the IED.

-
- Use the screws (2) supplied in the mounting kit.
 2. Place the IED assembly in the 19" panel.
 3. Fasten the mounting angles with appropriate screws.

5.3.4 Wall mounting

5.3.4.1 Overview

All case sizes, 1/2 x 19", 3/4 x 19" and 1/1 x 19", can be wall mounted. It is also possible to mount the IED on a panel or in a cubicle.



When mounting the side plates, be sure to use screws that follows the recommended dimensions. Using screws with other dimensions than the original may damage the PCBs inside the IED.



If fiber cables are bent too much, the signal can be weakened. Wall mounting is therefore not recommended for communication modules with fiber connection; Serial SPA/IEC 60870-5-103 and LON communication module (SLM), Optical Ethernet module (OEM) and Line data communication module (LDCM).

5.3.4.2

Mounting procedure for wall mounting

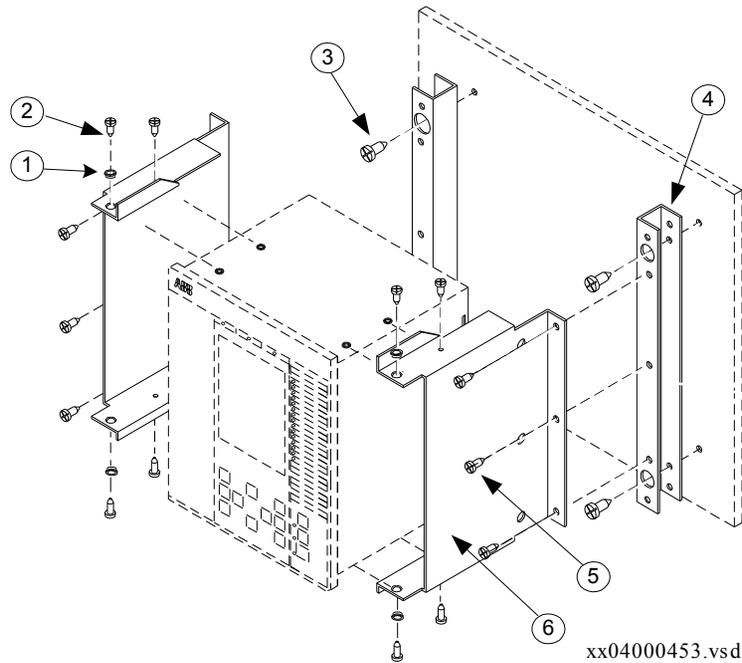


Figure 13: Wall mounting details.

PosNo	Description	Quantity	Type
1	Bushing	4	-
2	Screw	8	M4x10
3	Screw	4	M6x12 or corresponding
4	Mounting bar	2	-
5	Screw	6	M5x8
6	Side plate	2	-

Procedure

1. Mount the mounting bars onto the wall (4).
See section ["Wall mounting dimensions"](#) for mounting dimensions.
Depending on the wall different preparations may be needed like drilling and inserting plastic or expander plugs (concrete/plasterboard walls) or threading (metal sheet wall).
2. Make all electrical connections to the IED terminal.

- It is much easier to do this without the unit in place.
3. Mount the side plates to the IED.
 4. Mount the IED to the mounting bars.

5.3.4.3

How to reach the rear side of the IED

The IED can be equipped with a rear protection cover, which is recommended to use with this type of mounting. See figure 14.

To reach the rear side of the IED, a free space of 3.2 inches is required on the unhinged side.

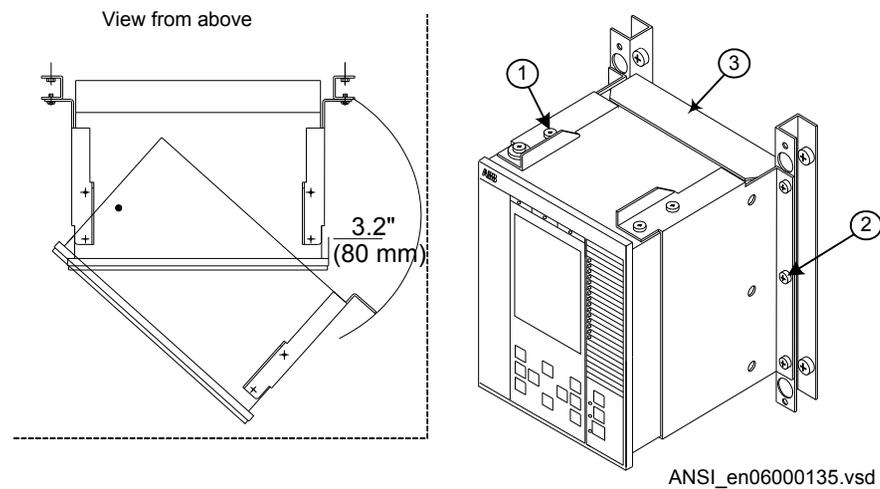


Figure 14: How to reach the connectors on the rear side of the IED.

PosNo	Description	Type
1	Screw	M4x10
2	Screw	M5x8
3	Rear protection cover	-

Procedure

1. Remove the inner screws (1), upper and lower on one side.
2. Remove all three fixing screws (2), on the opposite side, from wall support.
3. The IED can now be swung out for access to the connectors, after removing any rear protection.

5.3.5 Side-by-side 19" rack mounting

5.3.5.1 Overview

IED case sizes, 1/2 x 19" or 3/4 x 19" and RHGS cases, can be mounted side-by-side up to a maximum size of 19". For side-by-side rack mounting, the side-by-side mounting kit together with the 19" rack panel mounting kit must be used. The mounting kit has to be ordered separately.



When mounting the plates and the angles on the IED, be sure to use screws that follows the recommended dimensions. Using screws with other dimensions than the original may damage the PCBs inside the IED.

5.3.5.2 Mounting procedure for side-by-side rack mounting

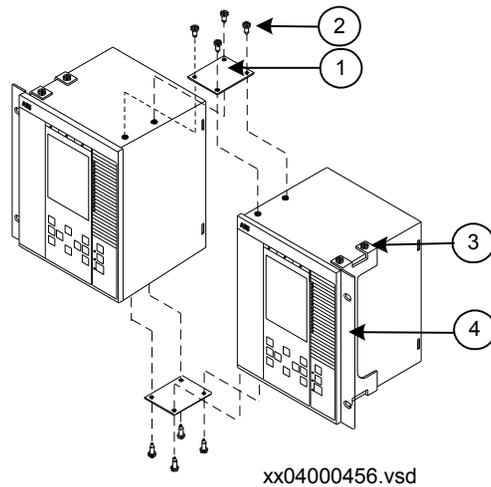


Figure 15: Side-by-side rack mounting details.

PosNo	Description	Quantity	Type
1	Mounting plate	2	-
2, 3	Screw	16	M4x6
4	Mounting angle	2	-

Procedure

1. Place the two IEDs next to each other on a flat surface.
2. Fasten a side-by-side mounting plate (1).
Use four of the delivered screws (2, 3).
3. Carefully turn the two IEDs up-side down.
4. Fasten the second side-by-side mounting plate.
Use the remaining four screws.
5. Carefully fasten the mounting angles (4) to the sides of the IED.
Use the screws available in the mounting kit.
6. Place the IED assembly in the rack.
7. Fasten the mounting angles with appropriate screws.

5.3.5.3

IED in the 670 series mounted with a RHGS6 case

An 1/2 x 19" or 3/4 x 19" size IED can be mounted with a RHGS (6 or 12 depending on IED size) case. The RHGS case can be used for mounting a test switch of type RTX 24. It also has enough space for a terminal base of RX 2 type for mounting of, for example, a DC-switch or two trip IEDs.

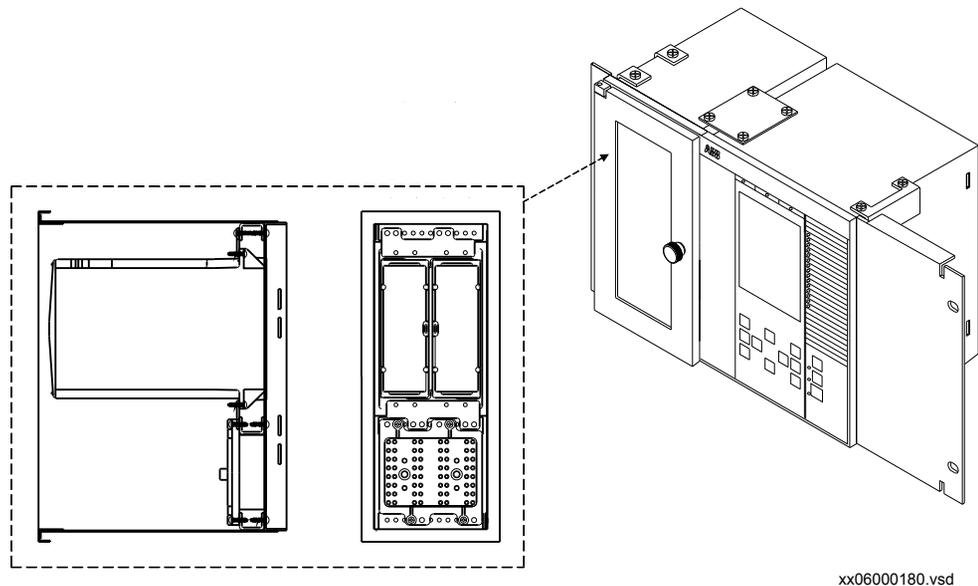


Figure 16: IED in the 670 series (1/2 x 19") mounted with a RHGS6 case containing a test switch module equipped with only a test switch and a RX2 terminal base

5.3.6 Side-by-side flush mounting

5.3.6.1 Overview

It is not recommended to flush mount side by side mounted cases if IP54 is required. If your application demands side-by-side flush mounting, the side-by-side mounting details kit and the 19" panel rack mounting kit must be used. The mounting kit has to be ordered separately. The maximum size of the panel cut out is 19".



With side-by-side flush mounting installation, only IP class 20 is obtained. To reach IP class 54, it is recommended to mount the IEDs separately. For cut out dimensions of separately mounted IEDs, see section ["Flush mounting"](#).



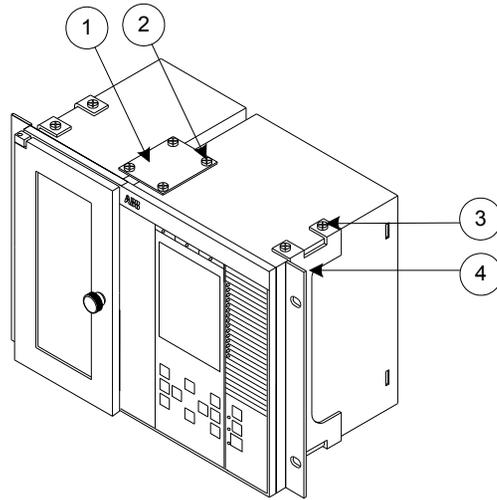
When mounting the plates and the angles on the IED, be sure to use screws that follows the recommended dimensions. Using screws with other dimensions than the original may damage the PCBs inside the IED.



Please contact factory for special add on plates for mounting FT switches on the side (for 1/2 19" case) or bottom of the relay.

5.3.6.2

Mounting procedure for side-by-side flush mounting



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Figure 17: Side-by-side flush mounting details (RHGS6 side-by-side with 1/2 x 19" IED).

PosNo	Description	Quantity	Type
1	Mounting plate	2	-
2, 3	Screw	16	M4x6
4	Mounting angle	2	-

Procedure

1. Make a panel cut-out.
For panel cut out dimension, see section ["Side-by-side flush mounting dimensions"](#).
2. Carefully press the sealing strip around the IED collar. Cut the end of the sealing strip little longer to make the joining point tight.
Repeat the same procedure with the second case.
The sealing strip is delivered with the mounting kit. The strip is long enough for the largest available IED.
3. Place the two IEDs next to each other on a flat surface.
4. Fasten a side-by-side mounting plate (1).

- Use four of the delivered screws (2, 3).
5. Carefully turn the two IEDs up-side down.
 6. Fasten the second side-by-side mounting plate.
Use the remaining four screws.
 7. Carefully fasten the mounting angles (4) to the sides of the IED.
Use the fixing screws available in the mounting kit.
 8. Insert the IED into the cut-out.
 9. Fasten the mounting angles with appropriate screws.

5.4 Making the electrical connection

5.4.1 IED connectors

5.4.1.1 Overview

The quantity and designation of connectors depend upon the type and size of the IED. The rear cover plates are prepared with space for the maximum of HW options for each case size and the cut-outs that are not in use are covered with a plate from factory.

Overview

Table 1: Basic modules

Module	Description
Combined backplane module (CBM)	A backplane PCB that carries all internal signals between modules in an IED. Only the TRM (when included) is not connected directly to this board.
Universal backplane module (UBM)	A backplane PCB that forms part of the IED backplane with connectors for TRM (when included), ADM etc.
Power supply module (PSM)	Including a regulated DC/DC converter that supplies auxiliary voltage to all static circuits. <ul style="list-style-type: none"> • An internal fail alarm output is available.
Numerical module (NUM)	Module for overall application control. All information is processed or passed through this module, such as configuration, settings and communication.
Local Human machine interface (LHMI)	The module consists of LED:s, an LCD, a push button keyboard and an ethernet connector used to connect a PC to the IED.
Transformer input module (TRM)	Transformer module that galvanically separates the internal circuits from the VT and CT circuits. It has 12 analog inputs.
Analog digital conversion module (ADM)	Slot mounted PCB with A/D conversion.

Table 2: *Application specific modules*

Module	Description
Binary input module (BIM)	Module with 16 optically isolated binary inputs
Binary output module (BOM)	Module with 24 single outputs or 12 double-pole command outputs including supervision function
Binary I/O module (IOM)	Module with 8 optically isolated binary inputs, 10 outputs and 2 fast signalling outputs.
Line data communication modules (LDCM), short range, medium range, long range, X21	Modules used for digital communication to remote terminal.
Serial SPA/LON/IEC 60870-5-103 communication modules (SLM)	Used for SPA/LON/IEC 60870-5-103 communication
Optical ethernet module (OEM)	PMC board for IEC 61850 based communication.
mA input module (MIM)	Analog input module with 6 independent, galvanically separated channels.
GPS time synchronization module (GSM)	Used to provide the IED with GPS time synchronization.
Static output module (SOM)	Module with 6 fast static outputs and 6 change over output relays.
IRIG-B Time synchronization module (IRIG-B)	Module with 2 inputs. One is used for handling both pulse-width modulated signals and amplitude modulated signals and one is used for optical input type ST for PPS time synchronization.

5.4.1.2

Front side connectors



Figure 18: IED front side connector

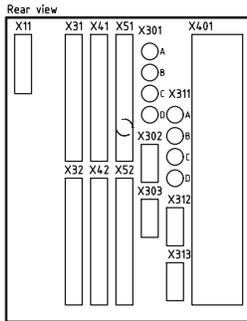
PosNo	Description
1	IED serial communication port with RJ45 connector
2	Ethernet cable with RJ45 connectors



The cable between PC and the IED serial communication port shall be a crossed-over Ethernet cable with RJ45 connectors. If the connection are made via a hub or switch, a standard Ethernet cable can be used.

5.4.1.3 Rear side connectors

Table 3: Designations for 1/2 x 19" casing with 1 TRM slot



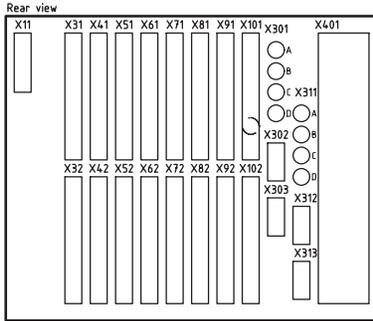
Module	Rear Positions
PSM	X11
BIM, BOM, SOM or IOM	X31 and X32 etc. to X51 and X52
BIM, BOM, SOM, IOM or GSM	X51, X52
SLM	X301:A, B, C, D
IRIG-B 1)	X302
OEM	X311:A, B, C, D
RS485 or LDCM 2) 3)	X312
LDCM 2)	X313
TRM	X401

- 1) IRIG-B installation, when included in seat P30:2
- 2) LDCM installation sequence: P31:2 or P31:3
- 3) RS485 installation, when included in seat P31:2

Note!

1 One LDCM can be included depending of availability of IRIG-B respective RS485 modules.

Table 4: Designations for 3/4 x 19" casing with 1 TRM slot



Module	Rear Positions
PSM	X11
BIM, BOM, SOM, IOM or MIM	X31 and X32 etc. to X101 and X102
BIM, BOM, SOM, IOM, MIM or GSM	X101, X102
SLM	X301:A, B, C, D
IRIG-B or LDCM 1) 2)	X302
LDCM 2)	X303
OEM 4)	X311:A, B, C, D
RS485 or LDCM 2) 3)	X312
LDCM 2)	X313
TRM	X401

1) IRIG-B installation, when included in seat P30:2

2) LDCM installation sequence: P31:2, P31:3, P30:2 and P30:3

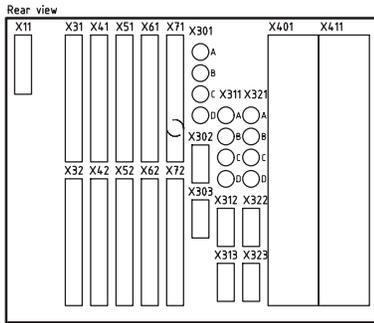
3) RS485 installation, when included in seat P31:2 or P31:3

4) OEM X311:A, B (IEC 61850-8-1). X311:C, D (IEC 61850-8-1)

Note!

2-4 LDCM can be included depending of availability of IRIG-B respective RS485 modules.

Table 5: Designations for 3/4 x 19" casing with 2 TRM slot



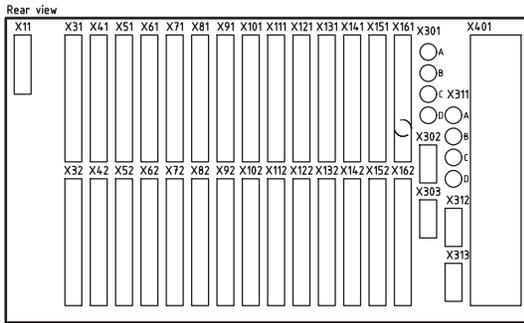
Module	Rear Positions
PSM	X11
BIM, BOM, SOM, IOM or MIM	X31 and X32 etc. to X71 and X72
BIM, BOM, SOM, IOM, MIM or GSM	X71, X72
SLM	X301:A, B, C, D
IRIG-B or LDCM 1,2)	X302
LDCM 2)	X303
OEM 4)	X311:A, B, C, D
RS485 or LDCM 2) 3)	X312
LDCM 2)	X313
LDCM 2)	X322
LDCM 2)	X323
TRM 1	X401
TRM 2	X411

- 1) IRIG-B installation, when included in seat P30:2
- 2) LDCM installation sequence: P31:2, P31:3, P32:2, P32:3, P30:2 and P30:3
- 3) RS485 installation, when included in seat P31:2, P31:3, P32:2 or P32:3
- 4) OEM X311:A, B (IEC 61850-8-1). (X311:C, D IEC 61850-8-1)

Note!

2-4 LDCM can be included depending of availability of IRIG-B respective RS485 modules.
When IRIG-B, RS485 and 4 pc of LDCM are in use, needs a second ADM.

Table 6: Designations for 1/1 x 19" casing with 1 TRM slot

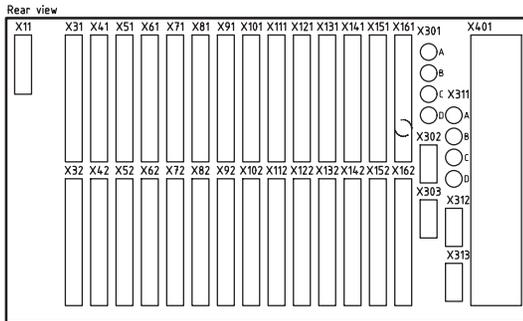


Module	Rear Positions
PSM	X11
BIM, BOM, SOM, IOM or MIM	X31 and X32 etc. to X161 and X162
BIM, BOM, SOM, IOM, MIM or GSM	X161 and X162
SLM	X301:A, B, C, D
IRIG-B	X302
LDCM ¹⁾	X312, X313, X302 and X303
OEM ²⁾	X311:A, B, C, D
RS485	X312, X313
TRM	X401

Note!

1) 2-4 LDCM can be included. First LDCM always in position X313, second LDCM always in position X303. LDCM can also be in position X302 and X312 if IRIG-B respective RS485 modules are not included.
 2) OEM X311:A, B (IEC 61850-8-1). OEM X311:C, D (IEC 61850-8-1)

Table 7: Designations for 1/1 x 19" casing with 2 TRM slots



Module	Rear Positions
PSM	X11
BIM, BOM, SOM, IOM or MIM	X31 and X32 etc. to X131 and X132
BIM, BOM, SOM, IOM, MIM or GSM	X131, X132
SLM	X301:A, B, C, D
IRIG-B or LDCM 1,2)	X302
LDCM 2)	X303
OEM 4)	X311:A, B, C, D
RS485 or LDCM 2) 3)	X312
LDCM 2)	X313
LDCM 2)	X322
LDCM 2)	X323
TRM 1	X401
TRM 2	X411

1) IRIG-B installation, when included in seat P30:2

2) LDCM installation sequence: P31:2, P31:3, P32:2, P32:3, P30:2 and P30:3

3) RS485 installation, when included in seat P31:2, P31:3, P32:2 or P32:4

4) OEM X311:A, B (IEC 61850-8-1). OEM X311:C, D

Note!

2-4 LDCM can be included depending of availability of IRIG-B respective RS485 modules. When IRIG-B, RS485 and 4 pc of LDCM are in use, needs a second ADM.

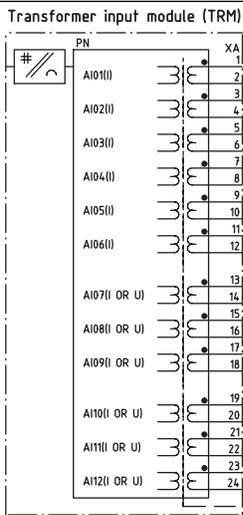


Figure 19: Transformer input module (TRM)

■ Indicates high polarity

Current/voltage configuration (50/60 Hz)	CT/VT-input designation according to figure 19											
	AI01	AI02	AI03	AI04	AI05	AI06	AI07	AI08	AI09	AI10	AI11	AI12
12I, 1A	1A	1A	1A	1A	1A	1A	1A	1A	1A	1A	1A	1A
12I, 5A	5A	5A	5A	5A	5A	5A	5A	5A	5A	5A	5A	5A
9I+3V, 1A	1A	1A	1A	1A	1A	1A	1A	1A	1A	110-220 V	110-220 V	110-220 V
9I+3V, 5A	5A	5A	5A	5A	5A	5A	5A	5A	5A	110-220 V	110-220 V	110-220 V
5I, 1A+4I, 5A+3V	1A	1A	1A	1A	1A	5A	5A	5A	5A	110-220 V	110-220 V	110-220 V
7I+5V, 1A	1A	1A	1A	1A	1A	1A	1A	110-220 V				
7I+5V, 5A	5A	5A	5A	5A	5A	5A	5A	110-220 V				
6I+6V, 1A	1A	1A	1A	1A	1A	1A	110-220 V					
6I+6V, 5A	5A	5A	5A	5A	5A	5A	110-220 V					
6I, 1A	1A	1A	1A	1A	1A	1A	-	-	-	-	-	-
6I, 5A	5A	5A	5A	5A	5A	5A	-	-	-	-	-	-



Note that internal polarity can be adjusted by setting of analog input CT neutral direction and/or on SMAI pre-processing function blocks.

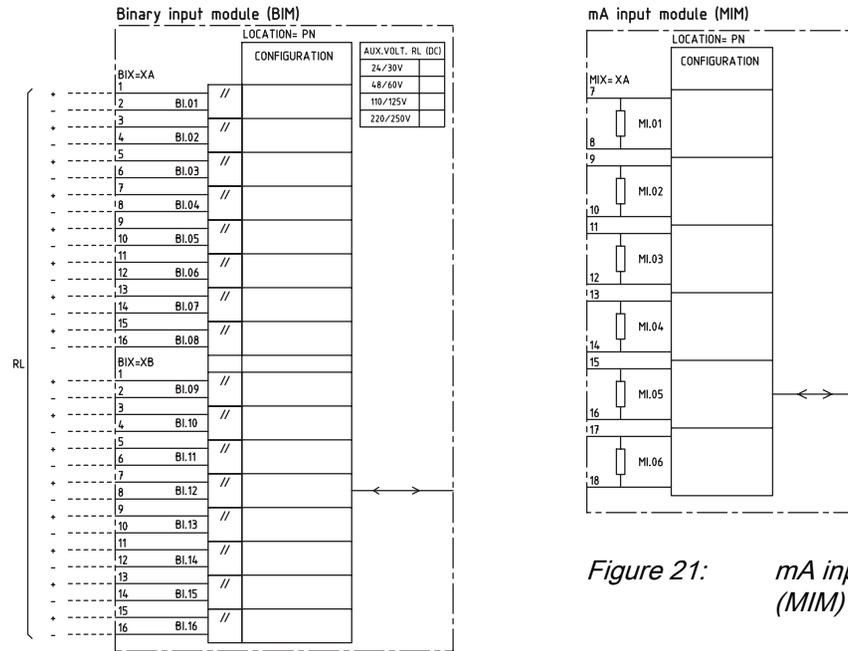


Figure 21: mA input module (MIM)

Figure 20: Binary input module (BIM).
Input contacts named XA corresponds to rear position X31, X41, and so on, and input contacts named XB to rear position X32, X42, and so on.

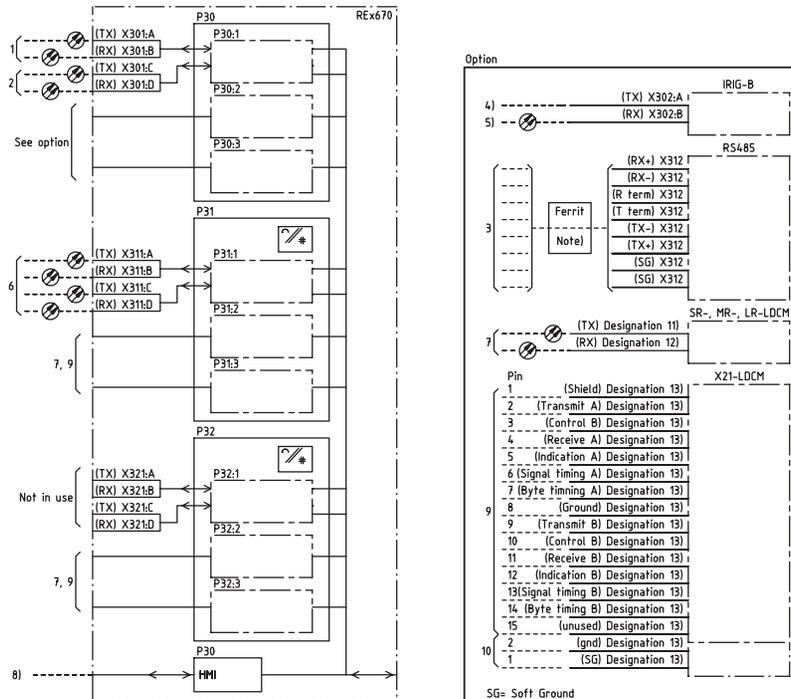


Figure 22: Communication interfaces (OEM, LDCM, SLM and HMI)

Note to figure 22

- 1) Rear communication port SPA/IEC 61850-5-103, ST-connector for glass alt. HFBR Snap-in connector for plastic as ordered
- 2) Rear communication port LON, ST connector for glass alt. HFBR Snap-in connector for plastic as ordered
- 3) Rear communication port RS485, terminal block
- 4) Time synchronization port IRIG-B, BNC-connector
- 5) Time synchronization port PPS or Optical IRIG-B, ST-connector
- 6) Rear communication port IEC 61850-8-1 for X311:A, B, C, D, ST-connector
- 7) Rear communication port C37.94, ST-connector
- 8) Front communication port Ethernet, RJ45 connector
- 9) Rear communication port 15-pole female micro D-sub, 1.27 mm (0.050") pitch
- 10) Rear communication port, terminal block

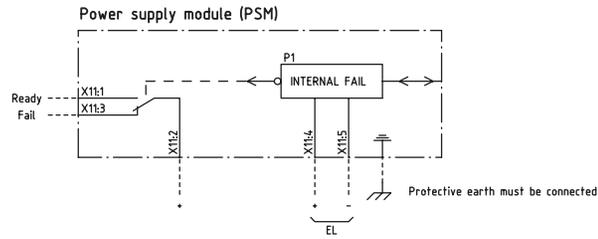
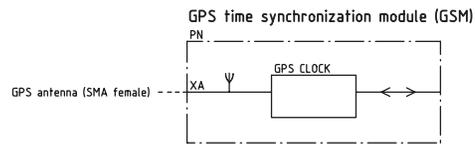


Figure 23: Power supply module (PSM)



Type of CBM	PN=	XA=
1/2x19" casing with 1 TRM slot	P5	X51
3/4x19" casing with 1 TRM slot	P10	X101
3/4x19" casing with 2 TRM slots	P7	X71
1/1x19" casing with 1 TRM slot	P16	X161
1/1x19" casing with 2 TRM slots	P13	X131

Figure 24: GPS time synchronization module (GSM)

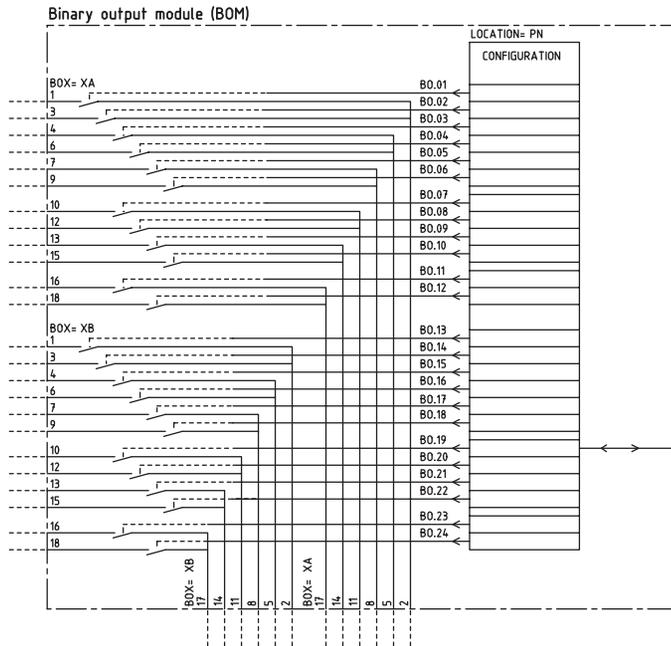


Figure 25: Binary output module (BOM). Output contacts named XA corresponds to rear position X31, X41, and so on, and output contacts named XB to rear position X32, X42, and so on.

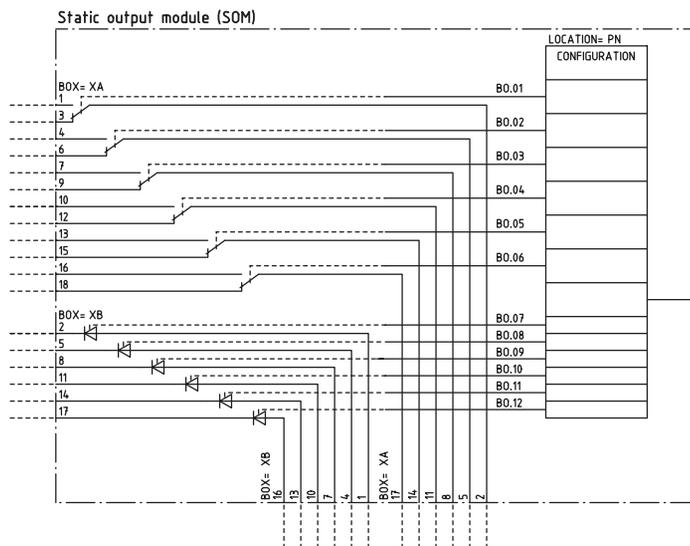


Figure 26: Static output module (SOM)

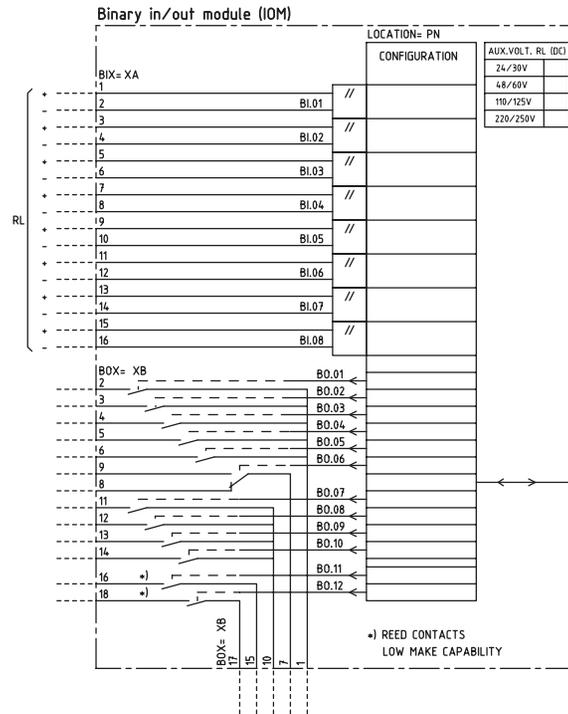


Figure 27: Binary in/out module (IOM). Input contacts named XA corresponds to rear position X31, X41, and so on, and output contacts named XB to rear position X32, X42, and so on.

5.4.1.4

Connection examples



WARNING! USE EXTREME CAUTION! Dangerously high voltages might be present on this equipment, especially on the plate with resistors. Do any maintenance **ONLY** if the primary object protected with this equipment is de-energized. If required by national law or standard, enclose the plate with resistors with a protective cover or in a separate box.

Connections for three-phase high impedance differential protection

Generator, reactor or busbar differential protection is a typical application for three-phase high impedance differential protection. Typical CT connections for three-phase high impedance differential protection scheme are shown in figure 28.

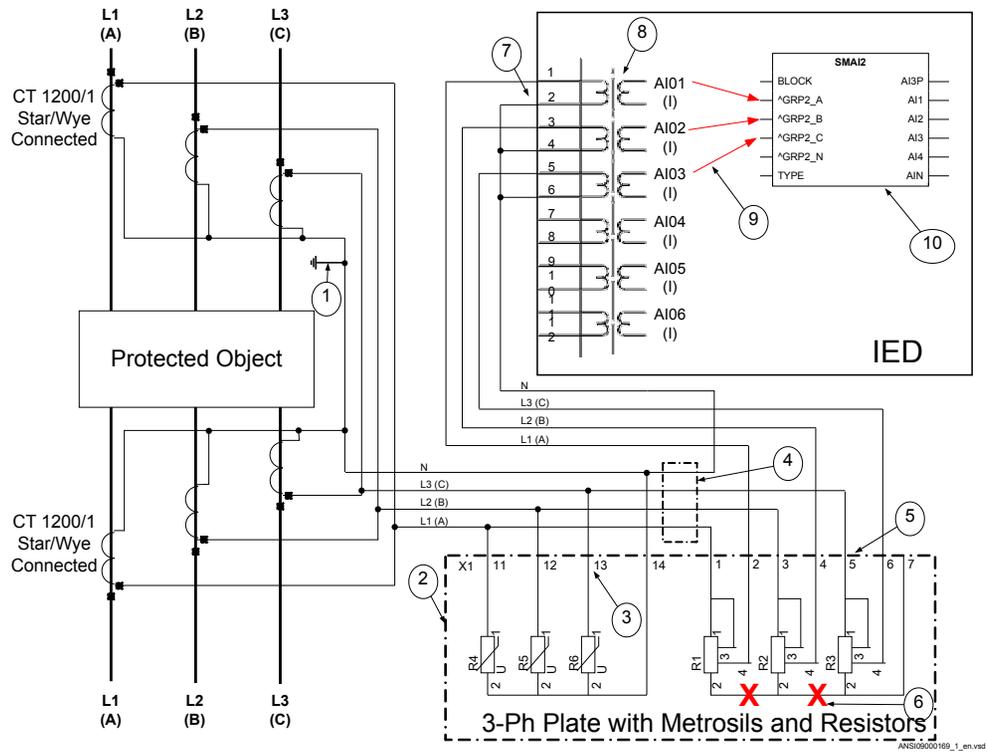


Figure 28: CT connections for high impedance differential protection

Pos	Description
1	Scheme grounding point



Note that it is of utmost importance to insure that only one grounding point exist in such scheme.

- 2 Three-phase plate with setting resistors and metrosils.
- 3 Necessary connection for three-phase metrosil set. Shown connections are applicable for both types of three-phase plate.
- 4 Position of optional test switch for secondary injection into the high impedance differential IED.
- 5 Necessary connection for setting resistors. Shown connections are applicable for both types of three-phase plate.
- 6 The factory made star point on a three-phase setting resistor set.



Shall be removed for installations with 650 and 670 series IEDs. This star point is required for RADHA schemes only.

- 7 How to connect three individual phase currents for high impedance scheme to three CT inputs in the IED.

- 8 Transformer input module, where the current inputs are located.



Note that the CT ratio for high impedance differential protection application must be set as one.

- For main CTs with 1A secondary rating the following setting values shall be entered: $CT_{prim} = 1A$ and $CT_{sec} = 1A$
 - For main CTs with 5A secondary rating the following setting values shall be entered: $CT_{prim} = 5A$ and $CT_{sec} = 5A$
 - The parameter $CT_{StarPoint}$ shall be always left to the default value $ToObject$.
- 9 Three connections made in the Signal Matrix, which connect these three current inputs to the first three input channels of the preprocessing function block (10). For high impedance differential protection preprocessing function block in 3ms task shall be used.
- 10 Preprocessing block, to digitally filter the connected analogue inputs. Preprocessing block outputs AI1, AI2 and AI3 shall be connected to three instances of 1Ph high impedance differential protection HZPDIF (87) function blocks, for example instance 1, 2 and 3 of HZPDIF (87) in the configuration tool.

Connections for 1Ph High impedance differential protection HZPDIF (87)

Restricted earth fault protection REFPDIF (87N) is a typical application for 1Ph High impedance differential protection HZPDIF (87). Typical CT connections for high impedance based REFPDIF (87N) protection scheme are shown in figure [29](#).

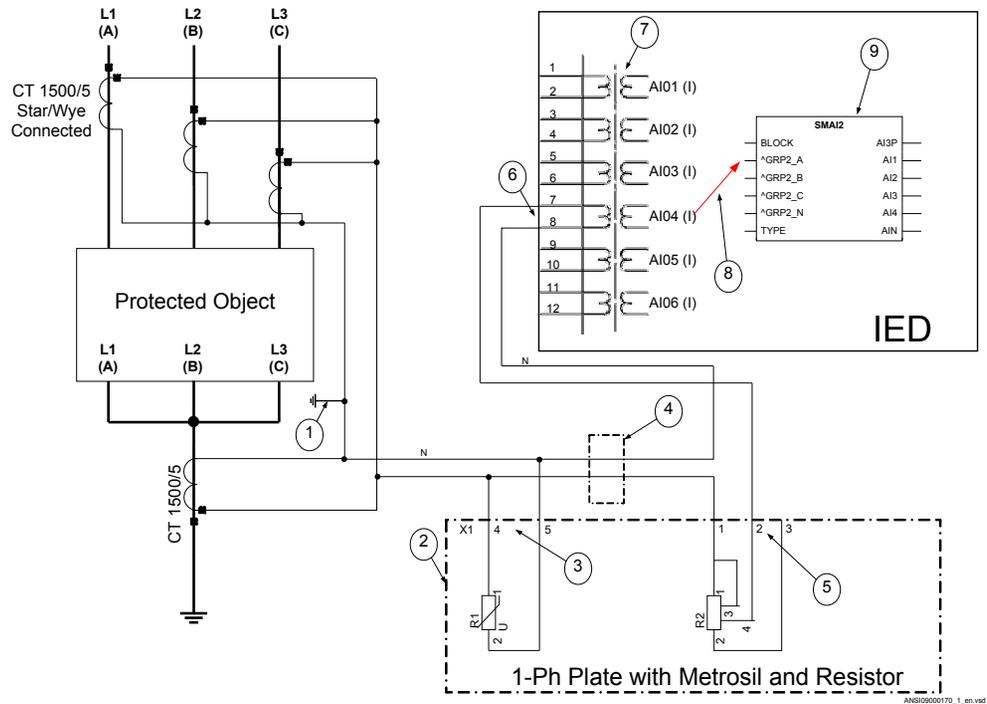


Figure 29: CT connections for restricted earth fault protection

Pos	Description
1	Scheme grounding point



Note that it is of utmost importance to insure that only one grounding point exist in such scheme.

- 2 One-phase plate with setting resistor and metrosil.
- 3 Necessary connection for the metrosil. Shown connections are applicable for both types of one-phase plate.
- 4 Position of optional test switch for secondary injection into the high impedance differential IED.
- 5 Necessary connection for setting resistor. Shown connections are applicable for both types of one-phase plate.
- 6 How to connect REFDPDIF (87N) high impedance scheme to one CT input in IED.

- 7 Transformer input module where this current input is located.



Note that the CT ratio for high impedance differential protection application must be set as one.

- For main CTs with 1A secondary rating the following setting values shall be entered: $CT_{prim} = 1A$ and $CT_{sec} = 1A$
 - For main CTs with 5A secondary rating the following setting values shall be entered: $CT_{prim} = 5A$ and $CT_{sec} = 5A$
 - The parameter $CT_{StarPoint}$ shall always be left to the default value $ToObject$
- 8 Connection made in the Signal Matrix, which connects this current input to first input channel of the preprocessing function block (10). For high impedance differential protection preprocessing function block in 3ms task shall be used.
- 9 Preprocessing block, which has a task to digitally filter the connected analogue inputs. Preprocessing block output A11 shall be connected to one instances of 1Ph high impedance differential protection function HZPDIF (87) (for example, instance 1 of HZPDIF (87) in the configuration tool).

5.4.2

Connecting to protective ground

Connect the grounding screw (pos 1 in figure [30](#)) on the rear of the IED to the closest possible grounding point in the cubicle. Electrical codes and standards require that protective ground cables are green/yellow conductors with a cross section area of at least 2.5 mm^2 (AWG14). There are several protective grounding screws on an IED. The Power supply module (PSM), Transformer input modules (TRM) and the enclosure are all separately grounded, see figure [30](#) below.

The cubicle must be properly connected to the station grounding system. Use a conductor with a core cross section area of at least 4 mm^2 (AWG 12).

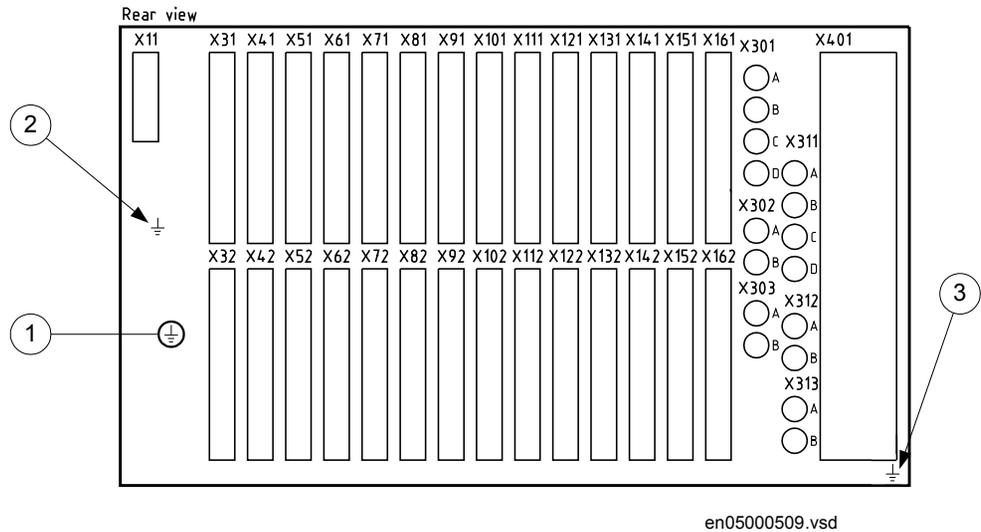


Figure 30: Rear view of IED showing grounding points.

Pos	Description
1	Main protective ground to chassis
2	Grounding screw to Power supply module (PSM)
3	Grounding screw to Transformer input module (TRM). (There is one ground connection per TRM)



Use the main protective ground screw (1) for connection to the stations grounding system. Grounding screws for PSM module (2) and TRM module (3) must be fully tightened to secure protective ground connection of these modules.

5.4.3 Connecting the power supply module

The wiring from the cubicle terminal block to the IED terminals (see figure 23 for PSM connection diagram) must be made in accordance with the established guidelines for this type of equipment. The wires from binary inputs and outputs and the auxiliary supply must be routed separately from the current transformer cables between the terminal blocks of the cubicle and the IED's connections. The connections are made on connector X11. For location of connector X11, refer to section ["Rear side connectors"](#).

5.4.4 Connecting to CT and VT circuits

CTs and VTs are connected to the 24-pole connector of the Transformer input module (TRM) on the rear side of the IED. Connection diagram for TRM is shown in figure 19.

Use a solid conductor with a cross section area between 2.5-6 mm² (AWG14-10) or a stranded conductor with a cross section area between 2.5-4 mm² (AWG14-12).

If the IED is equipped with a test-switch of type RTXP 24 COMBIFLEX wires with 20 A sockets must be used to connect the CT and VT circuits.

Connectors on TRM (for location see section "[Rear side connectors](#)") for current and voltage transformer circuits are so called "feed-through IED blocks" and are designed for conductors with cross sectional area up to 4 mm² (AWG 12). The screws used to fasten the conductors should be tightened with a torque of 1Nm.

Connector terminals for CT and VT circuits, as well as terminals for binary input and output signals, can be of either ringlug or compression connection type, depending on ANSI/IEC standards, or customers choice.



Figure 31: Examples of ringlug terminals



Figure 32: Examples of standard compression connection terminals

Table 8: *CT and VT circuit connectors*

Connector type	Rated voltage and current	Maximum conductor area
Screw compression type	250 V AC, 20 A	4 mm ² (AWG12) 2 x 2.5 mm ² (2 x AWG14)
Terminal blocks suitable for ring lug terminals	250 V AC, 20 A	4 mm ² (AWG12)

5.4.4.1

Configuration for analog CT inputs

The secondary rated current of the CT (that is, 1A or 5A) determines the choice of TRM in the IED. Two TRMs are available, One is dimensioned for an input current of 5A and the other for an input of 1A. If the CT rated secondary current does not match the TRM input current rating adjustments can be made in settings depending on the tolerance of the TRM.

5.4.5

Connecting the binary input and output signals

Auxiliary power and signals are connected using voltage connectors. Signal wires are connected to a female connector, see figure 33, which is then plugged into the corresponding male connector, see figure 34, located at the rear of the IED. For location of BIM, BOM and IOM refer to section "[Rear side connectors](#)". Connection diagrams for BIM, BOM and IOM are shown in figure 20, figure 25 and figure 27.

If the IED is equipped with a test-switch of type RTXP 24 COMBIFLEX wires with 20 A sockets, 1.5mm² (AWG16) conductor area must be used to connect the auxiliary power.

Procedure

1. Connect signals to the female connector
All wiring to the female connector should be done before it is plugged into the male part and screwed to the case. The conductors can be of rigid type (solid, stranded) or of flexible type.
The female connectors accept conductors with a cross section area of 0.2-2.5 mm² (AWG 24-14). If two conductors are used in the same terminal, the maximum permissible cross section area is 0.2-1 mm² (AWG 24-18).
If two conductors, each with area 1.5 mm² (AWG 16) need to be connected to the same terminal, a ferrule must be used, see figure 35. This ferrule, is applied with the by Phoenix recommended crimping tool. No soldering is needed. Wires with a smaller gauge can be inserted directly into the female connector receptacle and the fastening screw shall be tightened with a torque of 0.4 Nm (This torque applies to all binary connectors).
2. Plug the connector to the corresponding back-side mounted male connector
3. Lock the connector by fastening the lock screws



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Figure 33: A female connector

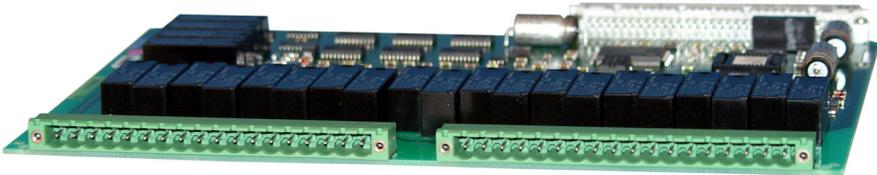
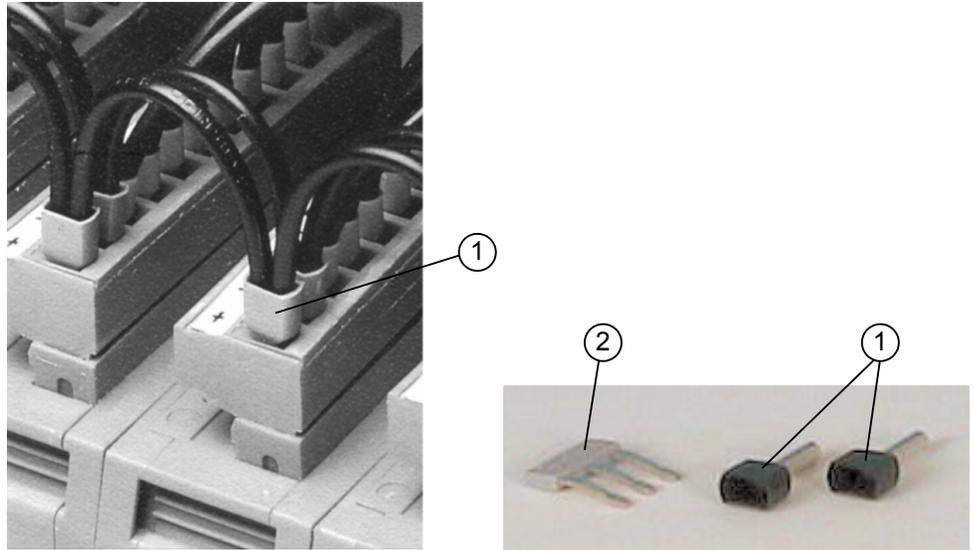


Figure 34: Board with male connectors



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Figure 35: Cable connectors

PosNo	Description
1	Is ferrule,
2	A bridge connector, is used to jump terminal points in a connector.

Table 9: Binary I/O connection system

Connector type	Rated voltage	Maximum conductor area
Screw compression type	250 V AC	2.5 mm ² (AWG14) 2 × 1 mm ² (2 × AWG18)
Terminal blocks suitable for ring lug terminals	300 V AC	3 mm ² (AWG14)



Because of limitations of space, when ring lug terminal is ordered for Binary I/O connections, one blank slot is necessary between two adjacent IO cards. Please refer to the ordering particulars for details.

5.4.6 Making the screen connection

When using screened cables always make sure screens are grounded and connected according to applicable engineering methods. This may include checking for appropriate grounding points near the IED, for instance, in the cubicle and/or near the source of measuring. Ensure that ground connections are made with short (max. 10 cm) conductors of an adequate cross section, at least 6 mm² (AWG10) for single screen connections.

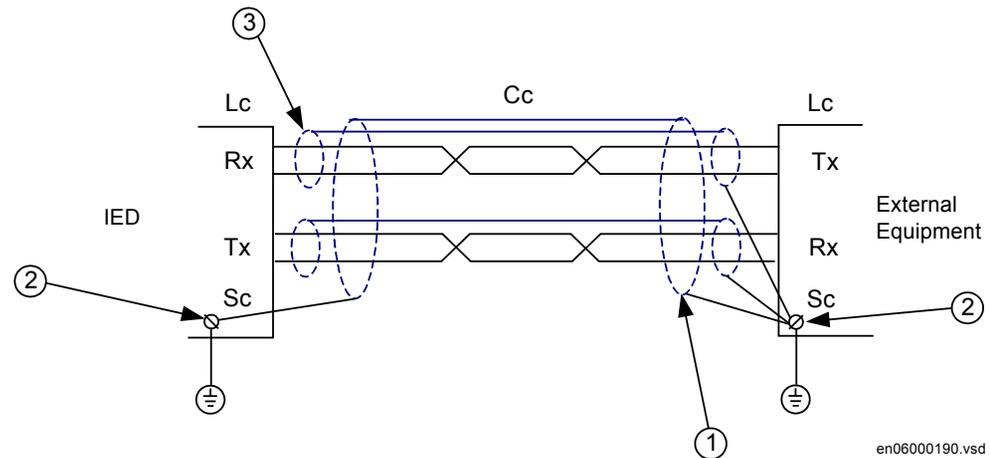


Figure 36: Communication cable installation.

PosNo	Description
1	Outer shield
2	Protective ground screw
3	Inner shield



Inner shielding of the cable shall be grounded at the external equipment end only. At the IED terminal end, the inner shield must be isolated from protective ground.

5.5 Making the optical connections

5.5.1 Connecting station communication interfaces

The IED can be equipped with an optical ethernet module (OEM), see figure [22](#), needed for IEC 61850 communication and a serial communication module (SLM), see figure [22](#) for LON, SPA or IEC 60870–5–103 communication. In such cases optical ports are provided on the rear side of the case for connection of the optical fibers. For location of OEM and SLM, refer to section "[Rear side connectors](#)".

- Optical ports X311: A, B (Tx, Rx) and X311: C, D (Tx, Rx) on OEM are used for IEC 61850-8-1 communication. Connectors are of ST type. When OEM is used, the protection plate for the galvanic connection must not be removed.
- Optical port X301: A, B (Tx, Rx) on SLM module is used for SPA or IEC 60870-5-103 communication. Connectors are of ST type (glass) or HFBR Snap in (plastic).
- Optical port X301: C, D (Tx, Rx) on SLM module is used for LON communication. Connectors are of ST type (glass) or HFBR Snap in (plastic).

The optical fibers have Transmission (Tx) and Reception (Rx) connectors, and they should be attached to the Tx and Rx connectors of OEM and SLM module (Tx cable to Rx connector, Rx cable to Tx connector).

Connectors are generally color coded; connect blue or dark grey cable connectors to blue or dark grey (receive) back-side connectors. Connect black or grey cable connectors to black or grey (transmit) back-side connectors.



The fiber optical cables are very sensitive to handling. Do not bend too sharply. The minimum curvature radius is 15 cm for the plastic fiber cables and 25 cm for the glass fiber cables. If cable straps are used to fix the cables, apply with loose fit.

Always hold the connector, never the cable, when connecting or disconnecting optical fibers. Do not twist, pull or bend the fiber. Invisible damage may increase fiber attenuation thus making communication impossible.



Please, strictly follow the instructions from the manufacturer for each type of optical cables/connectors.

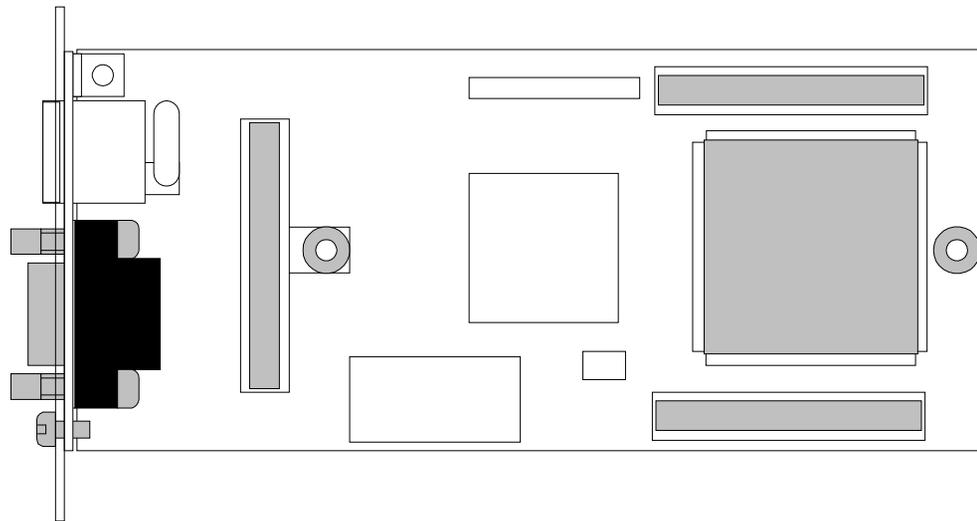
5.5.2 Connecting remote communication interfaces LDCM

The Line Data Communication Module (LDCM), see figure 22 is the hardware used for the transfer of binary and analog signal data between IEDs in different protection schemes on the IEEE/ANSI C37.94 protocol. The optical ports on the rear side of the IED are X302, X303, X312 and X313. For location of LDCM, refer to section "[Rear side connectors](#)".

5.6 Connecting the galvanic X.21 line data communication module

The Galvanic X.21 Line Data Communication Module (X.21 LDCM), see figure 22 is the hardware used for the transfer of binary and analog signal data between IEDs in different protection schemes via telecommunication equipment, for example leased telephone lines. For location of X-21 LDCM , refer to section "[Rear side connectors](#)".

The galvanic X.21 line data communication module uses a ABB specific PC*MIP Type II format.



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Figure 37: Overview of the X.21 LDCM module

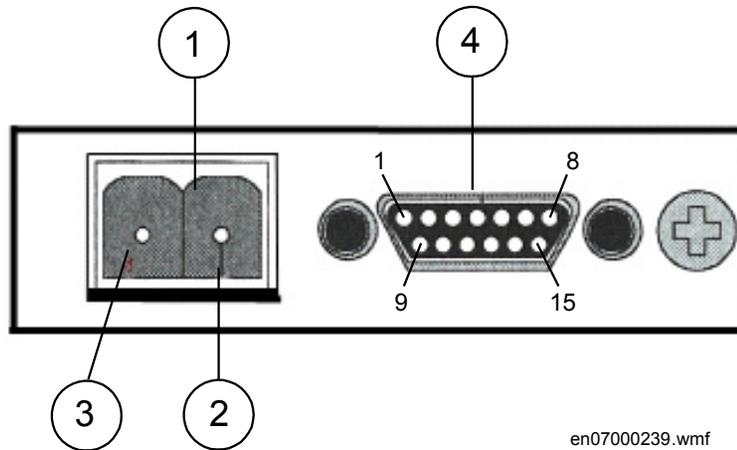


Figure 38: The X.21 LDCM module external connectors

1. Ground selection connector for IO, screw terminals, 2-pole
2. Ground pin
3. Soft ground pin, see figure [39](#)
4. X.21 Micro D-sub 15 pole male connector according to the V11 (X:27) balanced version

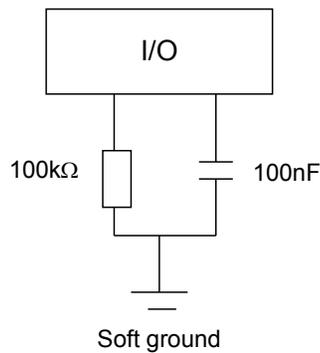


Figure 39: Schematic view of soft ground

Grounding

At special problems with ground loops, the soft ground connection for the IO-ground can be tested.

Three different kinds of grounding principles can be set (used for fault tracing):

1. Direct ground - The normal grounding is direct ground, connect terminal 2 direct to the chassi.
2. No ground - Leave the connector without any connection.
3. Soft ground - Connect soft ground pin (3), see figure [38](#)

X.21 connector

Table 10: *Pinout for the X.21 communication connector*

Pin number	Signal
1	Shield (ground)
2	TXD A
3	Control A
4	RXD A
6	Signal timing A
8	Ground
9	TXD B
10	Control B
11	RXD B
13	Signal timing B
5,7,12,14,15	Not used

5.7 Installing the serial communication cable for RS485

5.7.1 RS485 serial communication module

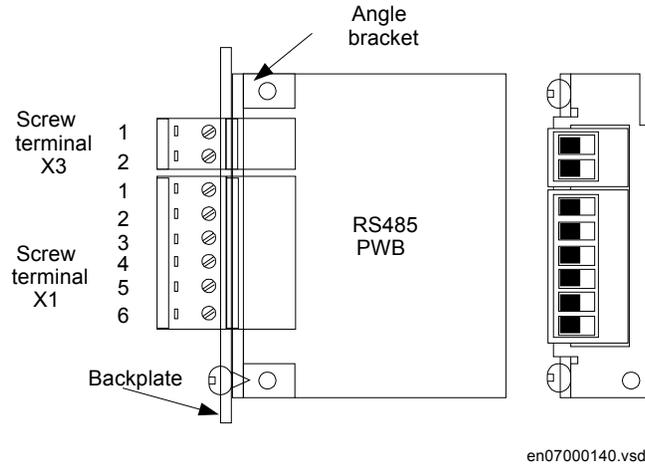


Figure 40: The connection plate to the backplate with connectors and screws. This figure also shows the pin numbering from the component side

Pin	Name 2-wire	Name 4-wire	Description
x3:1			soft ground
x3:2			soft ground
x1:1	RS485 +	TX+	Receive/transmit high or transmit high
x1:2	RS485 -	TX-	Receive/transmit low or transmit low
x1:3	Term	T-Term	Termination resistor for transmitter (and receiver in 2-wire case) (connect to TX+)
x1:4	reserved	R-Term	Termination resistor for receiver (connect to RX +)
x1:5	reserved	RX-	Receive low
x1:6	reserved	RX+	Receive high

Table continues on next page

Pin	Name 2-wire	Name 4-wire	Description
2-wire:	Connect pin X1:1 to pin X1:6 and pin X1:2 to pin X1:5.		
Termination (2-wire):	Connect pin X1:1 to pin X1:3		
Termination (4-wire):	Connect pin X1:1 to pin X1:3 and pin X1:4 to pin X1:6		

The distance between ground points should be < 1200 m (3000 ft), see figure [41](#) and [42](#). Only the outer shielding is connected to the protective ground at the IED. The inner and outer shieldings are connected to the protective ground at the external equipment. Use insulating tape for the inner shield to prevent contact with the protective ground. Make sure that the terminals are properly grounded with as short connections as possible from the ground screw, for example to an grounded frame.

The IED and the external equipment should preferably be connected to the same battery.

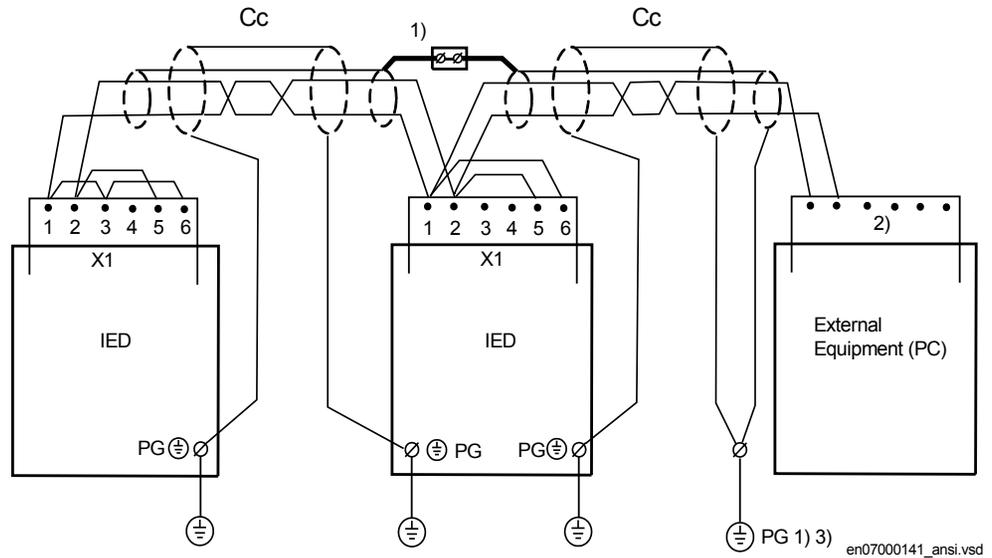


Figure 41: Communication cable installation, 2-wire

Where:

- 1 The inner shields shall be connected together (with an isolated terminal block) and only have **one grounding point** in the whole system, preferably at the external equipment (PC). The outer shield shall be connected to Protective Ground (PG) in every cable end that is, to PG at all IED terminals and to PG at External equipment (PC). The first IED will have only one cable end but all others of course two.
 - 2 Connect according to installation instructions for the actual equipment, observe the 120 ohms termination.
 - 3 The protective ground should be close to the external equipment (< 2m)
- Cc Communication cable
PE Protective ground screw

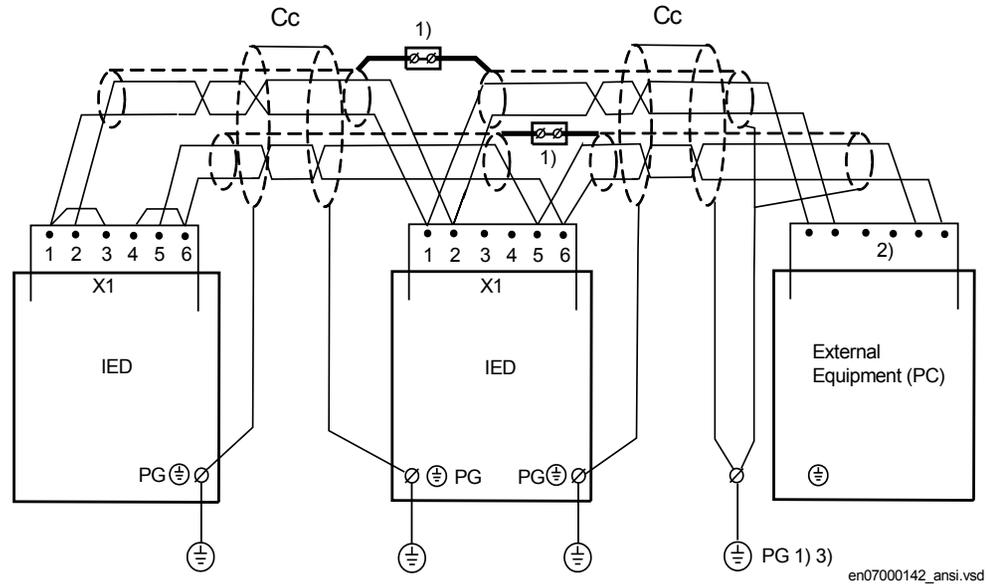


Figure 42: Communication cable installation, 4-wire

Where:

- 1 The inner shields shall be connected together (with an isolated terminal block) and only have **one grounding point** in the whole system, preferably at the external equipment (PC). The outer shield shall be connected to Protective Ground (PG) in every cable end that is, to PG at all IED terminals and to PG at External equipment (PC). The first **IED** will have only one cable end but all others of course two.
 - 2 Connect according to installation instructions for the actual equipment, observe the 120 ohms termination.
 - 3 The protective ground should be close to the external equipment (< 2m)
- Cc Communication cable
PG Protective ground screw

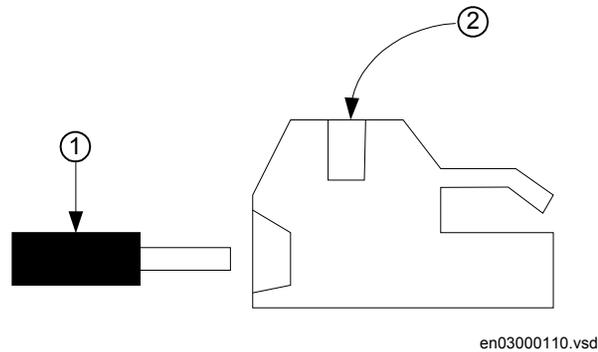


Figure 43: Cable contact, Phoenix: MSTB2.5/6-ST-5.08 1757051

Where:

- 1 is cable
- 2 is screw

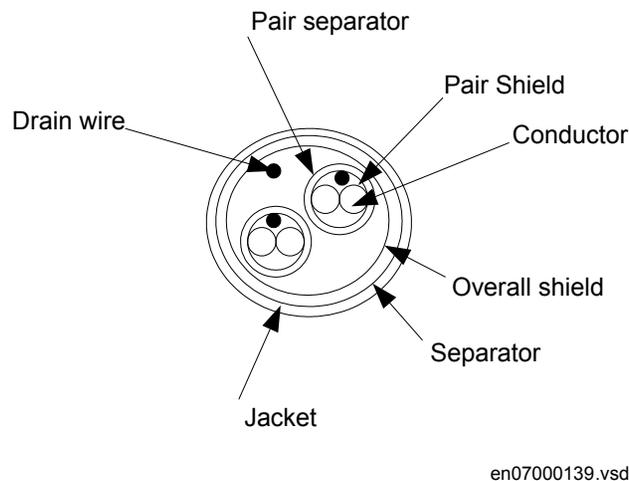


Figure 44: Cross section of communication cable

The EIA standard RS-485 specifies the RS485 network. An informative excerpt is given in section ["Installing the serial communication cable for RS485 SPA/IEC"](#).

5.7.2

Installing the serial communication cable for RS485 SPA/IEC

Informative excerpt from EIA Standard RS-485 - Electrical Characteristics of Generators and Receivers for Balanced Digital Multipoint Systems

RS-485 Wire - Media dependent Physical layer

1 Normative references

EIA Standard RS-485 - Electrical Characteristics of Generators and Receivers for Balanced Digital Multipoint Systems

2 Transmission method

RS-485 differential bipolar signaling

2.1 Differential signal levels

Two differential signal levels are defined:

A+ =line A positive with respect to line B

A- =line A negative with respect to line B

2.2 Galvanic isolation

The RS485 circuit shall be isolated from ground by:

$R_{iso} \geq 10 \text{ M}\Omega$

$C_{iso} \leq 10 \text{ pF}$

Three isolation options exist:

- a) The entire node electronics can be galvanically isolated
- b) The bus interface circuit can be isolated form the rest of node electronics by optoisolators, transformer coupling or otherwise.
- c) The RS485 chip can include built-in isolation

2.3 Bus excitation and signal conveyance

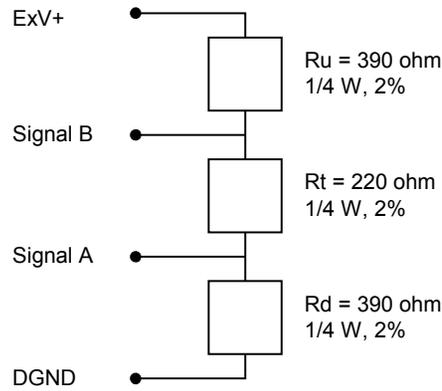
2.3.1 Requirements

- a) The RS485 specification requires the Signal A and Signal B wires.
- b) Each node also requires (5 V) Excitation of the RS485 termination network.
- c) V_{im} - the common mode voltage between any pair of RS485 chips may not exceed 10 V.
- d) A physical ground connection between all RS485 circuits will reduce noise.

2.3.2 Bus segment termination network

The termination network below required at each end of each Bus Ph-segment.

Table continues on next page



ExV is supplied by the Node at end of the Bus Segment

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Figure 45: RS-485 bus segment termination

ExV is supplied by the Node at end of the Bus Segment

The specifications of the components are:

- a) Ru + 5 V to Signal B = 390 Ω, 0.25 W ±2.5%
- b) Rt Signal B to Signal A = 220 Ω, 0.25 W ±2.5%
- c) Rd Signal A to GND = 390 Ω, 0.25 W ±2.5%

2.3.3 Bus power distribution

The end node in each Ph-segment applies 5 V bus excitation power to the Termination network via the Excitation pair (ExV+ and GND) used in the Type 3 Physical layer specification.

5.7.3

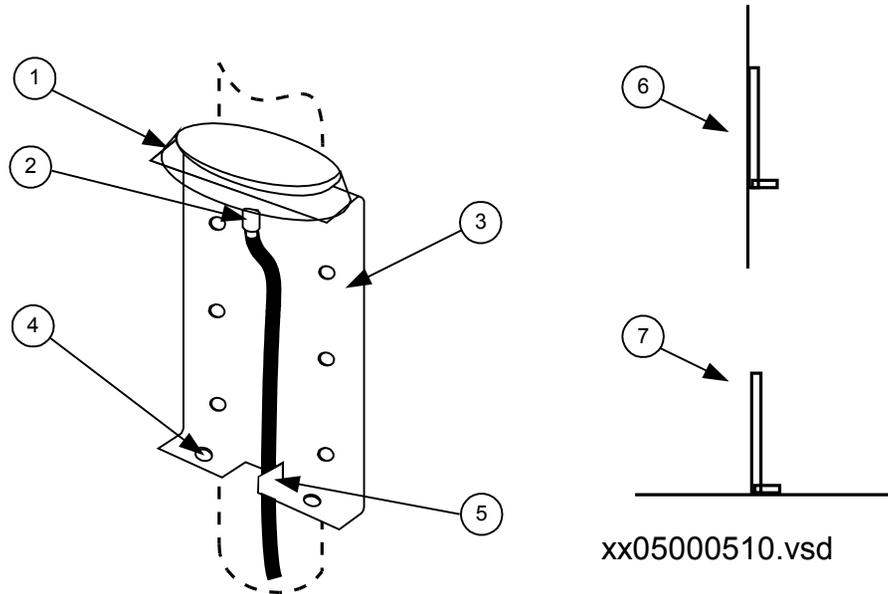
Data on RS485 serial communication module cable

Type:	Twisted-pair S-STP (Screened – Screened Twisted Pair)
Shield:	Individual foil for each pair with overall copper braid
Length:	Maximum 1200 m (3000 ft) from one system ground to the next system ground (includes length from platform point to system ground on both sides)
Temp:	According to application
Impedance:	120 Ω
Capacitance:	Less than or equal to 42 pF/m
Example:	Belden 9841, Alpha wire 6412, 6413

5.8 Installing the GPS antenna

5.8.1 Antenna installation

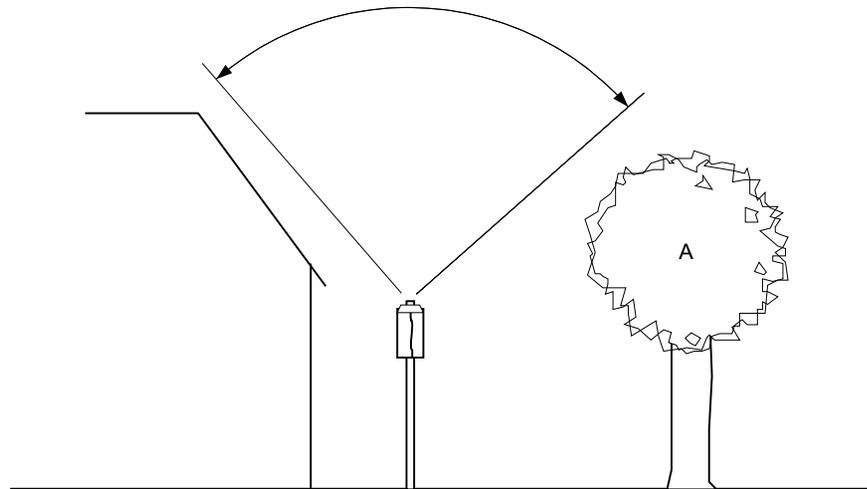
The antenna is mounted on a console for mounting on a horizontal or vertical flat surface or on an antenna mast.



PosNO	Description
1	GPS antenna
2	TNC connector
3	Console, 78x150 mm
4	Mounting holes 5.5 mm
5	Tab for securing of antenna cable
6	Vertical mounting position (on antenna mast etc.)
7	Horizontal mounting position

Mount the antenna and console clear of flat surfaces such as buildings walls, roofs and windows to avoid signal reflections. If necessary, protect the antenna from animals and birds which can affect signal strength. Also protect the antenna against lightning.

Always position the antenna and its console so that a continuous clear line-of-sight visibility to all directions is obtained, preferably more than 75%. A minimum of 50% clear line-of-sight visibility is required for un-interrupted operation.



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Figure 46: Antenna line-of-sight

5.8.2

Electrical installation

Use a 50 ohm coaxial cable with a male TNC connector on the antenna end and a male SMA connector on the receiver end to connect the antenna to the IED. Choose cable type and length so that the total attenuation is max. 26 dB at 1.6 GHz. A suitable antenna cable is supplied with the antenna.

The antenna has a female TNC connector to the antenna cable. For location of GPS module, refer to section "[Rear side connectors](#)". Connection diagram for GPS module is shown in figure [24](#).



Make sure that the antenna cable is not charged when connected to the antenna or to the receiver. Short-circuit the end of the antenna cable with some metal device, then connect to the antenna. When the antenna is connected to the cable, connect the cable to the receiver. The IED must be switched off when the antenna cable is connected.

5.8.3 Lightning protection

The antenna should be mounted with adequate lightning protection, that is the antenna mast must not rise above a neighboring lightning conductor.

Section 6 Checking the external optical and electrical connections

About this chapter

This chapter describes what to check to ensure correct connection to the external circuitry, such as the auxiliary power supply, CT's and VT's. These checks must be made with the protection IED de-energized.

6.1 Overview

The user must check the installation which includes verifying that the IED is connected to the other parts of the protection system. This is done with the IED and all connected circuits de-energized.

6.2 Checking VT circuits

Check that the wiring is in strict accordance with the supplied connection diagram.



Correct all errors before continuing to test circuitry.

Test the circuitry.

- Polarity check
- VT circuit voltage measurement (primary injection test)
- Grounding check
- Phase relationship
- Insulation resistance check

The polarity check verifies the integrity of circuits and the phase relationships. The check should be performed as close to the IED as possible.

The primary injection test verifies the VT ratio and the wiring all the way through from the primary system to the IED. Injection must be performed for each phase-to-neutral

circuit and each phase-to-phase pair. In each case voltages in all phases and neutral are measured.

6.3 Checking CT circuits

The CTs must be connected in accordance with the circuit diagram provided with the IED, both with regards to phases and polarity. The following tests shall be performed on every primary CT connected to the IED:

- Primary injection test to verify the current ratio of the CT, the correct wiring up to the protection IED and correct phase sequence connection (that is A, B, C.)
- Polarity check to prove that the predicted direction of secondary current flow is correct for a given direction of primary current flow. This is an essential test for the proper operation of the differential function.
- CT secondary loop resistance measurement to confirm that the current transformer secondary loop dc resistance is within specification and that there are no high resistance joints in the CT winding or wiring.
- CT excitation test in order to confirm that the current transformer is of the correct accuracy rating and that there are no shorted turns in the current transformer windings. Manufacturer's design curves should be available for the current transformer to compare the actual results.
- Grounding check of the individual CT secondary circuits to verify that each three-phase set of main CTs is properly connected to the station ground and only at one electrical point.
- Insulation resistance check.
- Phase identification of CT shall be made.



Both primary and secondary sides must be disconnected from the line and IED when plotting the excitation characteristics.



If the CT secondary circuit ground connection is removed without the current transformer primary being de-energized, dangerous voltages may result in the secondary CT circuits.

6.4 Checking the power supply

Check that the auxiliary supply voltage remains within the permissible input voltage range under all operating conditions. Check that the polarity is correct before powering the IED.

6.5 Checking the binary I/O circuits

6.5.1 Binary input circuits

Preferably, disconnect the binary input connector from the binary input cards. Check all connected signals so that both input level and polarity are in accordance with the IEDs specifications.

6.5.2 Binary output circuits

Preferably, disconnect the binary output connector from the binary output cards. Check all connected signals so that both load and polarity are in accordance with IED specifications.

6.6 Checking optical connections

Check that the Tx and Rx optical connections are correct.



An IED equipped with optical connections requires a minimum depth of 180 mm for plastic fiber cables and 275 mm for glass fiber cables. The allowed minimum bending radius has to be checked from the optical cable manufacturer.

Section 7 Energizing the IED

About this chapter

This chapter describes the start-up sequence and what to check once the IED has been energized.

7.1 Check the IED operation

Check all connections to external circuitry to ensure that the installation was made correctly, before energizing the IED and carrying out the commissioning procedures.

The user could also check the software version, the IED's serial number and the installed modules and their ordering number to ensure that the IED is according to delivery and ordering specifications.

Energize the power supply of the IED to start it up. This could be done in number of ways, from energizing a whole cubicle to energizing a single IED. The user should re-configure the IED to activate the hardware modules in order to enable the self supervision function to detect possible hardware errors. The IED time must be set. The self-supervision function in the **Main menu/Diagnostics/Monitoring** menu in local HMI should also be checked to verify that the IED operates properly.

7.2 Energizing the IED

When the IED is energized, the green LED instantly starts flashing. After approximately 55 seconds the window lights up and the window displays 'IED Startup'. The main menu is displayed and the upper row should indicate 'Ready' after about 90 seconds. A steady green light indicates a successful startup.

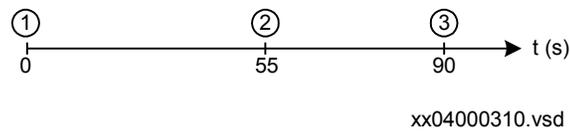


Figure 47: Typical IED start-up sequence

- 1 IED energized. Green LED instantly starts flashing
- 2 LCD lights up and "IED startup" is displayed
- 3 The main menu is displayed. A steady green light indicates a successful startup.

If the upper row in the window indicates 'Fail' instead of 'Ready' and the green LED flashes, an internal failure in the IED has been detected. See [section 3.3 "Checking the self supervision function"](#) in this chapter to investigate the fault.

An example of the local HMI is shown in figure [48](#).

7.3

Design

The different parts of the medium size local HMI are shown in figure [48](#). The local HMI exists in an IEC version and in an ANSI version. The difference is on the keypad operation buttons and the yellow LED designation.

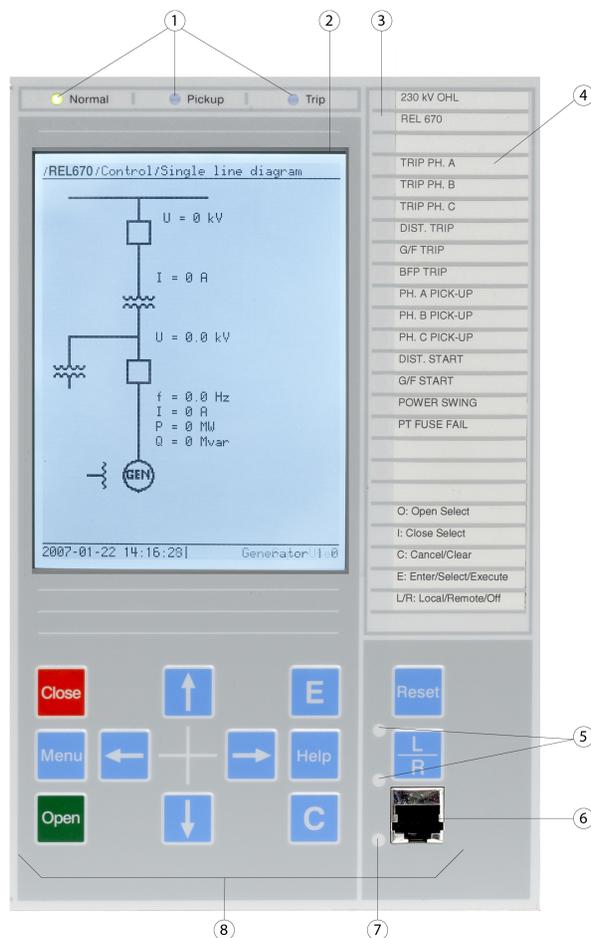


Figure 48: Medium size graphic HMI

- 1 Status indication LEDs
- 2 LCD
- 3 Indication LEDs
- 4 Label
- 5 Local/Remote LEDs
- 6 RJ45 port
- 7 Communication indication LED
- 8 Keypad

7.4 Checking the self supervision signals

7.4.1 Reconfiguring the IED

I/O modules configured as logical I/O modules (BIM, BOM or IOM) are supervised.

I/O modules that are not configured are not supervised.

Each logical I/O module has an error flag that indicates signal or module failure. The error flag is also set when the physical I/O module of the correct type is not detected in the connected slot.

7.4.2 Setting the IED time

This procedure describes how to set the IED time from the local HMI.

1. Display the set time dialog.
Navigate to **Main menu/Settings/Time/System time**
Press the *E* button to enter the dialog.
2. Set the date and time.
Use the *Left* and *Right* arrow buttons to move between the time and date values (year, month, day, hours, minutes and seconds). Use the *Up* and *Down* arrow buttons to change the value.
3. Confirm the setting.
Press the *E* button to set the calendar and clock to the new values.

7.4.3 Checking the self supervision function

7.4.3.1 Determine the cause of an internal failure

This procedure describes how to navigate the menus in order to find the cause of an internal failure when indicated by the flashing green LED on the HMI module.

Procedure

1. Display the general diagnostics menu.
Navigate the menus to:
Diagnostics/IED status/General
2. Scroll the supervision values to identify the reason for the failure.
Use the arrow buttons to scroll between values.

7.4.4 Self supervision HMI data

Table 11: *Signals from the General menu in the diagnostics tree.*

Indicated result	Possible reason	Proposed action
InternFail OK	No problem detected.	None.
InternFail Fail	A failure has occurred.	Check the rest of the indicated results to find the fault.
InternWarning OK	No problem detected.	None.
InternWarning Warning	A warning has been issued.	Check the rest of the indicated results to find the fault.
NUM-modFail OK	No problem detected.	None.
NUM-modFail Fail	The main processing module has failed.	Contact your ABB representative for service.
NUM-modWarning OK	No problem detected.	None.
NUM-modWarning Warning	There is a problem with: <ul style="list-style-type: none"> • the real time clock. • the time synchronization. 	Set the clock. If the problem persists, contact your ABB representative for service.
ADC-module OK	No problem detected.	None.
ADC-module Fail	The AD conversion module has failed.	Contact your ABB representative for service.
CANP 9 BIM1 Fail	IO module has failed.	Check that the IO module has been configured and connected to the IOP1- block. If the problem persists, contact your ABB representative for service.
RealTimeClock OK	No problem detected.	None.
RealTimeClock Warning	The real time clock has been reset.	Set the clock.
TimeSync OK	No problem detected.	None.
TimeSync Warning	No time synchronization.	Check the synchronization source for problems. If the problem persists, contact your ABB representative for service.

Section 8 Set up the PCM600 communication link per IED

About this chapter

This chapter describes the communication between the IED and PCM600.

8.1 Setting up communication between PCM600 and the IED

The communication between the IED and PCM600 is independent of the used communication protocol within the substation or to the NCC.

The communication media is always Ethernet and the used protocol is TCP/IP.

Each IED has an Ethernet interface connector on the front and on the rear side. The Ethernet connector can be used for communication with PCM600.

When an Ethernet based station protocol is used, PCM600 communication can use the same Ethernet port and IP address.

For the connection of PCM600 to the IED two basic variants have to be considered.

- Direct point to point link between PCM600 and the IED front port. The front port can be seen as a service port.
- Indirect link via a station LAN or from remote via a network.

The physical connection and the IP address must be configured in both cases to enable communication.

The communication procedures are in both cases the same.

1. If needed, set the IP address for the IEDs.
2. Set up the PC or workstation for a direct link (point to point), or
3. Connect the PC or workstation to the LAN/WAN network.
4. Configure the IED IP addresses in the PCM600 project for each IED to match the IP addresses of the physical IEDs.

Setting up IP addresses

The IP address and the corresponding mask can be set via the LHMI for each available Ethernet interface in the IED. Each Ethernet interface has a default factory IP address when the complete IED is delivered. This is not given when an additional Ethernet interface is installed or an interface is replaced.

- The default IP address for the IED front port is 10.1.150.3 and the corresponding subnetwork mask is 255.255.255.0, which can be set via the local HMI path **Main menu/Settings/General settings/Communication/Ethernet configuration/Front port**.
- The default IP address for the IED rear port is 192.168.1.10 and the corresponding subnetwork mask is 255.255.0.0, which can be set via the local HMI path **Main menu/Settings/General settings/Communication/Ethernet configuration/Rear OEM - port AB and Rear OEM - port CD**.



The front and rear port IP addresses cannot belong to the same subnet or communication will fail. It is recommended to change the IP address of the front port, if the front and rear port are set to the same subnet.

Setting up the PC or workstation for point to point access to IEDs front port

A special cable is requested to connect two physical Ethernet interfaces together without a hub, router, bridge or switch in between. The Tx and Rx signal wires must be crossed in the cable to connect Tx with Rx on the other side and vice versa. These cables are known as null-modem cable or cross-wired cable. The maximum length should be about 2 m. The connector type is RJ-45, see [Figure 49](#).

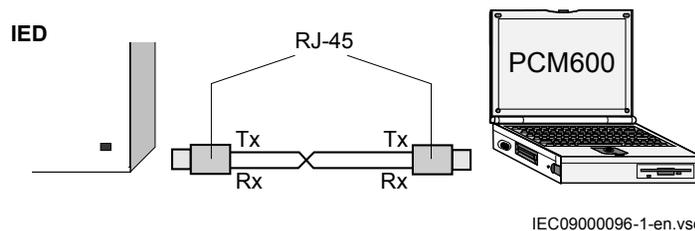


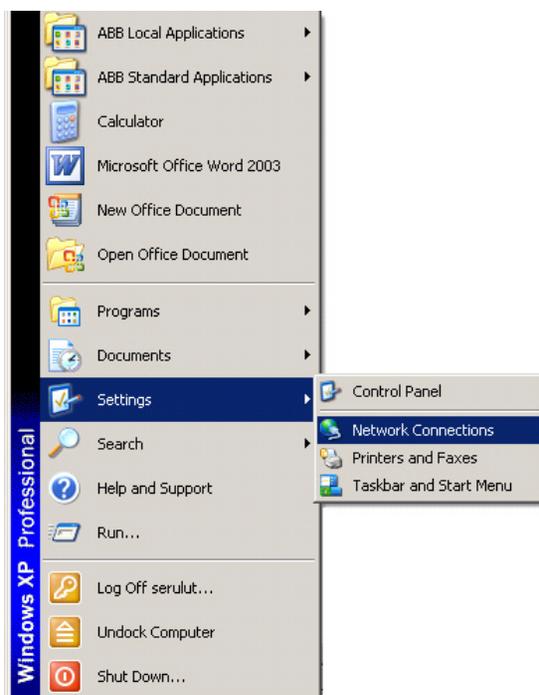
Figure 49: Point to point link between IED and PCM600 using a null-modem cable

The following description is an example valid for standard PCs using Microsoft Windows operating system. The example is taken from a Laptop with one Ethernet interface.



Administrator rights are requested to change the PC communication setup. Some PCs have the feature to automatically detect that Tx signals from the IED are received on the Tx pin on the PC. Thus straight (standard) Ethernet cable can be used.

1. Select *Network Connections* in the PC, see [Figure 50](#).



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Figure 50: Select: Network connections

2. Select *Properties* in the status window, see [Figure 51](#).



Figure 51: Right-click Local Area Connection and select Properties

3. Select the TCP/IP protocol from the list of configured components using this connection and click *Properties*, see [Figure 52](#).

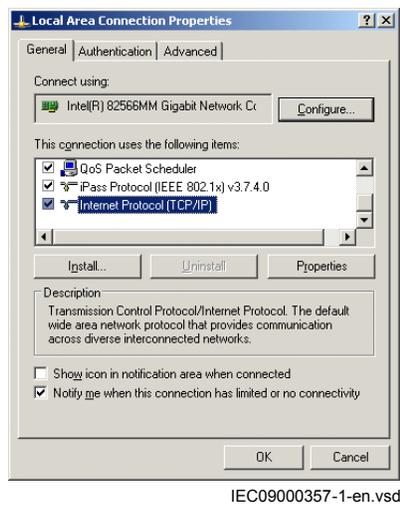
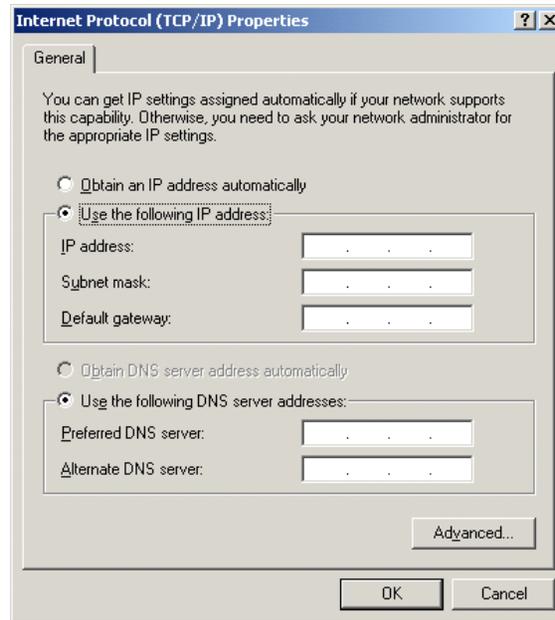


Figure 52: Select the TCP/IP protocol and open Properties

4. Select *Use the following IP address* and define *IP address* and *Subnet mask*, see [Figure 53](#). The IP address must be different from the IP address chosen for the IED.



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Figure 53: Select: Use the following IP address

5. Use the *ping* command to verify connectivity with the IED.
6. Close all open windows and start PCM600.

Setting up the PC to access the IED via a network

This task depends on the used LAN/WAN network. PC and IED must belong to the same subnetwork.

Section 9 Establishing connection and verifying the SPA/IEC- communication

About this chapter

This chapter contains instructions on how to establish connection and verify that the SPA/IEC-communication operates as intended, when the IED is connected to a monitoring or control system via the rear SPA/IEC port.

9.1 Entering settings

If the IED is connected to a monitoring or control system via the rear SPA/IEC port, the SPA/IEC port has to be set either for SPA or IEC use.

9.1.1 Entering SPA settings

The SPA/IEC port is located on the rear side of the IED. Two types of interfaces can be used:

- for plastic fibres with connector type HFBR
- for glass fibres with connectors type ST

When using the SPA protocol, the rear SPA/IEC port must be set for SPA use.

Procedure

1. Set the operation of the rear optical SPA/IEC port to “SPA”.
The operation of the rear SPA port can be found on the local HMI under **Main menu/Settings/General settings/Communication/SLM configuration/Rear optical SPA/IEC port/Protocol selection**
When the setting is entered the IED restarts automatically. After the restart the SPA/IEC port operates as a SPA port.
2. Set the slave number and baud rate for the rear SPA port
The slave number and baud rate can be found on the local HMI under **Main menu/Settings/General settings/Communication/SLM configuration/Rear optical SPA/IEC port/SPA**
Set the same slave number and baud rate as set in the SMS system for the IED.

9.1.2 Entering IEC settings

When using the IEC protocol, the rear SPA/IEC port must be set for IEC use.

Two types of interfaces can be used:

- for plastic fibres with connector type HFBR
- for glass fibres with connectors type ST

Procedure

1. Set the operation of the rear SPA/IEC port to “IEC”.
The operation of the rear SPA/IEC port can be found on the local HMI under **Main menu/Settings/General settings/Communication/SLM configuration/Rear optical SPA/IEC port/Protocol selection**
When the setting is entered the IED restarts automatically. After the restart the selected IEC port operates as an IEC port.
2. Set the slave number and baud rate for the rear IEC port
The slave number and baud rate can be found on the local HMI under **Main menu/Settings/General settings/Communication/SLM configuration/Rear optical SPA/IEC port/IEC60870-5-103**
Set the same slave number and baud rate as set in the IEC master system for the IED.

9.2 Verifying the communication

To verify that the rear communication with the SMS/SCS system is working, there are some different methods. Choose one of the following.

9.2.1 Verifying SPA communication

Procedure

1. Use a SPA-emulator and send “RF” to the IED. The answer from the IED should be “IED 670 ”.
2. Generate one binary event by activating a function, which is configured to an event block where the used input is set to generate events on SPA. The configuration must be made with the PCM600 software. Verify that the event is presented in the SMS/SCS system.

Establishing connection and verifying the SPA/IEC- communication

During the following tests of the different functions in the IED, verify that the events and indications in the SMS/SCS system are as expected.

9.2.2 Verifying IEC communication

To verify that the IEC communication with the IEC master system is working, there are some different methods. Choose one of the following.

Procedure

1. Check that the master system time-out for response from the IED, for example after a setting change, is > 40 seconds.
2. Use a protocol analyzer and record the communication between the IED and the IEC master. Check in the protocol analyzer's log that the IED answers the master messages.
3. Generate one binary event by activating a function that is configured to an event block where the used input is set to generate events on IEC. The configuration must be made with the PCM600 software. Verify that the event is presented in the IEC master system.

During the following tests of the different functions in the IED, verify that the events and indications in the IEC master system are as expected.

9.3 Fibre optic loop

The SPA communication is mainly used for SMS. It can include different numerical IEDs with remote communication possibilities. The fibre optic loop can contain < 20-30 IEDs depending on requirements on response time. Connection to a personal computer (PC) can be made directly (if the PC is located in the substation) or by telephone modem through a telephone network with ITU (CCITT) characteristics.

Table 12: *Max distances between IEDs/nodes*

glass	< 1000 m according to optical budget
plastic	< 25 m (inside cubicle) according to optical budget

Section 9

Establishing connection and verifying the SPA/IEC- communication

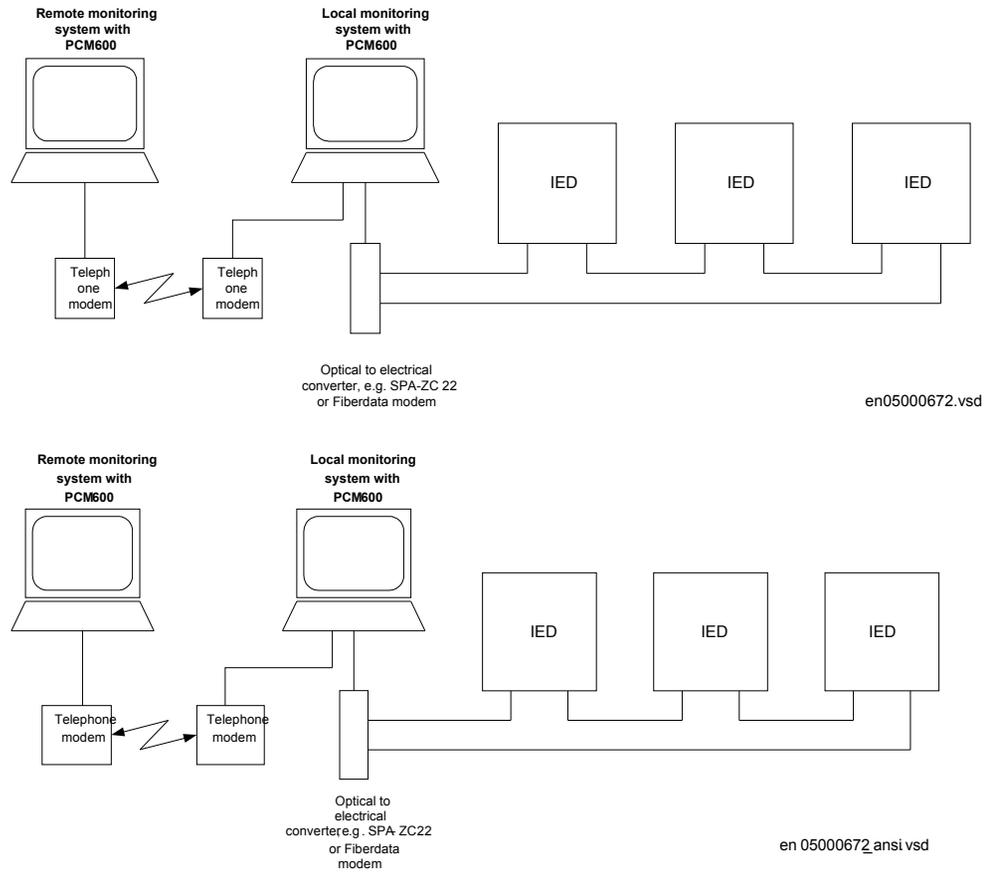


Figure 54: Example of SPA communication structure for a station monitoring system

Where:

- 1 A separate minute pulse synchronization from station clock to obtain ± 1 ms accuracy for time tagging within the substation might be required.

9.4 Optical budget calculation for serial communication with SPA/IEC

Table 13: Example

	Distance 1 km Glass	Distance 25 m Plastic
Maximum attenuation	- 11 dB	- 7 dB
4 dB/km multi mode: 820 nm - 62.5/125 um	4 dB	-
0.16 dB/m plastic: 620 nm - 1mm	-	4 dB
Margins for installation, aging, and so on	5 dB	1 dB
Losses in connection box, two contacts (0.5 dB/contact)	1 dB	-
Losses in connection box, two contacts (1 dB/contact)	-	2 dB
Margin for 2 repair splices (0.5 dB/splice)	1 dB	-
Maximum total attenuation	11 dB	7 dB

Section 10 Establishing connection and verifying the LON communication

About this chapter

This chapter explains how to set up LON communication and how to verify that LON communication is up and running.

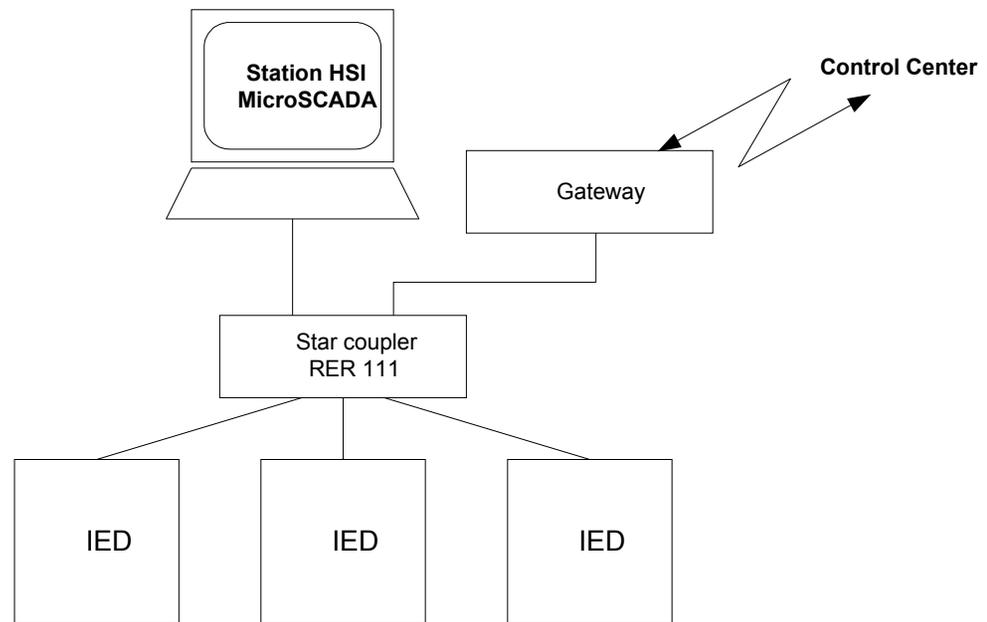
10.1 Communication via the rear ports

10.1.1 LON communication

LON communication is normally used in substation automation systems. Optical fiber is used within the substation as the physical communication link.

The test can only be carried out when the whole communication system is installed. Thus, the test is a system test and is not dealt with here.

The communication protocol Local Optical Network (LON) is available for 670 IED series as an option.



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Figure 55: Example of LON communication structure for a substation automation system

An optical network can be used within the substation automation system. This enables communication with the IEDs in the 670 series through the LON bus from the operator's workplace, from the control center and also from other IEDs via bay-to-bay horizontal communication.

The fibre optic LON bus is implemented using either glass core or plastic core fibre optic cables.

Table 14: *Specification of the fibre optic connectors*

	Glass fibre	Plastic fibre
Cable connector	ST-connector	snap-in connector
Cable diameter	62.5/125 m	1 mm
Max. cable length	1000 m	10 m
Wavelength	820-900 nm	660 nm
Transmitted power	-13 dBm (HFBR-1414)	-13 dBm (HFBR-1521)
Receiver sensitivity	-24 dBm (HFBR-2412)	-20 dBm (HFBR-2521)

10.2.1 The LON Protocol

The LON protocol is specified in the LonTalkProtocol Specification Version 3 from Echelon Corporation. This protocol is designed for communication in control networks and is a peer-to-peer protocol where all the devices connected to the network can communicate with each other directly. For more information of the bay-to-bay communication, refer to the section Multiple command function.

10.2.2 Hardware and software modules

The hardware needed for applying LON communication depends on the application, but one very central unit needed is the LON Star Coupler and optical fibres connecting the star coupler to the IEDs. To interface the IEDs from MicroSCADA, the application library LIB670 is required.

The HV Control 670 software module is included in the LIB520 high-voltage process package, which is a part of the Application Software Library within MicroSCADA applications.

The HV Control 670 software module is used for control functions in IEDs in the 670 series. This module contains the process picture, dialogues and a tool to generate the process database for the control application in MicroSCADA.

Use the LON Network Tool (LNT) to set the LON communication. This is a software tool applied as one node on the LON bus. To communicate via LON, the IEDs need to know

- The node addresses of the other connected IEDs.
- The network variable selectors to be used.

This is organized by LNT.

The node address is transferred to LNT via the local HMI by setting the parameter *ServicePinMsg = Yes*. The node address is sent to LNT via the LON bus, or LNT can scan the network for new nodes.

The communication speed of the LON bus is set to the default of 1.25 Mbit/s. This can be changed by LNT.

The setting parameters for the LON communication are set via the local HMI. Refer to the technical reference manual for setting parameters specifications.

The path to LON settings in the local HMI is **Main menu/Settings/General settings/Communication/SLM configuration/Rear optical LON port**

Establishing connection and verifying the LON communication

If the LON communication from the IED stops, caused by setting of illegal communication parameters (outside the setting range) or by another disturbance, it is possible to reset the LON port of the IED.

By setting the parameter *LONDefault = Yes*, the LON communication is reset in the IED, and the addressing procedure can start from the beginning again.

Path in the local HMI under **Main menu/Settings/General settings/Communication/SLM configuration/Rear optical LON port**

These parameters can only be set with the LON Network Tool (LNT).

Table 15: *Setting parameters for the LON communication*

Parameter	Range	Default	Unit	Parameter description
DomainID	0	0	-	Domain identification number
SubnetID*	0 - 255 Step: 1	0	-	Subnet identification number
NodeID*	0 - 127 Step: 1	0	-	Node identification number
*Can be viewed in the local HMI				

Path in the local HMI under **Main menu/Settings/General settings/Communication/SLM configuration/Rear optical LON port**

These parameters can only be set with the LON Network Tool (LNT).

Table 16: *LON node information parameters*

Parameter	Range	Default	Unit	Parameter description
NeuronID*	0 - 12	Not loaded	-	Neuron hardware identification number in hexadecimal code
Location	0 - 6	No value	-	Location of the node
*Can be viewed in the local HMI				

Path in the local HMI under **Main menu/Settings/General settings/Communication/SLM configuration/Rear optical LON port**

Table 17: *ADE Non group settings (basic)*

Name	Values (Range)	Unit	Step	Default	Description
Operation	Disabled Enabled	-	-	Disabled	Operation
TimerClass	Slow Normal Fast	-	-	Slow	Timer class

Establishing connection and verifying the LON communication

Path in the local HMI under **Main menu/Settings/General settings/Communication/SLM configuration/Rear optical LON port**

Table 18: *LON commands*

Command	Command description
ServicePinMsg	Command with confirmation. Transfers the node address to the LON Network Tool.

10.2

Optical budget calculation for serial communication with LON

Table 19: *Example*

	Distance 1 km Glass	Distance 10 m Plastic
Maximum attenuation	-11 dB	- 7 dB
4 dB/km multi mode: 820 nm - 62.5/125 um	4 dB	-
0.3 dB/m plastic: 620 nm - 1mm	-	3 dB
Margins for installation, aging, and so on	5 dB	2 dB
Losses in connection box, two contacts (0.75 dB/contact)	1.5 dB	-
Losses in connection box, two contacts (1dB/contact)	-	2 dB
Margin for repair splices (0.5 dB/splice)	0.5 dB	-
Maximum total attenuation	11 dB	7 dB

Section 11 Establishing connection and verifying the IEC 61850 communication

About this chapter

This chapter contains instructions on how to establish connection and verify that the IEC 61850 communication operates as intended, when the IED is connected to an Ethernet network via the optical ports of the OEM.

11.1 Overview

The rear OEM ports are used for substation bus (IEC 61850-8-1) communication.

11.2 Setting the station communication

To enable IEC 61850 communication the corresponding OEM ports must be activated. The rear OEM port AB and CD is used for IEC 61850-8-1 communication. For IEC 61850-8-1 redundant communication, both OEM port AB and CD are used exclusively.

To enable IEC 61850 station communication:

1. Enable IEC 61850-8-1 (substation bus) communication for port AB.
 - 1.1. Set values for the rear port AB.

Navigate to: **Main menu/Settings/general settings/Communication/Ethernet configuration/Rear OEM - port AB**

Set values for *Mode*, *IPAddress* and *IPMask*. *Mode* must be set to *Normal*.
Check that the correct IP address is assigned to the port.
 - 1.2. Enable IEC 61850-8-1 communication.

Navigate to: **Main menu/Settings/General settings/Communication/Station communication/IEC 61850-8-1**

Set *Operation* to *Enabled* and *GOOSE* to the port used (for example *OEM311_AB*).

11.3 Verifying the communication

Connect your PC to the nearby switch and ping the connected IED and the Substation Master PC, to verify that the communication is working (up to the transport layer). If it is possible to see all of them, then they can see each other.

The best way to verify the communication up to the application layer is to

- use a protocol analyzer, for example an Ethereal that is connected to the substation bus, and
- monitor the communication

Section 12 Configuring the IED and changing settings

About this chapter

This chapter describes how to change IED settings, either through a PC or the local HMI, and download a configuration to the IED in order to make commissioning possible.

The chapter does not contain instructions on how to create a configuration or calculate settings. Please consult the application manual for further information about how to calculate settings.



It takes a minimum of three minutes for the IED to save the new settings, during this time the DC supply must not be turned off.

The IED uses a FLASH disk for storing configuration data and process data like counters, object states, Local/Remote switch position etc. Since FLASH memory is used, measures have been taken in software to make sure that the FLASH disk is not worn out by too intensive storing of data. These mechanisms make it necessary to think about a couple of issues in order to not lose configuration data, especially at commissioning time.

After the commissioning is complete, the configuration data is always stored to FLASH, so that is not an issue. But other things, like objects states and the Local/Remote switch position is stored in a slightly different way, where the save of data to FLASH is performed more and more seldom to eliminate the risk of wearing out the FLASH disk. In worst case, the time between saves of this kind of data is around one hour.

This means, that to be absolutely sure that all data have been saved to FLASH, it is necessary to leave the IED with auxiliary power connected after all the commissioning is done (including setting the Local/Remote switch to the desired position) for at least one hour after the last commissioning action performed on the IED.

After that time has elapsed, it will be safe to turn the IED off, no data will be lost.

12.1 Overview

The customer specific values for each setting parameter and a configuration file have to be available before the IED can be set and configured, if the IED is not delivered with a configuration.

Use the configuration tools in PCM600 to verify that the IED has the expected configuration. A new configuration is done with the application configuration tool. The binary outputs can be selected from a signal list where the signals are grouped under their function names. It is also possible to specify a user-defined name for each input and output signal.

Each function included in the IED has several setting parameters, which have to be set in order to make the IED behave as intended. A factory default value is provided for each parameter. A setting file can be prepared using the Parameter Setting tool, which is available in PCM600.

All settings can be

- Entered manually through the local HMI.
- Written from a PC, either locally or remotely using SMS/SCS. Front or rear port communication has to be established before the settings can be written.

12.2 Entering settings through the local HMI

Procedure

1. Set each function included in the IED in the local HMI.
2. Browse to the function to be set and enter the appropriate value.
3. Find the parameters for each function in the local HMI

The operator's manual is structured in a similar way to the local HMI and provides a detailed guide to the use of the local HMI including paths in the menu structure and brief explanations of most settings and measurements. See the technical reference manual for a complete list of setting parameters for each function. Some of the included functions may not be used. In this case the user can set the parameter *Operation = Off* to disable the function.

12.3 Configuring analog CT inputs

The analog input channels must be configured to get correct measurement results as well as correct protection functionality. Because all protection algorithms in the IED utilize the primary system quantities, it is extremely important to make sure that connected current transformer settings are done properly. These data are calculated by the system engineer and normally set by the commissioning personnel from the local HMI or from the SMS.

The analog inputs on the transformer input module are dimensioned for either 1A or 5A. Each transformer input module has a unique combination of current and voltage inputs. Make sure the input current rating is correct and that it matches the order documentation.

The primary CT data are entered via the HMI menu under **Main menu/Settings/General Settings/Analog modules/AnalogInputs**

The following parameter shall be set for every current transformer connected to the IED:

Table 20: CT configuration

Parameter description	Parameter name	Range	Default
Rated CT primary current in A	CT Prim Input	from -10000 to +10000	0

This parameter defines the primary rated current of the CT. For two set of CTs with ratio 1000/1 and 1000/5 this parameter is set to the same value of 1000 for both CT inputs. Negative values (that is -1000) can be used in order to reverse the direction of the CT current by software for the differential function. This might be necessary if two sets of CTs have different neutral (WYE) point locations in relation to the protected busbar. It is recommended that this parameter is set to zero, for all unused CT inputs.

For main CTs with 2A rated secondary current, it is recommended to connect the secondary wiring to the 1A input and to set the rated primary current to one half times its true value. For example, a CT with a primary secondary current ratio of 1000/2A can be treated as a 500/1A CT.



Take the rated permissive overload values for the current inputs into consideration.

12.4 Downloading settings and configuration from a PC

12.4.1 Writing an application configuration to the IED

When writing a configuration to the IED with the application configuration tool, the IED is automatically set in configuration mode. When the IED is set in configuration mode, all functions are blocked. The red LED on the IED flashes, and the green LED is lit while the IED is in the configuration mode.

When the configuration is written and completed, the IED is automatically set into normal mode. For further instructions please refer to the users manuals for PCM600.

Section 13 Verifying settings by secondary injection

About this chapter

This chapter describes how to verify that protection functions operate correctly and according to their settings. It is preferable that only the tested function is in operation.

13.1 Overview

IED test requirements:

- Calculated settings
- Application configuration diagram
- Signal matrix (SMT) configuration
- Terminal diagram
- Technical reference manual
- Three-phase test equipment
- PCM600

The setting and configuration of the IED must be completed before the testing can start.

The terminal diagram, available in the technical reference manual, is a general diagram of the IED.



Note that the same diagram is not always applicable to each specific delivery (especially for the configuration of all the binary inputs and outputs).

Therefore, before testing, check that the available terminal diagram corresponds to the IED.

The technical reference manual contains application and functionality summaries, function blocks, logic diagrams, input and output signals, setting parameters and technical data sorted per function.

The test equipment should be able to provide a three-phase supply of voltages and currents. The magnitude of voltage and current as well as the phase angle between voltage and current must be variable. The voltages and currents from the test equipment must be obtained from the same source and they must have minimal

harmonic content. If the test equipment cannot indicate the phase angle, a separate phase-angle measuring instrument is necessary.

Prepare the IED for test before testing a particular function. Consider the logic diagram of the tested protection function when performing the test. All included functions in the IED are tested according to the corresponding test instructions in this chapter. The functions can be tested in any order according to user preferences and the test instructions are therefore presented in alphabetical order. Only the functions that are used (*Operation* is set to *On*) should be tested.

The response from a test can be viewed in different ways:

- Binary outputs signals
- Service values on the local HMI (logical signals or phasors)
- A PC with PCM600 application configuration software in debug mode

All setting groups that are used should be tested.



This IED is designed for a maximum continuous current of four times the rated current.



Please observe the measuring accuracy of the IED, the test equipment and the angular accuracy for both of them.



Please consider the configured logic from the function block to the output contacts when measuring the operate time.

13.2 Preparing for test

13.2.1 Preparing the IED to verify settings

If a test switch is included, start preparation by making the necessary connections to the test switch. This means connecting the test equipment according to a specific and designated IED terminal diagram.

Put the IED into test mode to facilitate the test of individual functions and prevent unwanted operation caused by other functions. The test switch should then be connected to the IED.

Verify that analog input signals from the analog input module are measured and recorded correctly by injecting currents and voltages required by the specific IED.

To make testing even more effective PCM600 should be used. PCM600 includes the Signal monitoring tool, which is useful to read of the individual currents and voltages, their amplitudes and phase angles. In addition PCM600 contains the Disturbance handling tool. The content of reports generated by the Disturbance handling tool can be configured which makes the work more efficient. For example, the tool may be configured to only show time tagged events and to exclude analog information and so on.

The disturbance report settings must be checked to ensure that indications are correct.

Functions to test, signal and parameter names can be found in the technical reference manual. The correct initiation of the disturbance recorder is made on start and/or release or trip from a function. Also check that the wanted recordings of analogue (real and calculated) and binary signals are achieved.



Parameters can be entered into different setting groups. Make sure to test functions for the same parameter setting group. If needed the tests must be repeated for all different setting groups used. The difference between testing the first parameter setting group and the remaining is that there is no need for testing the connections.

Observe during testing that the right method for testing must be used that corresponds to the actual parameters set in the activated parameter setting group.

Set and configure the function(s) before the testing can start. Most functions are highly flexible and permit a choice of functional and tripping modes. The various modes are checked at the factory as part of the design verification. In certain cases only modes with a high probability of coming into operation need to be checked when commissioned to verify the configuration and settings.

13.2.2

Preparing the connection to the test equipment

The IED can be equipped with a test switch of type RTXP8, RTXP18 or RTXP24 or FT. The test switch and its associated test plug handles are a part of the COMBITEST or FT system of ABB, which provides secure and convenient testing of the IED.

When using the COMBITEST, preparations for testing are automatically carried out in the proper sequence, that is for example, blocking of tripping circuits, short circuiting of CT's, opening of voltage circuits, making IED terminals available for secondary injection). Terminals 1 and 8, 1 and 18 as well as 1 and 12 of the test switches RTXP8, RTXP18 and RTXP24 respectively are not disconnected as they supply DC power to the protection IED. When FT switch is used for testing, care shall be exercised to open the tripping circuit, ahead of manipulating the CT fingers.

The RTXH test-plug handle leads may be connected to any type of test equipment or instrument. When a number of protection IEDs of the same type are tested, the test-plug handle only needs to be moved from the test switch of one protection IED to the test switch of the other, without altering previous connections.

Use COMBITEST test system to prevent unwanted tripping when the handle is withdrawn, since latches on the handle secure it in the half withdrawn position. In this position, all voltages and currents are restored and any reenergizing transients are given a chance to decay before the trip circuits are restored. When the latches are released, the handle can be completely withdrawn from the test switch, restoring the trip circuits to the protection IED.

If a test switch is not used, take measures according to provided circuit diagrams.



Never disconnect the secondary connection of a current transformer circuit without short-circuiting the transformer's secondary winding. Operating a current transformer with the secondary winding open will cause a massive potential build up that may damage the transformer and injure humans.

13.2.3

Activating test mode

The IED shall be put into test mode before testing. Test mode blocks all functions in the IED and the individual functions to be tested can be unblocked to prevent unwanted operation caused by other functions. In this way, it is possible to test slower back-up measuring functions without the interference from faster measuring functions. Test mode is indicated when the yellow Start LED flashes.

Procedure

1. Browse to the **TestMode** menu and press *E*.
The **TestMode** menu is found on the local HMI under **Main menu/Test/IED test mode/TestMode**
2. Use the up and down arrows to choose *On* and press *E*.
3. Press the left arrow to exit the menu.
The dialog box *Save changes* appears.
4. Choose *Yes*, press *E* and exit the menu.
The yellow pickupLED above the LCD will start flashing when the IED is in test mode.

13.2.4

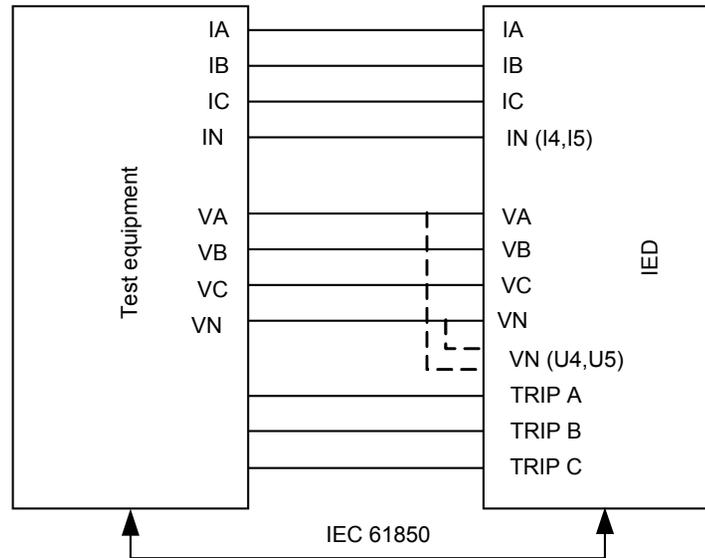
Connecting test equipment to the IED

Connect the test equipment according to the IED specific connection diagram.

The current and voltage terminals must be connected. Pay attention to the current polarity. Make sure that the connection of input and output current terminals and the connection of the residual current conductor is correct. Check that the input and output logical signals in the logic diagram for the function under test are connected to the corresponding binary inputs and outputs of the IED under test.



To ensure correct results, make sure that the IED as well as the test equipment are properly grounded before testing.



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Figure 56: Connection example of the test equipment to the IED when test equipment is connected to the transformer input module

13.2.5

Verifying analog primary and secondary measurement

Verify that the connections are correct and that measuring and scaling is correctly. This is done by injecting current and voltage to the IED.



Apply input signals as needed according to the actual hardware and the application configuration made in PCM600.

1. Inject a symmetrical three-phase voltage and current at rated value.
2. Compare the injected value with the measured values.
The voltage and current phasor menu in the local HMI is located under **Main menu/Measurements/Analog primary values** and **Main menu/Measurements/Analog secondary values**.
3. Compare the frequency reading with the set frequency and the direction of the power.
The frequency and active power are located under **Main menu/Measurements/Monitoring/ServiceValues(MMXU)/SVRx**. Then navigate to the bottom of the list to find the frequency.
4. Inject an unsymmetrical three phase voltage and current, to verify that phases are correctly connected.

If some setting deviates check the analog input settings under

Main menu/Settings/General settings/Analog modules

13.2.6

Releasing the function to be tested

Release or unblock the function to be tested. This is done to ensure that only the function or the chain of functions to be tested are in operation and that other functions are prevented from operating. The user can release the tested function(s) by setting the corresponding *Blocked* parameter under Function test modes to *No* in the local HMI.

When testing a function in this blocking feature, remember that not only the actual function must be activated, but the whole sequence of interconnected functions (from measuring inputs to binary output contacts), including logic and so on. Before starting a new test mode session the user should scroll through every function to ensure that only the function to be tested (and the interconnected ones) have the parameters *Blocked* and eventually *EvDisable* are set to *No* and *Yes* respectively. Remember that a function is also blocked if the BLOCK input signal on the corresponding function block is active, which depends on the configuration. Ensure that the logical status of the BLOCK input signal is equal to 0 for the function to be tested. Event function blocks can also individually be blocked to ensure that no events are reported to a remote station during the test. This is done by setting the parameter *EvDisable* to *Yes*.



Any function is blocked if the corresponding setting in the local HMI under **Main menu/Test/Function test modes** menu remains *On*, that is the parameter *Blocked* is set to *Yes* and the parameter *TestMode* under **Main menu/Test/IED test mode** remains active. All functions that were blocked or released from a previous test mode session, that is the parameter *Test mode* is set to *On*, are reset when a new test mode session is started.

 Procedure

1. Browse to the **Function test modes** menu.
The Function test modes menu is located in the local HMI under **Main menu/Test/Function test modes**.
2. Browse to the function instance that should be released.
3. Set parameter *Blocked* for the selected function to *Yes*.

13.2.7 Disturbance report

13.2.7.1 Introduction

The following sub-functions are included in the disturbance report function:

- Disturbance recorder
- Event list
- Event recorder
- Fault locator
- Trip value recorder
- Indications

If the disturbance report is set on, then its sub-functions are also set up and so it is not possible to only switch these sub-functions off. The disturbance report function is switched off (parameter *Operation = Off*) in PCM600 or the local HMI under **Main menu/Settings/General settings/Monitoring/DisturbanceReport/DisturbanceReport(RDRE)**.

13.2.7.2 Disturbance report settings

When the IED is in test mode, the disturbance report can be made active or inactive. If the disturbance recorder is turned on during test mode, recordings will be made. When test mode is switched off all recordings made during the test session are cleared.

Setting *OpModeTest* for the control of the disturbance recorder during test mode are located on the local HMI under **Main menu/Settings/General settings/Monitoring/DisturbanceReport/DisturbanceReport(RDRE)**.

13.2.7.3 Disturbance recorder (DR)

A *Manual Trig* can be started at any time. This results in a recording of the actual values from all recorded channels.

The *Manual Trig* can be initiated in two ways:

1. From the local HMI under **Main menu/Disturbance records**.
 - 1.1. Enter on the row at the bottom of the HMI called **Manual trig**.
The newly performed manual trig will result in a new row.
 - 1.2. Navigate to **General information** or to **Trip values** to obtain more detailed information.
2. Open the Disturbance handling tool for the IED in the plant structure in PCM600.
 - 2.1. Right-click and select *Execute manual Trig* in the window *Available recordings in IED*.
 - 2.2. Read the required recordings from the IED.
 - 2.3. Refresh the window *Recordings* and select a recording.
 - 2.4. Right-click and select *Create Report* or *Open With* to export the recordings to any disturbance analyzing tool that can handle Comtrade formatted files.

Evaluation of the results from the disturbance recording function requires access to a PC either permanently connected to the IED or temporarily connected to the Ethernet port (RJ-45) on the front. The PCM600 software package must be installed in the PC.

Disturbance upload can be performed by the use of PCM600 or by any third party tool with IEC 61850 protocol. Reports can automatically be generated from PCM600. Disturbance files can be analyzed by any tool reading Comtrade formatted disturbance files.

13.2.7.4

Event recorder (ER) and Event list (EL)

The result from the event recorder and event list can be viewed on the local HMI or, after upload, in PCM600 as follows:

1. on the local HMI under **Main menu/Events**, or in more details via
2. the *Event Viewer* in PCM600.
The internal FIFO register of all events will appear when the event viewer is launched.

When the IED is brought into normal service it is recommended to delete all events resulting from commissioning tests to avoid confusion in future fault analysis. All event in the IED can be cleared in the local HMI under **Main Menu//Reset/Reset internal event list** or **Main menu/Reset/Reset process event list**. It is not possible to clear the event lists from PCM600.

When testing binary inputs, the event list (EL) might be used instead. No uploading or analyzing of registrations is then needed since the event list keeps running, independent of start of disturbance registration.

13.2.8 Identifying the function to test in the technical reference manual

Use the technical reference manual (to identify function blocks, logic diagrams, input and output signals, setting parameters and technical data.

13.2.9 Exit test mode

The following procedure is used to return to normal operation.

Procedure

1. Navigate to the test mode folder.
2. Change the 'On' setting to 'Off'. Press the 'E' key and the left arrow key.
3. Answer 'YES', press the 'E' key and exit the menus.

13.3 Basic IED functions

13.3.1 Parameter setting group handling SETGRPS

Prepare the IED for verification of settings as outlined in section ["Overview"](#) and section ["Preparing for test"](#) in this chapter.

13.3.1.1 Verifying the settings

1. Check the configuration of binary inputs that control the selection of the active setting group.
2. Browse to the **ActiveGroup** menu to achieve information about the active setting group.
The **ActiveGroup** menu is located on the local HMI under **Main menu/Test/Function status/Setting groups/ActiveGroup**
3. Connect the appropriate dc voltage to the corresponding binary input of the IED and observe the information presented on the local HMI.
The displayed information must always correspond to the activated input.
4. Check that the corresponding output indicates the active group.
Operating procedures for the PC aided methods of changing the active setting groups are described in the corresponding PCM600 documents and instructions for the operators within the SCS are included in the SCS documentation.

13.3.1.2 Completing the test

Continue to test another function or end the test by changing the *Test mode* setting to *Off*. Restore connections and settings to their original values, if they were changed for testing purposes.

13.4 Differential protection

13.4.1 High impedance differential protection HZPDIF (87)

Prepare the IED for verification of settings as outlined in section ["Overview"](#) and section ["Preparing for test"](#) in this chapter.

13.4.1.1 Verifying the settings

1. Connect single-phase or three-phase test set to inject the operating voltage. The injection shall be on the primary side of the stabilizing resistor.



As the operating voltage is adjusted on the stabilizing resistor and with the setting of the resistor value in the function this is essential for the measurement of the expected value. Normally a slightly higher operating value is no problem as the sensitivity is not influenced much.

2. Connect the trip contact to the test set to stop the test set for measurement of trip times below.
3. Increase the voltage and make note of the operate value *Pickup*. This is done with manual test and without trip of the test set.
4. Reduce the voltage slowly and make note of the reset value. The reset value must be high for this function.
5. Check the operating time by injecting a voltage corresponding to $1.2 \cdot Pickup$ level. Make note of the measured trip time.
6. If required, verify the trip time at another voltage. Normally $2 \cdot Pickup$ is selected.
7. If used, measure the alarm level operating value. Increase the voltage and make note of the operate value *AlarmPickup*. This is done with manual test and without trip of the test set.

8. Measure the operating time on the alarm output by connecting the stop of the test set to an output from *tAlarm*. Inject a voltage $1.2 \cdot AlarmPickup$ and measure the alarm time.
9. Check that trip and alarm outputs operate accordingly to the configuration logic.
10. Finally check that pickup and alarm information is stored in the event menu and if a serial connection to the SA is available verify that the correct and only the required signals are presented on the local HMI and on the SCADA system.



Information on how to use the event menu is found in the operator's manual.

13.4.1.2

Completing the test

Continue to test another function or end the test by changing the *Test mode* setting to *Off*. Restore connections and settings to their original values, if they were changed for testing purposes.

13.4.2

Line differential protection L3CPDIF (87L) and L6CPDIF (87L)

Prepare the IED for verification of settings as outlined in section ["Overview"](#) and section ["Preparing for test"](#) in this chapter.

The test of the line differential protection is done with the different IEDs geographically separated from each other. It is important to note that local actions, in one IED, may cause operation in remotely located IEDs. In the test of the line differential function actions must be done in all involved IEDs.

Before test the trip signal to the circuit breaker must be blocked, for example by applying the COMBITEST test switch or opening the trip link through FT switch.

Line differential protection must be set in test mode. In the test mode the injected current is communicated to the remote IEDs and sent back to the IED under test. The echoed current is switched in phase so that current in phase A is returned in phase B, current in phase B is returned in phase C and current in phase C is returned in phase A. The magnitude of the returned current can be set as a ratio of the injected current.

Take a line with three IEDs, for example, set the return current from each remote IED to be 50% of the injected current. Inject a current I in phase A to get the following differential and bias currents:

Phase A:

$$IDiff_A = IBias_A = I_{injected,A}$$

Phase B:

$$IDiff_B = IBias_B = I_{injected,A} \cdot 1 \angle 240^\circ$$

Phase C:

$$IDiff_B = IBias_B = 0$$

13.4.2.1

Verifying the settings

Procedure

1. Block the trip signal from all involved IEDs.
2. Set *Test mode* to *On* for the Line differential function for test.
3. Set the factor of the return currents to $1/(\text{number of current IEDs} = 1)$.
4. Inject a current in phase A and increase the current until the function operates for phases A and B.
The injected operate current must correspond to the set *IminOp*. The service values for *IDiff_A*, *IBias_A*, *IDiff_B* and *IBias_B* must be equal to the injected current.
5. Repeat step 3 by current injection in phases B and C.
6. Inject a symmetrical three-phase current, and increase the current until operation is achieved in all three phases.
The injected operate current must correspond to the set *IminOp*. The service values for *IDiff_A*, *IBias_A*, *IDiff_B*, *IBias_C*, *IDiff_C* and *IBias_C* must be equal to the injected current.
7. Read the transmission delay.
8. Measure the operating time by injection of a single-phase current in phase A.
The injected current must be 4 times the operating current. The time measurement is stopped by the trip output.
9. Check the negative sequence fault discriminator by injecting a three-phase current with changed phase sequence: switch phases A and B. The injected current will now be seen as a pure negative-sequence current where the phase angle between the local negative-sequence current and the remote negative-sequence currents will be 120° .
With the current above *IminOp*, the signal external fault (EXTFAULT) must apply. No trip must be generated.
10. Disconnect the test equipment and reconnect the current transformers.

11. Read and check the service values of the three-phase current.
12. Switch off the test mode.
13. With a through load current (maximum current of line ends) of minimum 20% of I_{Base} the current $IDiff$ and $IBias$ are read in all phases. $IDiff$ must be less than 10% of the maximum line end current and $IBias$ must be equal to the largest line end current.

13.4.2.2 Completing the test

Continue to test another function or end the test by changing the *Test mode* setting to *Off*. Restore connections and settings to their original values, if they were changed for testing purposes.



After finishing a loop test with line in service, the test mode *Release local* setting must be switched off before disconnecting the test handle. If not, the load current might cause incorrect operation of the differential function.

13.5 Impedance protection

13.5.1 Distance protection zones, quadrilateral characteristic ZMQPDIS (21)

Prepare the IED for verification of settings as outlined in section ["Overview"](#) and section ["Preparing for test"](#) in this chapter.

Consider releasing Zone 1, the Phase selection with load encroachment, quadrilateral characteristic (FDPSDPIS) and the tripping logic SMPPTRC. If the autorecloser is not released and in service, trip will always be three phase.

Measure operating characteristics during constant current conditions. Keep the measured current as close as possible to its rated value or lower. But make sure it is higher than 30% of the rated current.

Ensure that the maximum continuous current in an IED does not exceed four times its rated value, if the measurement of the operating characteristics runs under constant voltage conditions.

The test procedure has to take into consideration that the shaped load encroachment characteristic is active. It is therefore necessary to check the setting. To verify the settings with the shaped load encroachment characteristic the test should be carried out

according to figures 57 and 58 and tables 21 and 22. In cases where the load encroachment characteristic is activated tests according to the adjusted figures should be carried out.

To verify the settings for the operating points according to the following fault types should be tested:

- One phase-to-phase fault
- One phase-to-earth fault

The shape of the operating characteristic depends on the values of the setting parameters.



The figures illustrating the characteristic for the distance protection function can be used for settings with and without load encroachment. The solid lines designate the diagram applicable when the load current compensation *operationLdCom* parameter is set to 1 (On). This is the default setting. The solid line and all test points except 13 are valid for this setting.

When it is set to 0 (Off) then the dotted lines and test point 13 are valid. Test points 5, 6, and 7 are not valid for this measurement.

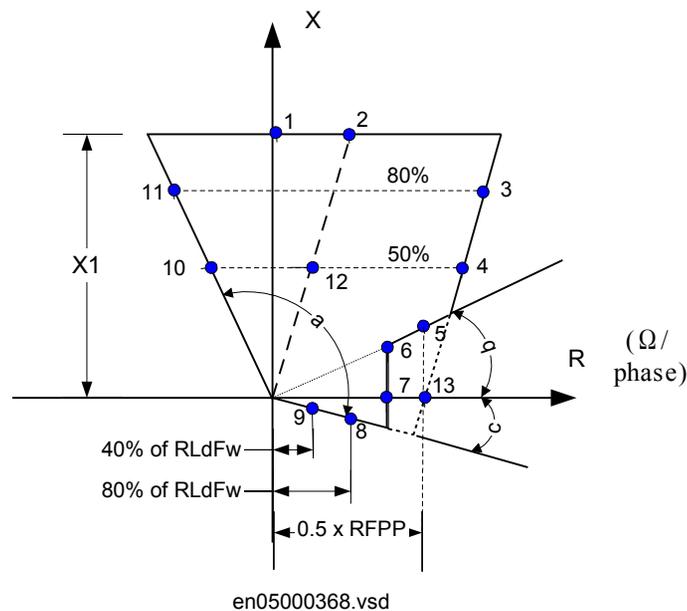


Figure 57: Distance protection characteristic with test points for phase-to-phase measurements

Table 21 is used in conjunction with figure 57.

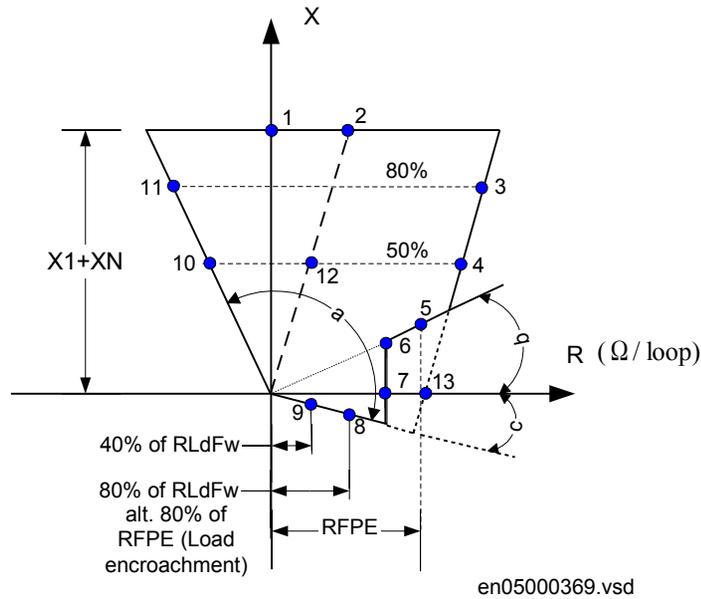


Figure 58: Distance protection characteristic with test points for phase-to-earth measurements

Table 22 is used in conjunction with figure 58.

Table 21: Test points for phase-to-phase loops L1-L2 (Ohm/Loop)

Test point	Reach	Set value	Comments
1	X	$X1_{set}$	
	R	0	
2	X	$X1_{set}$	
	R	$R1_{set}$	
3	X	$0.8 \times X1_{set}$	
	R	$0.8 \times R1_{set} + RFPP/2$	
4	X	$0.5 \times X1_{set}$	
	R	$0.5 \times R1_{set} + RFPP/2$	
5	X	$0.85 \times RFPP \times \tan(\text{ArgRLd})$	$\text{ArgRLd} = \text{angle for the maximal load transfer}$
	R	$0.85 \times RFPP$	
6	X	$RLdFw \times \tan(\text{ArgLd})$	
	R	$RLdFw$	

Table continues on next page

Section 13 Verifying settings by secondary injection

Test point	Reach	Set value	Comments
7	X	$RLdFw \times \tan(\text{ArgLd})$	
	R	0	
8	X	$-0.2143 \times RFPP/2$	Exact: $0.8 \times RFPP/2$ (ArgDir)
	R	$0.8 \times RFPP/2$	
9	X	$-0.4 \times RLdFw \times \tan(\text{ArgDir})$	
	R	$0.4 \times RLdFw$	
10	X	$0.5 \times X1_{set}$	Exact $-0.5 \times R1_{set} \times \tan(\text{ArgNegRes-90})$
	R	$-0.23 \times X1_{set}$	
11	X	$0.8 \times X1_{set}$	Exact $-0.5 \times R1_{set} \times \tan(\text{ArgNegRes-90})$
	R	$-0.37 \times X1_{set}$	
12	X	$0.5 \times X1_{set}$	
	R	$0.5 \times R1_{set}$	
13	X	0	Only used when <i>OperationLdCmp</i> setting is 0 (Off)
	R	$0.5 \times RFPP$	

Table 22: Test points for phase-to-earth L3-E (Ohm/Loop)

Test point	Reach	Value	Comments
1	X	$(2 \times X1_{set} + X0_{set})/3$	
	R	0	
2	X	$(2 \times X1_{set} + X0_{set})/3$	
	R	$2 \times R1_{set} + R0_{set}/3$	
3	X	$0.8 \times (2 \times X1_{set} + X0_{set})/3$	
	R	$0.8 \times (2 \times R1_{set} + R0_{set})/3 + RFPE_{set}$	
4	X	$0.5 \times (2 \times X1_{set} + R0_{set})/3$	
	R	$0.5 \times (2 \times R1_{set} + R0_{set})/3 + RFPE_{set}$	
5	X	$0.85 \times RFPE_{set} \times \tan(\text{ArgLdset})$	ArgLd = angle for the maximal load transfer.
	R	$0.85 \times RFPE$	
6	X	$RLdFw_{set} \times \tan(\text{ArgLdSet})$	
	R	$RLdFw_{set}$	
7	X	0	
	R	$RLdFw_{set}$	
8	X	$-0.2143 \times RLdFw_{set}$	Exact: $0.8 \times RFPE \times \tan(\text{ArgDir})$
	R	$0.8 \times RLdFw_{set}$	

Table continues on next page

Test point	Reach	Value	Comments
9	X	$-0.8 \times \text{RLdFw}_{\text{set}} \times \tan(\text{ArgDir})$	
	R	$0.8 \times \text{RLdFw}_{\text{set}}$	
10	X	$0.17 \times (2 \times X1_{\text{set}} + X0_{\text{set}})$	Exact: $0.5 \times (2 \times X1_{\text{set}} + X0_{\text{set}})/3$
	R	$-0.36 \times (2 \times X1_{\text{set}} + X0_{\text{set}})$	Exact: $0.5 \times (2X1_{\text{set}} + X0_{\text{set}})/(3 \times \tan(\text{AgNegDir}90))$
11	X	$0.27 \times (2 \times X1_{\text{set}} + X0_{\text{set}})$	Exact: $0.8 \times (2 \times X1_{\text{set}} + X0_{\text{set}})/3$
	R	$-0.57 \times (2 \times X1_{\text{set}} + X0_{\text{set}})$	Exact: $0.8 \times (2X1_{\text{set}} + X0_{\text{set}})/(3 \times \tan(\text{AngNegDir } 90))$
12	X	$0.5 \times (2 \times X1_{\text{set}} + X0_{\text{set}})/3$	
	R	$0.5 \times (2 \times R1_{\text{set}} + R0_{\text{set}})/3$	
13	X	0	
	R	RFPE	

13.5.1.1

Measuring the operating limit of set values in cases without shaped load encroachment characteristics (OperationLdCmp=off)

Procedure for phase-to-phase fault L1–L2.

1. Subject the IED to healthy normal load conditions for at least two seconds.
2. Apply the fault condition and slowly decrease the measured impedance to find the operating value of the phase-to-phase fault for zone 1 according to test point 1 in figure 57 and table 21. Compare the result of the measurement with the set value.
3. Repeat steps 1 to 2 to find the operating value for test point 2, 3 in table 21 and the operating value for the phase-to-earth loop according to test point 1, 2, 3 in table 22.
Observe that the zones that are not tested have to be blocked and the zone that is tested has to be released.
4. Repeat steps 1 to 3 above to find the operating value for the phase-to-earth fault L3-E according to figure 58 and table 22



Test points 8 and 9 are intended to test the directional lines of impedance protection. Since directionality is a common function for all 5 measuring zones, it is only necessary to test points 6, 7, 8 and 9 once, in the forward direction (the largest reverse zone can be used to facilitate the test) in order to test the accuracy of directionality (directional angles). Directional functionality testing (trip inside, no-trip outside) should always be carried for all impedance zones set with directionality (forward or reverse).

13.5.1.2 Measuring the operate time of distance protection zones

Procedure

1. Subject the IED to healthy normal load conditions for at least two seconds.
2. Apply the fault condition to find the operating time for the phase-to-phase fault according to test point 10 in figure [57](#) and table [21](#) for zone 1. Compare the result of the measurement with the setting $tIPP$.
3. Repeat steps [1](#) to [2](#) to find the operating time for the phase-to-earth fault according to test point 10 in figure [58](#) and table [22](#). Compare the result of the measurement with the setting $tIPE$.
4. Repeat steps [1](#) to [2](#) to find the operating time for all other used measuring zones. Observe that the zones that are not tested have to be blocked and the zone that is tested has to be released.

When the load shaped characteristic is activated ($OperationLdCmp=On$) the test point for phase-to-phase faults is 12 in figure [57](#) and table [21](#) and for phase-earth faults according to P12 in figure [58](#) and table [22](#).

13.5.1.3 Completing the test

Continue to test another function or end the test by changing the test mode setting to off.

13.5.2 Phase selection with load encroachment, quadrilateral characteristic FDPSPDIS (21)

Prepare the IED for verification of settings as outlined in section ["Preparing for test"](#) in this chapter.

The phase selectors operate on the same measuring principles as the impedance measuring zones. So it is necessary to follow the same principles as for distance protection, when performing the secondary injection tests.

Measure operating characteristics during constant current conditions. Keep the measured current as close as possible to the rated value of its associated input transformer, or lower. But ensure that it is higher than 30% of the rated current.

Ensure that the maximum continuous current of an IED does not exceed four times its rated value, if the measurement of the operating characteristics runs under constant voltage conditions.

To verify the settings the operating points according to figures [59](#) and [60](#) should be tested. See also tables [23](#) and [24](#) for information.

Table 23: Test points for phase-ground loop CG (Ohm/loop)

Test point		Value	Comments
1	X	$[X1+XN]$	$XN=(X_0-X_1)/3$
	R	0	
2	X	0	
	R	RLdFwd	
3	X	$0.85 \cdot [X1+XN]$	$R \approx 0.491 \cdot (X1+XN) + RFltFwdPG$
	R		
4	X	$0.85 \cdot [X1+XN]$	
	R	$-0.85 \cdot [X1+XN] \cdot \tan(\text{AngNegRes}-90^\circ)$	
5	X	$RFltFwdPG \cdot \tan(\text{LdAngle})$	
	R	RFltFwdPG	
6	X	$-0,5 \cdot RLdFwd \cdot \tan(\text{ArgDir})$	
	R	$0,5 \cdot RLdFwd$	

The table showing test points for phase-to- ground loops is used together with figure [59](#).

Table 24: Test points for phase-to-phase loops A-B

Test point		Value	Comments
1	X	X1	
	R	0	
2	X	0	
	R	RLdFwd	
3	X	$0.85 \cdot X1$	$R = 0.491 \cdot X1 + 0.5 \cdot RFLdFwdPP$
	R	$0.85 \cdot X1 \cdot 1/\tan(60^\circ) + 0.5 \cdot RFLdFwdPP$	
4	X	$0.85 \cdot X1$	
	R	$-0.85 \cdot X1 \cdot \tan(\text{AngNegRes}-90^\circ)$	
5	X	$0.5 \cdot RFLdFwdPP \cdot \tan(\text{ArgLd})$	
	R	$0.5 \cdot RFLdFwdPP$	
6	X	$-0.5 \cdot RLdFwd \cdot \tan(\text{ArgDir})$	
	R	$0.5 \cdot RLdFwd$	

The table showing test points for phase-to-phase loops is used together with figure [60](#).

13.5.2.1 Measuring the operate limit of set values

1. Supply the IED with healthy conditions for at least two seconds.
2. Apply the fault condition and slowly decrease the measured impedance to find the operate value for of the phase-to-ground loop ECG, test point 1, according to figure 59. Compare the result of the measurement with the expected value according to table 23.

The corresponding binary signals that inform about the operation of the phase selection measuring elements are available in the local HMI under **Main menu/Test/Function status/Impedance Protection/PhaseSelection(PDIS, 21)/PHSx**.

3. Repeat steps 1 to 2 to find the operate values for the remaining test points according to figures 59 and table 23.



When the load encroachment characteristic is deliberately set very high in order not to have an influence, then the test points 2 and 5 can be replaced by test point 7.

4. Repeat steps 1 to 3 to find the operate value for the phase-to-phase fault in A - C according to figure 60 and table 24.



When the load encroachment characteristic is deliberately set very high in order not to have an influence, then the test points 2 and 5 can be replaced by test point 7.

13.5.2.2 Completing the test

Continue to test another function or end the test by changing the *Test mode* setting to *Off*. Restore connections and settings to their original values, if they were changed for testing purposes.

13.5.3 Full scheme distance protection, mho characteristic ZMHPDIS (21)

Prepare the IED for verification of settings as outlined in section "[Overview](#)" and section "[Preparing for test](#)" in this chapter. Consider releasing of the zone to be tested by setting the phase selector FDPSPDIS to *On*.

The programming of the autorecloser function SMBRREC (79) will determine if three-phase or single-phase trip will be initiated as result of the test.

Keep the current constant when measuring operating characteristics. Keep the current as close as possible to its rated value or lower. But make sure it is higher than 30% of the rated current.

Ensure that the maximum continuous current in an IED does not exceed four times its rated value, if the measurement of the operating characteristics runs under constant voltage conditions.

To verify the mho characteristic, at least two points should be tested.

In the following, three test points are proposed. The mho characteristic always goes through the origin, which automatically gives a fourth point for the characteristic.

13.5.3.1

Phase-to-phase faults

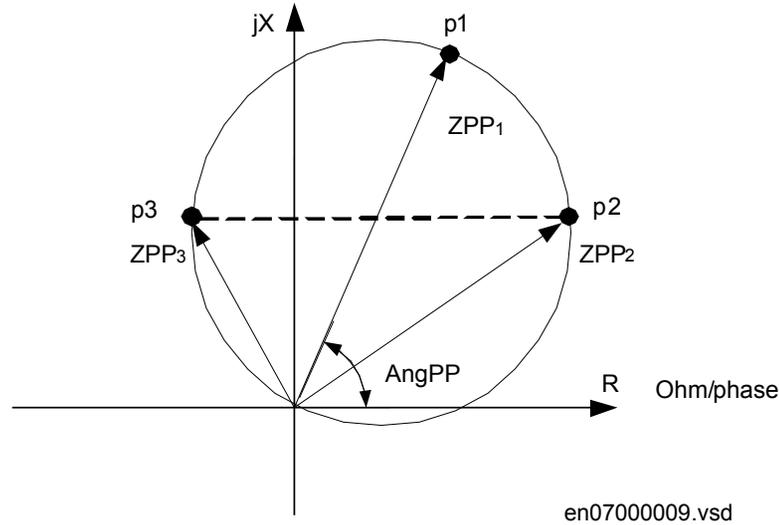


Figure 61: Proposed test points for phase-to-phase fault

Label	Description
ZPP1	The measured impedance for phase-to-phase fault at point 1 (zone reach ZPP) ohm/phase.
ZAngPP	The characteristic angel for phase-to-phase fault in degrees.
ZPP2 and ZPP3	The fault impedance for phase-to-phase fault at the boundary for the zone reach at point 2 and 3.

Table 25: *Test points for phase-to-phase*

Test points	R	X
1	$ZPP \cdot \cos(ZAngPP)$	$ZPP \cdot \sin(ZAngPP)$
2	$ZPP/2 + \Delta R = ZPP/2 \cdot (1 + \cos(ZAngPP))$	$ZPP/2 \cdot \sin(ZAngPP)$
3	$ZPP/2 - \Delta R = ZPP/2 \cdot (1 - \cos(ZAngPP))$	$ZPP/2 \cdot \sin(ZAngPP)$

Change the magnitude and angle of phase-to-phase voltage to achieve impedances at test points p1, p2 and p3. For each test point, observe that the output signals, START, STLx and STPP are activated where x refers to the actual phase to be tested. After the timer t_{PP} for the actual zone has elapsed, also the signals TRIP, TRPP and TRx shall be activated.

13.5.3.2

Phase-to-ground faults

For simplicity, the same test points as for phase-to-phase faults are proposed, but considering new impedance values.

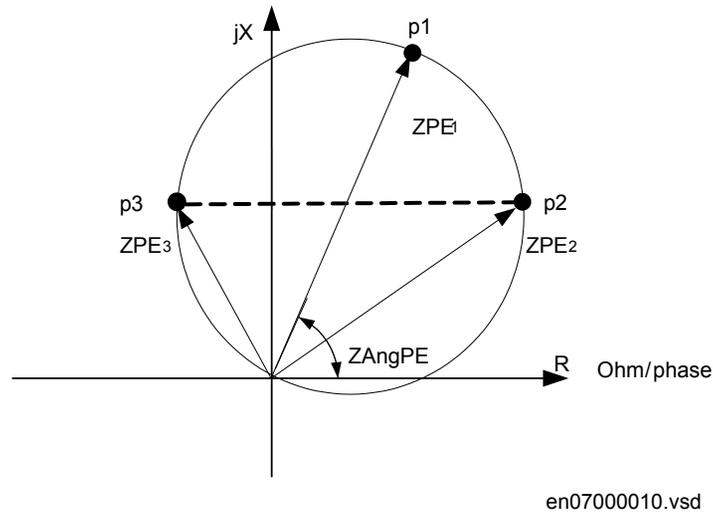


Figure 62:

Label	Description
ZPE1	The measured impedance for phase-to-ground fault at point 1 (zone reach ZPE) ohm/phase.
ZAngPE	The characteristic angel for phase-to-ground fault in degrees.
ZPE2 and ZPE3	The fault impedance for phase-to-ground fault at the boundary for the zone reach at point 2 and 3.

Table 26: Test points for phase-to-phase loops A-B (Ohm/Loop)

Test points	Set	Comments
1	$ZPE \cdot \cos(ZAngPE)$	$ZPE \cdot \sin(ZAngPE)$
2	$ZPE/2 + \Delta R = (ZPE/2) \cdot (1 - \cos(ZAngPE))$	$ZPE/2 \cdot \sin(ZAngPE)$
3	$ZPE/2 - \Delta R = ZPE/2 \cdot (1 - \cos(ZAngPE))$	$ZPE/2 \cdot \sin(ZAngPE)$

Check also in the same way as for phase-to-ground fault for each test point that the output signals STPE, START and STLx are activated where x refers to the actual phase to be tested. After the timer tPE for the zone has elapsed, also the signals TRIP, TRPE and TRx shall be activated.

13.5.4 Faulty phase identification with load encroachment FMPSPDIS (21)

There is no specific test routine for this function. The function is tested in conjunction with other impedance (mho) functions.

13.5.5 Power swing detection ZMRPSB (78)

The aim is to verify that the settings of the power swing detection function ZMRPSB(78) is according to the setting table and to verify that ZMRPSB (78) operates as expected.

Prepare the IED for verification of settings as outlined in section ["Overview"](#) and section ["Preparing for test"](#) in this chapter.

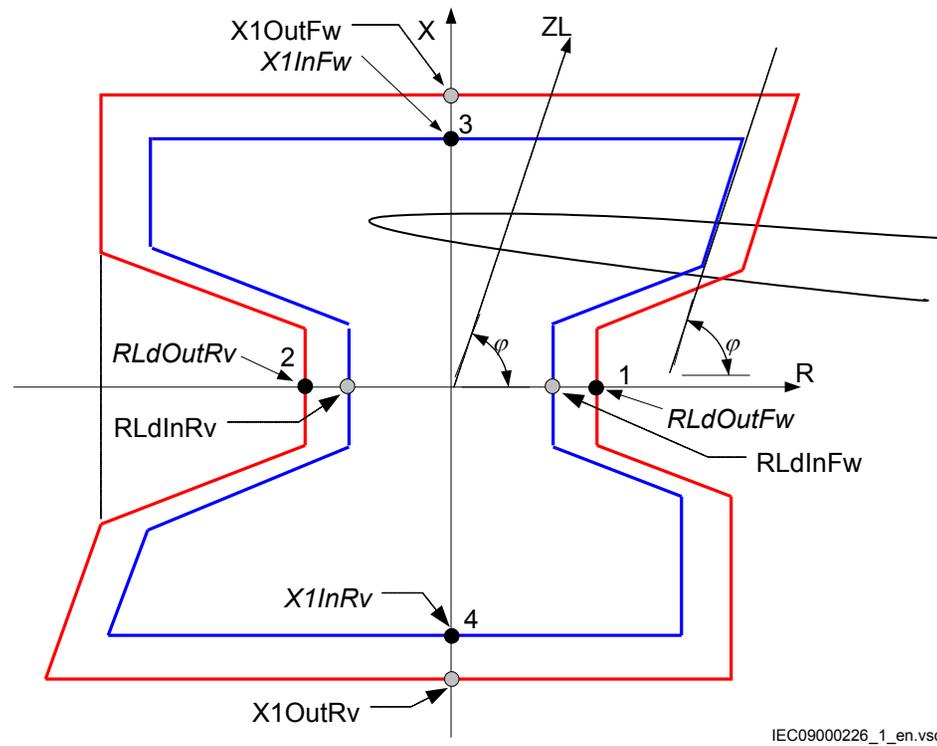
Before starting this process, all impedance measuring zones shall be set and in operation. Test the outer resistive boarder in forward and reverse direction, $RLdOutFw$ and $RLdOutRv$ and the inner reactive boarder in forward and reverse direction $XIInFw$ and $XIInRv$. See figure [63](#).

The corresponding resistive boarder for the inner resistive boundary and outer resistive boundary is calculated automatically from the setting of $kLdRFw$ and $kLdRRv$.

The inner zone of ZMRPSB (78) must cover all zones to be blocked by ZMRPSB (78) by at least 10% margin.

The test is mainly divided into two parts, one which aim is to verify that the settings are in accordance to the selective plane and a second part to verify the operation of ZMRPSB (78). The proposed test points for validation of the settings are numbered according to figure [63](#)

Test of the interactions or combinations that are not configured are not considered in this instruction.



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Figure 63: *Operating principle and characteristic of the power swing detection function (settings parameters in italic)*

Where:

$$RLdInFw = RLdOutFw \cdot kLdRFw$$

$$RLdInRv = RLdOutRv \cdot kLdRRv$$

$$X1OutFw = X1InFw + (RLdOutFw - RLdInFw)$$

$$X1OutRv = X1InRv + (RLdOutFw - RLdInFw)$$

13.5.5.1

Verifying the settings

Preconditions

The following output signal shall be configured to binary output available: ZOUT, measured impedance within outer impedance boundary.

1. Keep the measured current as close as possible to its rated value or lower. Keep it constant during the test, but ensure that it is higher than 30% of the rated current.
2. Ensure that the maximum continuous current of the IED does not exceed four times its rated value, if the measurement of the operating characteristics runs under constant voltage conditions.
3. Make the necessary connections and settings of the test equipment for test of point 1 according to figure [63](#).
4. Decrease the measured impedance slowly and observe the operation value for the signal ZOUT.
5. Check the operation value with the setting table.
6. Do the necessary change of the setting of the test equipment and repeat step [4](#) and step [5](#) for point 2, 3 and 4 according to figure [63](#).

13.5.5.2

Testing the power swing detection function ZMRPSB (78)

Preconditions

The following output signal shall be configured to a binary output: ZOUT, measured impedance within outer impedance boundary, ZIN, measured impedance within inner impedance boundary and PICKUP, power swing detection.

1. Slowly decrease the measured impedance in all three phases until the PICKUP signal gets activated.
2. Increase the measured voltages to their rated values.
3. Decrease instantaneously voltages in all three phases to the values, which are approximately 20% lower than the voltage that gives the set value $RILIn$ at the predefined test current.
4. The PICKUP signal must not appear.
5. Increase the measured voltages to their rated values.

13.5.5.3

Testing the $tR1$ timer

Preconditions

- The input I0CHECK, residual current ($3I_0$) detection used to inhibit start output is configured to the output signal STPE on the phase selection with load encroachment, quadrilateral characteristic function FDPSPDIS (21) or FRPSPDIS (21).
- The input BLK_SS, block inhibit of start output for subsequent residual current detection is connected to FALSE.

1. Program the test equipment for a single phase-to-ground fault and energize FDPSPDIS (21) or FRPSPDIS (21) and check that the input BLOCK on the power swing detection function ZMRPSB (78) is activated.
2. Make a test sequence so that a single phase-to-ground fault occurs after that the trajectory of the impedance has passed the outer and inner boundary of ZMRPSB (78) during power swing. Use the result from test of ZMRPSB (78) above to determine when the fault shall be applied. The ground-fault must be activated before tRI has elapsed.
3. Start the sequence and observe that the PICKUP signal will not be activated.

13.5.5.4 Testing the block input, interaction between FDPSPDIS (21) or FRPSPDIS (21) and ZMRPSB (78)

Precondition

The BLOCK input is configured and connected to STPE output on the FDPSPDIS (21) or FRPSPDIS (21) function.

1. Make a test sequence so that a single phase-to-ground-fault occurs after that the trajectory of the impedance has passed the outer boundary but not the inner boundary of the power swing detection function ZMRPSB (78). Use the result from test of ZMRPSB (78) above to instance when the fault shall be applied.
2. Start the test sequence by continuously reducing the voltage and observe that the output signal ZOUT may come, but not PICKUP.
If the input I0CHECK is configured (connected to output signal STPE on FDPSPDIS (21) or FRPSPDIS (21)), the test of inhibit of ZMRPSB (78) at ground-fault during power swing can be done in the same way as for test of tRI . The inhibit of ZMRPSB (78) shall be instantaneous if the input TRSP is activated at the same time as the input I0CHECK during power swing.

13.5.5.5 Completing the test

Continue to test another function or end the test by changing the *Test mode* setting to *Off*. Restore connections and settings to their original values, if they were changed for testing purposes.

13.5.6 Power swing logic ZMRPSL

Prepare the IED for verification of settings as outlined in section ["Overview"](#) and section ["Preparing for test"](#) in this chapter.

Most readily available test equipment does not permit simulation of power-swing conditions and the simultaneous occurrence of different faults with controlled fault

impedance. For this reason it is necessary to enable the logic by connecting the STPSD input signal to some other functional signal, which is used for testing purposes.

Make sure that the existing configuration permits monitoring of the CS, TRIP signals on the binary outputs of the IED. If not, configure connections to unused binary outputs, for test purposes.

13.5.6.1 Testing the carrier send and trip signals

Procedure

1. Set the operation of all distance zones, which are supposed to be blocked by the operation of ZMRPSB (78), to *Off*.
2. Configure the PUPSD functional inputs to the TRIP output of the underreaching power-swing zone, if the underreaching communication scheme is used.
3. Start instantaneously any kind of fault within the underreaching power-swing zone and check, that:
 - The CS signal appears after the time delay, which is equal to the sum of set time delays for the underreaching zone $tnPP$ or $tnPG$ (dependent on the type of fault) and for the carrier send security timer tCS . Also add the usual operate time for the underreaching zone (approximately 30ms).
 - The TRIP signal appears after the time delay, which is equal to the sum of set time delays for the underreaching zone $tnPP$ or $tnPG$ (dependent on the type of fault) and for the trip security timer $tTrip$. Also add the usual operate time for the underreaching zone (approximately 30ms).
4. Simulate the receiving of the carrier signal so that the functional input signal CR becomes a logical one.
5. Configure the PUPSD input to connect to the output START of the carrier accelerating zone (Power-swing overreaching zone).
6. Initiate any kind of fault within the carrier accelerating zone and check that the TRIP signal appears after the time, which is equal to the time delay set on the trip timer $tTrip$.
Also consider the (average) operate time of the carrier acceleration zone (approximately 30ms).

13.5.6.2 Testing the influence of the residual overcurrent protection

Additionally connect the IED according to the test instructions for the four step residual overcurrent protection function EF4PTOC (51N/67N), if the Power swing logic (ZMRPSL) is configured in a way that is controlled by this protection.

Procedure

1. Initiate a single phase-to-ground fault within both power-swing zones.
Make sure that none of CS and TRIP output signals appear after the time delays t_{CS} and t_{Trip} .
BLKZMUR must appear together with the fault and must remain active until the fault has been switched off plus the time delay, as set on the t_{BlkTr} timer.
2. Initiate a phase-to-phase fault within the operating area of both power-swing zones.
Make sure that CS and TRIP output signals appear after the time delays t_{CS} .
3. Switch the operation of the zone 1 distance protection function on and fulfill all the conditions for single-pole autoreclosing.
4. Simulate a single phase-to-ground fault within the reach of zone 1 and both power-swing zones.
The fault should cause a single-pole tripping and should be switched off with the normal operating time of zone 1.
5. Repeat the fault within the dead time of single-pole autoreclosing.
Make sure, that ZMRPSL generates a BLKZMUR signal and no CS and TRIP.

13.5.6.3

Controlling of the underreaching zone

Procedure

1. Set the operation of all normal distance protection zones to *On*.
2. Simulate a fault without fault resistance in the middle of distance protection zone 1.
Make sure that the trip appears within the operate time for the distance protection zone 1 and no BLKZMOR output signal appears.
3. Switch off the fault and prepare a new fault without fault resistance within the normal distance protection zone 2 operate area, but outside the zone 1 operate area.
4. Switch on the fault and move it into the zone 1 operate area with a time delay longer than the time set on the t_{DZ} timer and faster than the time set on timer t_{ZL} .
5. Observe the operate time, which must be equal to the operate time of zone 1, after the measured impedance enters its operate area.
No delayed operation of zone 1 must be observed.
6. Configure the PUPSD functional input to connect to the START functional output and repeat the previous fault.
Fast trip, caused by the operation of zone 1 must appear with a time delay, which is equal to the set time delay on the timer t_{ZL} plus zone 1 normal operate time.
Also, observe the BLKZMOR functional output signal, which must appear for a short time.
7. Be sure to establish the original configuration of the IED and the original settings of all setting parameters.

13.5.6.4 Completing the test

Continue to test another function or end the test by changing the *Test mode* setting to *Off*. Restore connections and settings to their original values, if they were changed for testing purposes.

13.5.7 Pole slip protection PSPPPAM (78)

Prepare the IED for verification of settings as outlined in section ["Overview"](#) and section ["Preparing for test"](#) in this chapter.

13.5.7.1 Verifying the settings

It is assumed that setting of the pole slip protection function PSPPPAM (78) is done according to impedances as seen in figure [64](#) and figure [65](#).

The test is done by means of injection of three-phase current and three-phase voltage from a modern test device. This test device shall be able to give voltage and current with the possibility to change voltage and current amplitude and the angle between the injected voltage and current. The parameter setting shall be according to the real application chosen values.

Procedure

1. Feed the IED with current and voltage corresponding to a normal operation point Injected voltage U equal to base voltage (V_{Base}) and the injected current I equal to half the base current ($I_{Base}/2$). The angle between the voltage and current shall be 0° .
2. With maintained amplitude of the injected voltage the current amplitude and angle is changed to a value $ZC/2$.
This is done with a speed so that the final impedance is reached after 1 second. As the injected voltage is higher than $0.92 V_{Base}$ no START signal should be activated.
3. With reduced amplitude of the injected voltage to $0.8 V_{Base}$ the current amplitude and angle is changed to a value $ZC/2$.
This is done with a speed so that the final impedance is reached after 1 second. As the injected voltage is lower than $0.92 V_{Base}$ the START signal should be activated.
4. With reduced amplitude of the injected voltage to $0.8 V_{Base}$ the current amplitude and angle is changed via $ZC/2$ to a value corresponding to half I_{Base} and 180° between the injected current and voltage.
This is done with a speed so that the final impedance is reached after 1 second. As the injected voltage is lower than $0.92 V_{Base}$ the START signal should be activated. In addition to this the signal ZONE1 should be activated.
5. Set $NILimit$ to 1 and repeat step [4](#).

- Now the signals TRIP1 and TRIP should be activated.
6. With reduced amplitude of the injected voltage to $0.8 V_{Base}$ the current amplitude and angle is changed via $ZC + (ZA - ZC)/2$ to a value corresponding to half I_{Base} and 180° between the injected current and voltage. This is done with a speed so that the final impedance is reached after 1s. As the injected voltage is lower than $0.92 V_{Base}$ the START signal should be activated. In addition to this the signal ZONE2 should be activated.
 7. Set $N2Limit$ to 1 and repeat step 6.
Now the signals TRIP2 and TRIP should be activated.

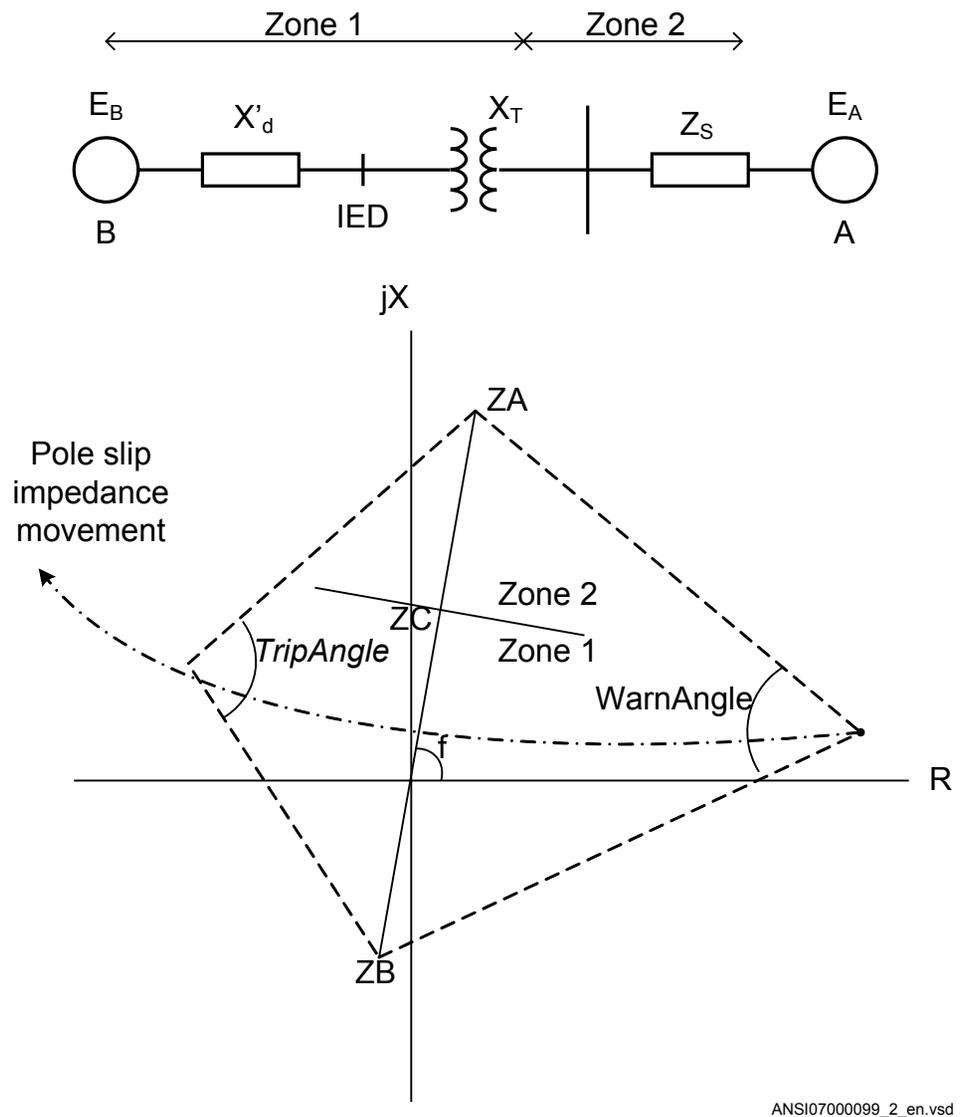


Figure 64: Setting of the pole slip protection PSPPPAM (78)

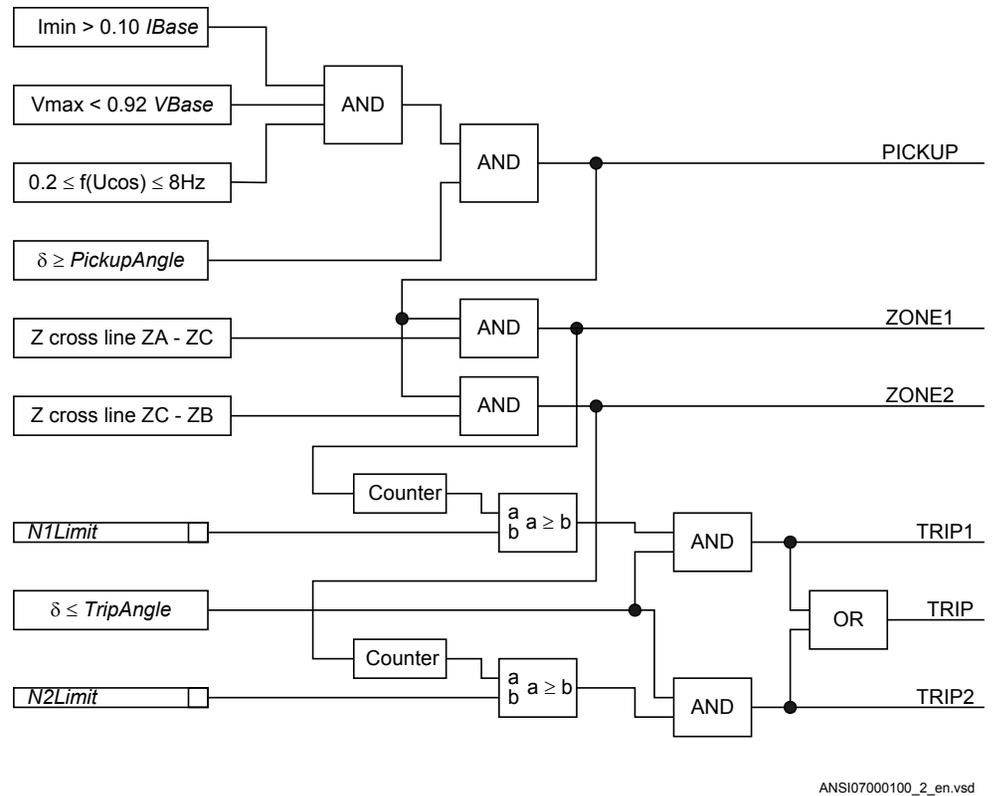


Figure 65: Logic diagram of the pole slip protection PSHPPAM (78)

13.5.7.2 Completing the test

Continue to test another function or end the test by changing the *Test mode* setting to *Off*. Restore connections and settings to their original values, if they were changed for testing purposes.

13.5.8 Automatic switch onto fault logic, voltage and current based ZCVPSOF

Prepare the IED for verification of settings as outlined in section ["Overview"](#) and section ["Preparing for test"](#) in this chapter.

Automatic switch onto fault logic, voltage and current based function ZCVPSOF is checked using secondary injection tests together with the scheme communication logic for distance or overcurrent protection function ZCPSCH (85) and with the dead line detection function (DLD), which is embedded in ZCVPSOF. ZCVPSOF is activated either by the external input BC, or by the internal DLD, which is integrated in the fuse

failure supervision function SDDRFUF. SDDRFUF is done with a pre-fault condition where the phase voltages and currents are at zero. A reverse three-phase fault with zero impedance and a three-phase fault with an impedance corresponding to the whole line is applied. This fault shall cause an instantaneous trip and result in a TRIP indication.

13.5.8.1 External activation of ZCVPSOF

1. Activate the switch onto fault BC input.
During normal operating conditions, the BC input is de-energized.
2. Apply a three-phase fault condition corresponding to a fault at approximately 45% of the line or with an impedance at 50% of used zone setting and current greater than 30% of I_n .
3. Check that the correct trip outputs, external signals and indication are obtained.

13.5.8.2 Automatic initiation of ZCVPSOF

1. Deactivate the switch onto fault BC input.
2. Set current and voltage inputs to 0 for at least 1 second.
3. Apply a three-phase fault condition corresponding to a fault at approximately 45% of the line or with an impedance at 50% of used zone setting and current greater than 30% of I_n .
4. Check that the correct trip outputs, external signals and indication are obtained.

13.5.8.3 Completing the test

Continue to test another function or end the test by changing the *Test mode* setting to *Off*. Restore connections and settings to their original values, if they were changed for testing purposes.

13.5.9 Phase preference logic PPLPHIZ

Prepare the IED for verification of settings as outlined in section ["Overview"](#) and section ["Preparing for test"](#) in this chapter.

The phase preference logic function PPLPHIZ is tested with a three-phase testing equipment for distance protections. PPLPHIZ is tested in co-operation with the distance protection zone, quadrilateral characteristic function ZMQPDIS (21). The distance protection and the phase preference logic shall be set to values according to the real set values to be used. The test is made by means of injection of voltage and current where the amplitude of both current and voltage and the phase angle between the voltage and current can be controlled.

During the test the following binary signals (outputs) shall be monitored:

- Trip signal from distance protection
 - Start signal from phase preference logic
1. Connect the test set for injection of voltage and current.
 2. Inject voltages and currents corresponding to a phase-to-phase to ground fault within zone 1 of the distance protection function. In the test one of the current inputs (one of the faulted phases) is disconnected. The remaining current is the fault current out on the protected line. All combinations of two phase-to-ground faults with one phase current are tested. The result shall be according to table 27. It should be checked that the fault will give phase-to-phase voltage, phase-to-ground voltage, zero-sequence voltage and phase current so that the conditions set for the logic are fulfilled.
 3. The same test is done for a phase-to-phase fault in zone 2.

Table 27: *Operation at different combinations of faults and operation mode*

OperMode	Fault type/Faulted phase current to the IED					
	L1L2N/IL1	L1L2N/IL2	L2L3N/IL2	L2L3N/IL3	L3L3N/IL1	L3L1N/IL3
No Filter	Trip	Trip	Trip	Trip	Trip	Trip
No Pref	Trip	Trip	Trip	Trip	Trip	Trip
1231c	Trip	No Trip	Trip	No Trip	No Trip	Trip
1321c	No Trip	Trip	No Trip	Trip	Trip	No Trip
123a	Trip	No Trip	Trip	No Trip	Trip	No Trip
132a	Trip	No Trip	No Trip	Trip	Trip	No Trip
213a	No Trip	Trip	Trip	No Trip	Trip	No Trip
231a	No Trip	Trip	Trip	No Trip	No Trip	Trip
312a	Trip	No Trip	No Trip	Trip	No Trip	Trip
321a	No Trip	Trip	No Trip	Trip	No Trip	Trip

13.5.9.1

Completing the test

Continue to test another function or end the test by changing the *Test mode* setting to *Off*. Restore connections and settings to their original values, if they were changed for testing purposes.

13.6 Current protection

13.6.1 Instantaneous phase overcurrent protection PHPIOC (50)

Prepare the IED for verification of settings as outlined in section ["Overview"](#) and section ["Preparing for test"](#) in this chapter.

To verify the settings the following fault type should be tested:

- Phase-to-ground fault

Ensure that the maximum continuous current, supplied from the current source used for the test of the IED, does not exceed four times the rated current value of the IED.

13.6.1.1 Measuring the operate limit of set values

1. Inject a phase current into the IED with an initial value below that of the setting.
2. Set the operation mode to *1 out of 3*.
3. Increase the injected current in the Ln phase until the TR_A (TR_B or TR_C) signal appears.
4. Switch the fault current off.



Observe: Do not exceed the maximum permitted overloading of the current circuits in the IED.

5. Compare the measured operating current with the set value.
6. Set the operation mode to *2 out of 3* and inject current into one of the phases.
Check - no operation.

13.6.1.2 Completing the test

Continue to test another function or end the test by changing the *Test mode* setting to *Off*. Restore connections and settings to their original values, if they were changed for testing purposes.

13.6.2 Four step phase overcurrent protection OC4PTOC (51/67)

Prepare the IED for verification of settings outlined in section ["Overview"](#) and section ["Preparing for test"](#) in this chapter.

13.6.2.1

Verifying the settings

1. Connect the test set for appropriate current injection to the appropriate IED phases. If there is any configuration logic that is used to enable or block any of the four available overcurrent steps, make sure that the step under test is enabled, for example end fault protection.
If *1 out of 3* currents for operation is chosen: Connect the injection current to phases A and neutral.
If *2 out of 3* currents for operation is chosen: Connect the injection current into phase A and out from phase B.
If *3 out of 3* currents for operation is chosen: Connect the symmetrical three-phase injection current into phases A, B and C.
2. Connect the test set for the appropriate three-phase voltage injection to the IED phases A, B and C. The protection shall be fed with a symmetrical three-phase voltage.
3. Set the injected polarizing voltage slightly larger than the set minimum polarizing voltage (default is 5% of V_{Base}) and set the injection current to lag the appropriate voltage by an angle of about 80° if forward directional function is selected.
If *1 out of 3* currents for operation is chosen: The voltage angle of phase A is the reference.
If *2 out of 3* currents for operation is chosen: The voltage angle of phase A – the voltage angle of B is the reference.
If *3 out of 3* currents for operation is chosen: The voltage angle of phase A is the reference.
If reverse directional function is selected, set the injection current to lag the polarizing voltage by an angle equal to 260° (equal to $80^\circ + 180^\circ$).
4. Increase the injected current and note the operated value of the tested step of the function.
5. Decrease the current slowly and note the reset value.
6. If the test has been performed by injection of current in phase A, repeat the test when injecting current into phases B and C with polarizing voltage connected to phases B respectively C (*1 out of 3* currents for operation).
7. If the test has been performed by injection of current in phases A — B, repeat the test when injecting current into phases B — C and C — A with appropriate phase angle of injected currents.
8. Block higher set stages when testing lower set stages according to below.
9. Connect a trip output contact to a timer.
10. Set the injected current to 200% of the operate level of the tested stage, switch on the current and check the time delay.
For inverse time curves, check the operate time at a current equal to 110% of the operate current for t_{xMin} .

11. Check that all trip and pickup contacts operate according to the configuration (signal matrixes)
12. Reverse the direction of the injected current and check that the protection does not operate.
13. If *2 out of 3* or *3 out of 3* currents for operation is chosen: Check that the function will not operate with current in one phase only.
14. Repeat the above described tests for the higher set stages.
15. Finally check that pickup and trip information is stored in the event menu.



Check of the non-directional phase overcurrent function. This is done in principle as instructed above, without applying any polarizing voltage.

13.6.2.2 Completing the test

Continue to test another function or end the test by changing the *Test mode* setting to *Off*. Restore connections and settings to their original values, if they were changed for testing purposes.

13.6.3 Instantaneous residual overcurrent protection EFPIOC (50N)

Prepare the IED for verification of settings as outlined in section ["Overview"](#) and section ["Preparing for test"](#) in this chapter.

To verify the settings the following fault type should be tested:

- Phase-to-ground fault

Ensure that the maximum continuous current, supplied from the current source used for the test of the IED, does not exceed four times the rated current value of the IED.

13.6.3.1 Measuring the operate limit of set values

1. Inject a phase current into the IED with an initial value below that of the setting.
2. Increase the injected current in the Ln or in the neutral (summed current input) phase until the TRIP signal appears.
3. Switch the fault current off.
Observe to not exceed the maximum permitted overloading of the current circuits in the IED
4. Compare the measured operating current with the set value.

13.6.3.2 Completing the test

Continue to test another function or end the test by changing the *Test mode* setting to *Off*. Restore connections and settings to their original values, if they were changed for testing purposes.

13.6.4 Four step residual overcurrent protection EF4PTOC (51N/67N)

Prepare the IED for verification of settings as outlined in section ["Overview"](#) and section ["Preparing for test"](#) in this chapter.

13.6.4.1 Four step directional overcurrent protection

1. Connect the test set for single current injection to the appropriate IED terminals. Connect the injection current to terminals A and neutral, or to terminals N and neutral.
2. Set the injected polarizing voltage slightly larger than the set minimum polarizing voltage (default 5% of V_n) and set the injection current to lag the voltage by an angle equal to the set reference characteristic angle (*AngleRCA*) if the forward directional function is selected.
If reverse directional function is selected, set the injection current to lag the polarizing voltage by an angle equal to $RCA + 180^\circ$.
3. Increase the injected current and note the value at which the studied step of the function operates.
4. Decrease the current slowly and note the reset value.
5. If the test has been performed by injection of current in phase A, repeat the test when injecting current into terminals B and C with a polarizing voltage connected to terminals B respectively C.
6. Block lower set steps when testing higher set steps according to the instructions that follow.
7. Connect a trip output contact to a timer.
8. Set the injected current to 200% of the operate level of the tested step, switch on the current and check the time delay.
For inverse time curves, check the operate time at a current equal to 110% of the operate current for *txMin*.
9. Check that all trip and start contacts operate according to the configuration (signal matrixes)
10. Reverse the direction of the injected current and check that the step does not operate.
11. Check that the protection does not operate when the polarizing voltage is zero.
12. Repeat the above described tests for the higher set steps.
13. Finally, check that pickup and trip information is stored in the event menu.

13.6.4.2 Four step non-directional overcurrent protection

1. Do as described in "[Four step directional overcurrent protection](#)", but without applying any polarizing voltage.

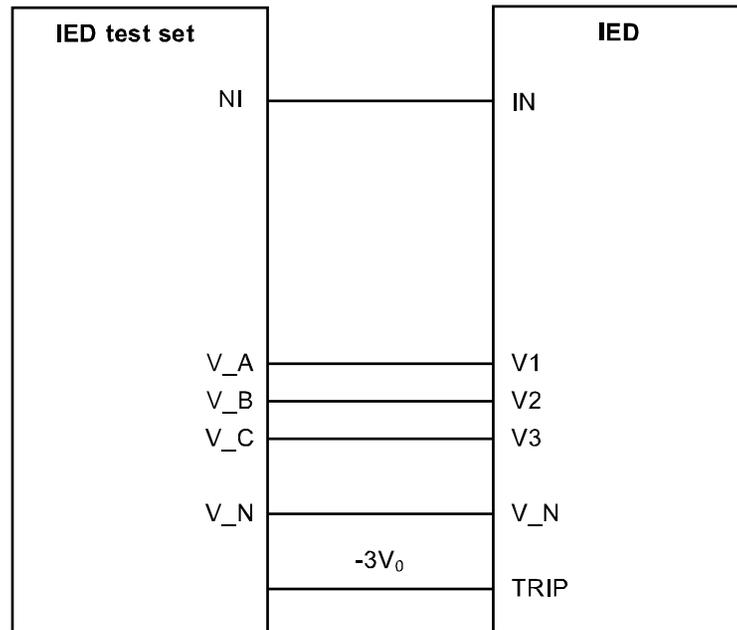
13.6.4.3 Completing the test

Continue to test another function or end the test by changing the *Test mode* setting to *Off*. Restore connections and settings to their original values, if they were changed for testing purposes.

13.6.5 Sensitive directional residual overcurrent and power protection SDEPSDE (67N)

Prepare the IED for verification of settings as outlined in section "[Overview](#)" and section "[Preparing for test](#)" in this chapter

Figure 66 shows the principal connection of the test set during the test of the sensitive directional residual overcurrent protection. Observe that the polarizing voltage is equal to $-3V_0$.



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Figure 66: Principle connection of the test set

Values of the logical signals belonging to the sensitive directional residual overcurrent protection are available on the local HMI under **Main menu/Test/Function status/Current protection/SensDirResOvCurr(PSDE,67N)/SDEx**

13.6.5.1

Measuring the operate and time limit for set values

Operation mode $3I_0 \cdot \cos\varphi$

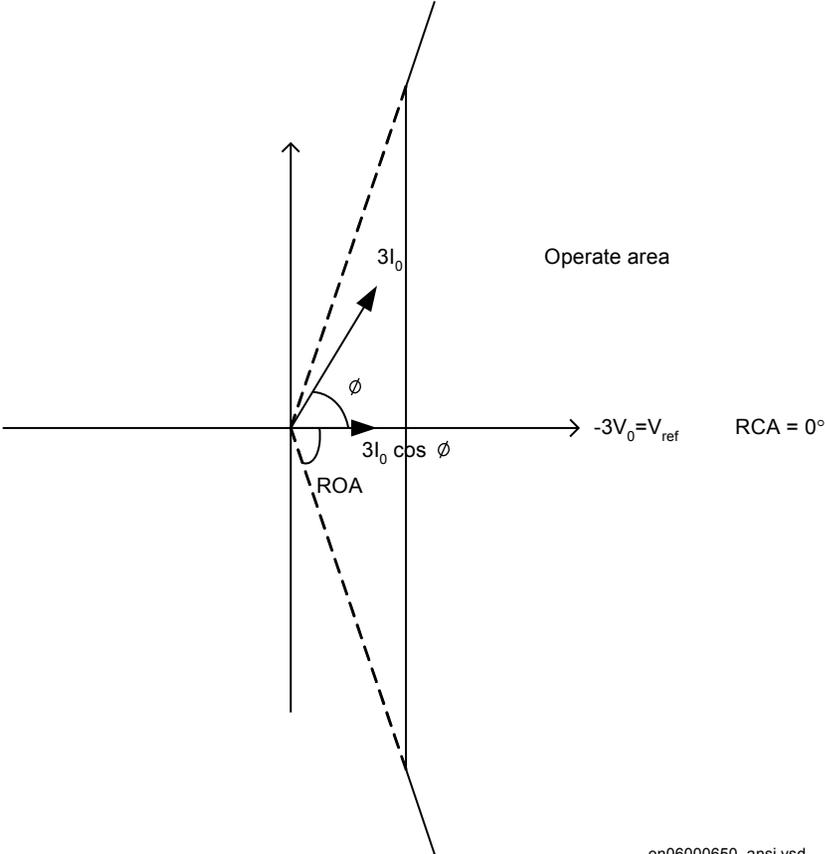
Procedure

1. Set the polarizing voltage to $1.2 \cdot VNRel>$ and the phase angle between voltage and current to the set characteristic angle ($RCADir$), the current lagging the voltage. Take setting $RCAComp$ into consideration if not equal to 0.
2. Measure that the operate current of the set directional element is equal to the $INcosPhi>$ setting.
The I Dir ($I_0 \cos(\text{Angle})$) function activates the BFI_3P and STDIRIN output.
3. Measure with angles $\varphi = RCADir \pm 45^\circ$ that the measuring element operates when $I_0 \cos(RCADir - \varphi) = I_0 \cos(\pm 45) = INcosPhi>$.
4. Compare the result with the set value.
Take the set characteristic into consideration, see figure 67 and figure 68.
5. Measure the operate time of the timer by injecting a current two times the set $INcosPhi>$ value and the polarizing voltage $1.2 \cdot VNRel>$.

$$T_{inv} = kSN \cdot Sref / 3I_{0test} \cdot \cos(\varphi)$$

(Equation 1)

6. Compare the result with the expected value.
The expected value depends on whether definite or inverse time was selected.
7. Set the polarizing voltage to zero and increase until the boolean output signal VNREL is activated, which is visible in the Application Configuration in PCM600 when the IED is in online mode. Compare the voltage with the set value $UVNRel>$.
8. Continue to test another function or complete the test by setting the test mode to *Off*.



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Figure 67: Characteristic with ROA_{Dir} restriction

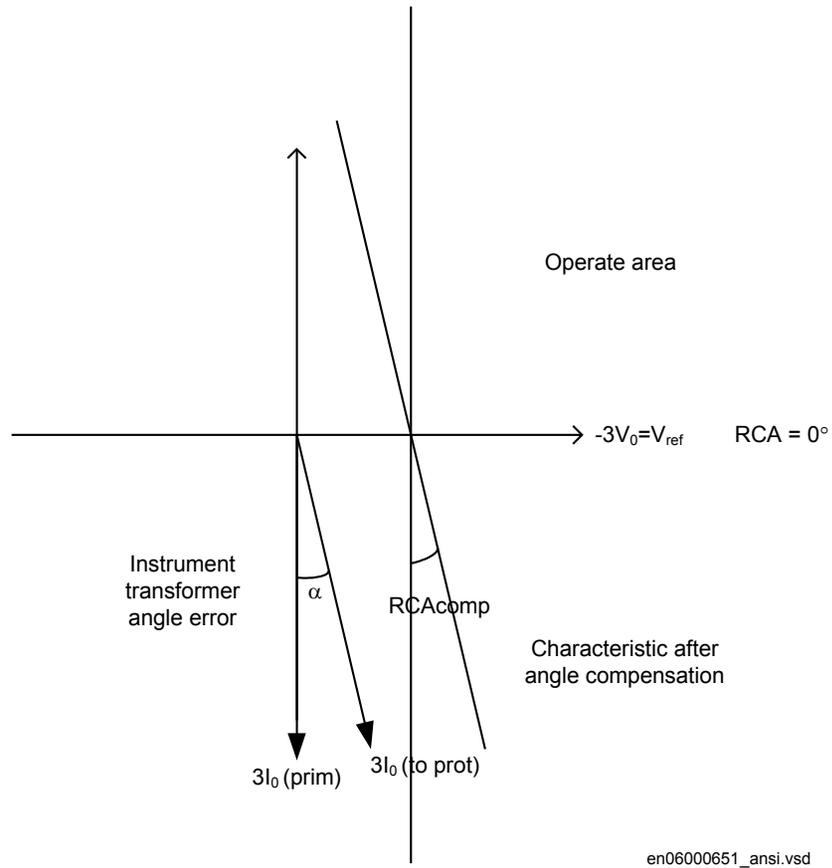


Figure 68: Explanation of RCAcomp

Operation mode $3I_0 \cdot 3U_0 \cdot \cos\varphi$

Procedure

1. Set the polarizing voltage to $1.2 \cdot VN_{Rel}$ and the phase angle between voltage and current to the set characteristic angle ($RCADir$), the current lagging the voltage.
2. Measure that the operate power is equal to the SN setting for the set directional element.
Note that for pick-up, both the injected current and voltage must be greater than the set values IN_{Rel} and VN_{Rel} respectively.
The function activates the BFI_3P and STDIRIN outputs.
3. Measure with angles $\varphi = RCADir \pm 45^\circ$ that the measuring element operates when $3I_0 \cdot 3V_0 \cdot \cos(RCADir - \varphi) = 3I_0 \cdot 3U_0 \cdot \cos(\pm 45) = SN$.
4. Compare the result with the set value. Take the set characteristic into consideration, see figure 67 and figure 68.

5. Measure the operate time of the timer by injecting $1.2 \cdot VNRel>$ and a current to get two times the set $SN>$ operate value.

$$T_{inv} = kSN \cdot Sref / 3I_{0test} \cdot 3V_{0test} \cdot \cos(\varphi)$$

(Equation 2)

6. Compare the result with the expected value.
The expected value depends on whether definite or inverse time was selected.
7. Continue to test another function or complete the test by setting the test mode to *Off*.

Operation mode $3I_0$ and fi

Procedure

1. Set the polarizing voltage to $1.2 \cdot VNRel>$ and the phase angle between voltage and current to the set characteristic angle ($RCADir$), the current lagging the voltage.
2. Measure that the operate power is equal to the $INDir>$ setting for the set directional element.



Note that for pickup, both the injected current and voltage must be greater than the set values $INRel>$ and $VNRel>$ respectively.

The function activates the BFI_3P and STDIRIN output.

3. Measure with angles φ around $RCADir$ +/- $ROADir$.
4. Compare the result with the set values, refer to figure 69 for example characteristic.
5. Measure the operate time of the timer by injecting a current to get two times the set $SN>$ operate value.

$$T_{inv} = kSN \cdot Sref / 3I_{0test} \cdot 3U_{0test} \cdot \cos(\varphi)$$

(Equation 3)

6. Compare the result with the expected value.
The expected value depends on whether definite or inverse time was selected.
7. Continue to test another function or complete the test by setting the test mode to *Off*.

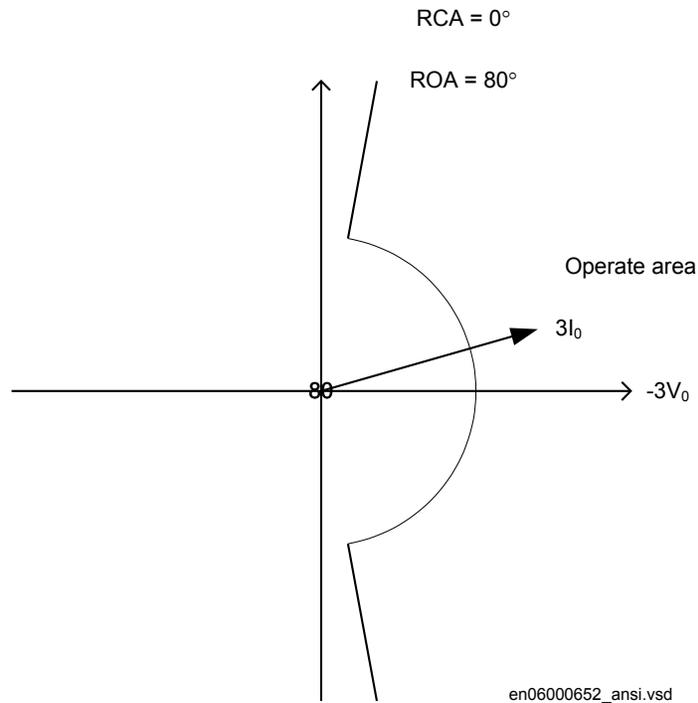


Figure 69: Example characteristic

Non-directional ground fault current protection

Procedure

1. Measure that the operate current is equal to the *INNonDir*> setting. The function activates the BFI_3P and STDIRIN output.
2. Measure the operate time of the timer by injecting a current to get two times the set *INNonDir*> operate value.
3. Compare the result with the expected value. The expected value depends on whether definite time *tINNonDir* or inverse time was selected.
4. Continue to test another function or complete the test by setting the test mode to *Off*.

Residual overvoltage release and protection

Procedure

1. Measure that the operate voltage is equal to the *UN*> setting. The function activates the BFI_3P and STUN signals.
2. Measure the operate time by injecting a voltage 1.2 times set *VN*> operate value.
3. Compare the result with the set *tVNNonDir* operate value.

4. Inject a voltage $0.8 \cdot V_{NRel}$ and a current high enough to operate the directional function at the chosen angle.
5. Increase the voltage until the directional function is released.
6. Compare the measured value with the set V_{NRel} operate value.

13.6.5.2 Completing the test

Continue to test another function or end the test by changing the *Test mode* setting to *Off*. Restore connections and settings to their original values, if they were changed for testing purposes.

13.6.6 Thermal overload protection, one time constant LPTTR (26)

Prepare the IED for verification of settings as outlined in section ["Overview"](#) and section ["Preparing for test"](#) in this chapter.

Check that the input logical signal BLOCK is logical zero and that on the local HMI, the logical signal TRIP, PICKUP and ALARM are equal to logical zero.

13.6.6.1 Measuring the operate and time limit of set values

Testing the protection without external temperature compensation (NonComp)

1. Quickly set the measured current (fault current) in one phase to about 300% of I_{Ref} (to minimise the trip time), and switch the current off.
2. Reset the thermal memory on the local HMI under **Main menu/Reset/Reset temperature/ThermalOverload1TimeConst(PTTR,26)/THLx**
3. Switch the fault current on and take note of the temperature, available on the local HMI under **Main menu/Test/Function status/Current protection/ThermOverLoad1TimeConst(PTTR,26)/THL/TEMP**
4. Check the time until the alarm limit has reached the *AlarmTemp* level during injection.
Monitor the signal ALARM until it appears on the corresponding binary output or on the local HMI.
5. Compare the measured temperature with the setting.
6. Measure the LPTTR (26) protection trip time.
Use the TRIP signal from the configured binary output to stop the timer.
7. Take the TEMP readings.
Compare with the setting of *TripTemp*.
8. Activate the BLOCK binary input.
The signals ALARM, PICKUP and TRIP should disappear.

9. Reset the BLOCK binary input.
10. Check the reset limit (TdReset).
Monitor the signal PICKUP until it disappears on the corresponding binary output or on the local HMI, take the TEMP readings and compare with the setting of *ReclTemp*.
11. Compare the measured trip time with the setting according to the formula.
12. Reset the thermal memory.
13. Continue to test another function or end the test by changing the test mode setting to *Disabled*.

13.6.6.2 Completing the test

Continue to test another function or end the test by changing the *Test mode* setting to *Off*. Restore connections and settings to their original values, if they were changed for testing purposes.

13.6.7 Breaker failure protection CCRBRF (50BF)

Prepare the IED for verification of settings as outlined in section ["Overview"](#) and section ["Preparing for test"](#) in this chapter.

The breaker failure protection function CCRBRF (50BF) should normally be tested in conjunction with some other function that provides an initiate signal. An external INITIATE signal can also be used.

To verify the settings in the most common back-up trip mode *1 out of 3*, it is sufficient to test phase-to-ground faults.

At mode *2 out of 4* the phase current setting, *Pickup_PH* can be checked by single-phase injection where the return current is connected to the summated current input. The value of residual (earth fault) current IN set lower than *Pickup_PH* is easiest checked in back-up trip mode *1 out of 4*.

13.6.7.1 Checking the phase current operate value, *Pickup_PH*

The check of the *Pickup_PH* current level is best made in *FunctionMode = Current* and *BuTripMode = 1 out of 3* or *2 out of 4*.

1. Apply the fault condition, including INITIATION of CCRBRF (50BF), with a current below set *Pickup_PH*.
2. Repeat the fault condition and increase the current in steps until a trip occurs.
3. Compare the result with the set *Pickup_PH*.
4. Disconnect AC and INITIATE input signals.



Note! If *NoIPickupcheck* or *Retrip off* is set, only back-up trip can be used to check set *Pickup_PH*.

13.6.7.2 Checking the residual (ground fault) current operate value *Pickup_N* set below *Pickup_PH*

Check the low set *Pickup_N* current where setting *FunctionMode = Current* and setting *BuTripMode = 1 out of 4*

1. Apply the fault condition, including INITIATION of CCRBRF (50BF), with a current just below set $IN > Pickup_N$.
2. Repeat the fault condition and increase the current in steps until trip appears.
3. Compare the result with the set *Pickup_N*.
4. Disconnect AC and INITIATION input signals.

13.6.7.3 Checking the re-trip and back-up times

The check of the set times can be made in connection with the check of operate values above.

Choose the applicable function and trip mode, such as *FunctionMode = Current* and *RetripMode = Current check*.

1. Apply the fault condition, including initiation of CCRBRF (50BF), well above the set current value. Measure time from INITIATION of CCRBRF (50BF).
2. Check the re-trip $t1$ and back-up trip times $t2$ and $t3$.
In applicable cases, the back-up trip for multi-phase start $t2MPH$ and back-up trip 2, $t2$ and $t3$ can also be checked. To check $t2MPH$, a two-phase or three-phase initiation shall be applied.
3. Disconnect AC and INITIATE input signals.

13.6.7.4 Verifying the re-trip mode

Choose the mode below, which corresponds to the actual case.

In the cases below it is assumed that *FunctionMode = Current* is selected.

Checking the case without re-trip, *RetripMode = Retrip Off*

1. Set *RetripMode* = *Retrip Off*.
2. Apply the fault condition, including initiation of CCRBRF (50BF), well above the set current value.
3. Verify that no re-trip, but back-up trip is achieved after set time.
4. Disconnect AC and INITIATE input signals.

Checking the re-trip with current check, *RetripMode* = *CB Pos Check*

1. Set *RetripMode* = *CB Pos Check*.
2. Apply the fault condition, including initiation of CCRBRF (50BF), well above the set current value.
3. Verify that re-trip is achieved after set time *t1* and back-up trip after time *t2*
4. Apply the fault condition, including initiation of CCRBRF (50BF), with current below set current value.
5. Verify that no re-trip, and no back-up trip is obtained.
6. Disconnect AC and INITIATE input signals.

Checking re-trip without current check, *RetripMode* = *No CBPos Check*

1. Set *RetripMode* = *No CBPos Check*.
2. Apply the fault condition, including initiation of CCRBRF (50BF), well above the set current value.
3. Verify that re-trip is achieved after set time *t1*, and back-up trip after time *t2*.
4. Apply the fault condition, including initiation of CCRBRF (50BF), with current below set current value.
5. Verify that re-trip is achieved after set time *t1*, but no back-up trip is obtained.
6. Disconnect AC and INITIATE input signals.

13.6.7.5

Verifying the back-up trip mode

In the cases below it is assumed that *FunctionMode* = *Current* is selected.

Checking that back-up tripping is not achieved at normal CB tripping

Use the actual tripping modes. The case below applies to re-trip with current check.

1. Apply the fault condition, including initiation of CCRBRF (50BF), with phase current well above set value *IP*.
2. Arrange switching the current off, with a margin before back-up trip time, *t2*. It may be made at issue of re-trip command.
3. Check that re-trip is achieved, if selected, but no back-up trip.
4. Disconnect AC and INITIATE input signals.

The normal mode *BuTripMode = 1 out of 3* should have been verified in the tests above. In applicable cases the modes *1 out of 4* and *2 out of 4* can be checked. Choose the mode below, which corresponds to the actual case.

Checking the case *BuTripMode = 1 out of 4*

It is assumed that the earth-fault current setting *Pickup_N* is below phase current setting *Pickup_PH*.

1. Set *BuTripMode = 1 out of 4*.
2. Apply the fault condition, including initiation of CCRBRF (50BF), with one-phase current below set *Pickup_PH* but above *Pickup_N*. The residual earth fault should then be above set *Pickup_N*.
3. Verify that back-up trip is achieved after set time. If selected, re-trip should also appear.
4. Disconnect AC and INITIATE input signals.

Checking the case *BuTripMode = 2 out of 4*

The earth-fault current setting *Pickup_N* may be equal to or below phase-current setting *Pickup_PH*.

1. Set *BuTripMode = 2 out of 4*.
2. Apply the fault condition, including initiation of CCRBRF (50BF), with one-phase current above set *Pickup_PH* and residual (ground fault) above set *Pickup_N*. It can be obtained by applying a single-phase current.
3. Verify that back-up trip is achieved after set time. If selected, re-trip should also appear.
4. Apply the fault condition, including initiation of CCRBRF (50BF), with at least one-phase current below set *Pickup_PH* and residual (ground fault) above set *Pickup_N*. The current may be arranged by feeding three- (or two-) phase currents with equal phase angle (I0-component) below *Pickup_PH*, but of such value that the residual (ground fault) current ($3I_0$) will be above set value *Pickup_N*.
5. Verify that back-up trip is not achieved.
6. Disconnect AC and INITIATE input signals.

13.6.7.6

Verifying instantaneous back-up trip at CB faulty condition

Applies in a case where a signal from CB supervision function regarding CB being faulty and unable to trip is connected to input 52FAIL.

1. Repeat the check of back-up trip time. Disconnect current and INITIATE input signals.
2. Activate the input 52FAIL. The output CBALARM (CB faulty alarm) should appear after set time $t_{CBAlarm}$. Keep the input activated.
3. Apply the fault condition, including initiation of CCRBRF (50BF), with current above set current value.
4. Verify that back-up trip is obtained without intentional delay, for example within 20ms from application of initiation.
5. Disconnect injected AC and INITIATE input signals.

13.6.7.7

Verifying the case *RetripMode = Contact*

It is assumed that re-trip without current check is selected, *RetripMode = Contact*.

1. Set *FunctionMode = Contact*
2. Apply input signal for CB closed to relevant input or inputs 52a_A (B or C)
3. Apply input signal, or signals for initiation of CCRBRF (50BF). The value of current could be low.
4. Verify that re-trip and back-up trip are achieved after set times.
5. Disconnect the start signal(s). Keep the CB closed signal(s).
6. Apply input signal(s), for initiation of CCRBRF (50BF). The value of current could be low.
7. Arrange disconnection of CB closed signal(s) well before set back-up trip time t_2 .
8. Verify that back-up trip is not achieved.
9. Disconnect injected AC and INITIATE input signals.

13.6.7.8

Verifying the function mode *Current&Contact*

To be made only when *FunctionMode = Current&Contact* is selected. It is suggested to make the tests in one phase only, or at three-pole trip applications for just three-pole tripping.

Checking the case with fault current above set value *Pickup_PH*

The operation shall be as in *FunctionMode = Current*.

1. Set *FunctionMode = Current&Contact*.
2. Leave the inputs for CB close inactivated. These signals should not influence.
3. Apply the fault condition, including initiation of CCRBRF (50BF), with current above the set *Pickup_PH* value.
4. Check that the re-trip, if selected, and back-up trip commands are achieved.
5. Disconnect injected AC and INITIATE input signals.

Checking the case with fault current below set value *Pickup_BlkCont*

The case shall simulate a case where the fault current is very low and operation will depend on CB position signal from CB auxiliary contact. It is suggested that re-trip without current check is used, setting *RetripMode = No CBPos Check*.

1. Set *FunctionMode = Current&Contact*.
2. Apply input signal for CB closed to relevant input or inputs 52a_A (B or C)
3. Apply the fault condition with input signal(s) for initiation of CCRBRF (50BF). The value of current should be below the set value *Pickup_BlkCont*
4. Verify that re-trip (if selected) and back-up trip are achieved after set times. Failure to trip is simulated by keeping the signal(s) CB closed activated.
5. Disconnect the AC and the INITIATE signal(s). Keep the CB closed signal(s).
6. Apply the fault and the initiation again. The value of current should be below the set value *Pickup_BlkCont*.
7. Arrange disconnection of BC closed signal(s) well before set back-up trip time *t2*. It simulates a correct CB tripping.
8. Verify that back-up trip is not achieved. Re-trip can appear for example, due to selection "Re-trip without current check".
9. Disconnect injected AC and INITIATE input signals.

13.6.7.9

Completing the test

Continue to test another function or end the test by changing the *Test mode* setting to *Off*. Restore connections and settings to their original values, if they were changed for testing purposes.

13.6.8

Stub protection STBPTOC (50STB)

Prepare the IED for verification of settings as outlined in section ["Overview"](#) and section ["Preparing for test"](#) in this chapter.

Logical signals for STBPTOC (50STB) protection are available on the local HMI under **Main menu/Settings/Setting group N/Current protection/Stub(PTOC, 50STB)/STBx**

13.6.8.1

Measuring the operate limit of set values

Procedure

1. Check that the input logical signals BLOCK and ENABLE and the output logical signal TRIP are all logical zero.
2. Activate the input ENABLE on the STBPTOC (50STB) function block
3. For a short while inject a current (fault current) in one phase to about 110% of the set operating current, and switch the current off.
Observe to not exceed the maximum permitted overloading of the current circuits in the IED.
4. Switch the fault current on and measure the operating time of STBPTOC (50STB).
Use the TRIP signal from the configured binary output to stop the timer. The operation should be instantaneously.
5. Activate the input BLOCK on the STBPTOC (50STB) function block.
6. Switch on the fault current (110% of the setting).
No TRIP signal should appear.
7. Switch off the fault current.
8. For a short while inject a current (fault current) in same phase to about 90% of the set operating current, and switch the current off.
9. Switch the fault current on.
No TRIP signal should appear.
10. Switch the fault current off.
11. Reset the ENABLE binary input.
12. Switch the fault current on.
No TRIP signal should appear.
13. Switch the fault current off.

13.6.8.2 Completing the test

Continue to test another function or end the test by changing the *Test mode* setting to *Off*. Restore connections and settings to their original values, if they were changed for testing purposes.

13.6.9 Pole discrepancy CCRPLD (52PD)

Prepare the IED for verification of settings as outlined in section ["Preparing for test"](#) and section ["Preparing for test"](#) in this chapter.

13.6.9.1 Verifying the settings

1. External detection logic, Contact function *selection* = *ContactSel* setting equals CCRPLD (52PD) signal from CB. Activate the EXTPDIND binary input, and measure the operating time of CCRPLD (52PD).

- Use the TRIP signal from the configured binary output to stop the timer.
2. Compare the measured time with the set value t_{Trip} .
3. Reset the EXTPDIND input.
4. Activate the BLKDBYAR binary input.
This test should be performed together with Autorecloser SMBRREC (79).
5. Activate the EXTPDIND binary input.
No TRIP signal should appear.
6. Reset both BLKDBYAR and EXTPDIND binary inputs.
7. Activate the BLOCK binary input.
8. Activate EXTPDIND binary input.
NO TRIP signal should appear.
9. Reset both BLOCK and EXTPDIND binary inputs.
10. If Internal detection logic Contact function *selection* = *ContactSel* setting equals Pole position from auxiliary contacts. Then set inputs 52b_A...52a_C in a status that activates the pole discordance logic and repeats step 2 to step 6.
11. Unsymmetrical current detection with CB monitoring: Set measured current in one phase to 110% of current release level. Activate CLOSECMD and measure the operating time of the CCRPLD (52PD) protection.
Use the TRIP signal from the configured binary out put stop the timer.
12. 12. Deactivate the CLOSECMD: Set measured current in one phase to 90% of Current Release level. Activate CLOSECMD.
NO TRIP signal should appear.
13. 13. Repeat step 14 and 15 using OPENCMD instead of CLOSECMD.
Asymmetry current detection with CB monitoring: Set all three currents to 110% of Current Release level. Activate CLOSECMD.
NO TRIP signal should appear due to symmetrical condition.
14. 14. Deactivate the CLOSECMD. Decrease one current with 120% of the current unsymmetrical level compared to the other two phases. Activate CLOSECMD and measure the operating time of the CCRPLD (52PD) protection.
Use the TRIP signal from the configured binary out put stop the timer.
15. 15. Deactivate the CLOSECMD. Decrease one current with 80% of the current unsymmetrical level compared to the other two phases. Activate CLOSECMD.
NO TRIP signal should appear.

13.6.9.2 Completing the test

Continue to test another function or end the test by changing the *Test mode* setting to *Off*. Restore connections and settings to their original values, if they were changed for testing purposes.

13.6.10 Directional underpower protection GUPPDUP (37)

Prepare the IED for verification of settings as outlined in section ["Overview"](#) and section ["Preparing for test"](#) in this chapter.

13.6.10.1

Verifying the settings

The underpower protection shall be set to values according to the real set values to be used.

The test is made by means of injection of voltage and current where the amplitude of both current and voltage and the phase angle between the voltage and current can be controlled. During the test the analog outputs of active and reactive power shall be monitored.

Procedure

1. Connect the test set for injection of voltage and current corresponding to the mode to be used in the application. If a three-phase test set is available this could be used for all the modes. If a single-phase current/voltage test set is available the test set should be connected to a selected input for one-phase current and voltage.

Set value: <i>Mode</i>	Formula used for complex power calculation
A, B, C	$\bar{S} = \bar{V}_A \cdot \bar{I}_A^* + \bar{V}_B \cdot \bar{I}_B^* + \bar{V}_C \cdot \bar{I}_C^*$ <p style="text-align: right;">(Equation 4)</p>
Arone	$\bar{S} = \bar{V}_{AB} \cdot \bar{I}_A^* - \bar{V}_{BC} \cdot \bar{I}_C^*$ <p style="text-align: right;">(Equation 5)</p>
PosSeq	$\bar{S} = 3 \cdot \bar{V}_{PosSeq} \cdot \bar{I}_{PosSeq}^*$ <p style="text-align: right;">(Equation 6)</p>
AB	$\bar{S} = \bar{V}_{AB} \cdot (\bar{I}_A^* - \bar{I}_B^*)$ <p style="text-align: right;">(Equation 7)</p>
BC	$\bar{S} = \bar{V}_{BC} \cdot (\bar{I}_B^* - \bar{I}_C^*)$ <p style="text-align: right;">(Equation 8)</p>
CA	$\bar{S} = \bar{V}_{CA} \cdot (\bar{I}_C^* - \bar{I}_A^*)$ <p style="text-align: right;">(Equation 9)</p>
Table continues on next page	

Set value: <i>Mode</i>	Formula used for complex power calculation
A	$\bar{S} = 3 \cdot \bar{V}_A \cdot \bar{I}_A^*$ <p style="text-align: right;">(Equation 10)</p>
B	$\bar{S} = 3 \cdot \bar{V}_B \cdot \bar{I}_B^*$ <p style="text-align: right;">(Equation 11)</p>
C	$\bar{S} = 3 \cdot \bar{V}_C \cdot \bar{I}_C^*$ <p style="text-align: right;">(Equation 12)</p>

2. Adjust the injected current and voltage to the set values in % of *I_{Base}* and *V_{Base}* (converted to secondary current and voltage). The angle between the injected current and voltage shall be set equal to the set direction *Angle1*, angle for stage 1 (equal to 0° for low forward power protection and equal to 180° for reverse power protection). Check that the monitored active power is equal to 100% of rated power and that the reactive power is equal to 0% of rated power.
3. Change the angle between the injected current and voltage to *Angle1* + 90°. Check that the monitored active power is equal to 0% of rated power and that the reactive power is equal to 100% of rated power.
4. Change the angle between the injected current and voltage back to 0°. Decrease the current slowly until the PICKUP1 signal, start of stage 1, is activated.
5. Increase the current to 100% of *I_{Base}*.
6. Switch the current off and measure the time for activation of TRIP1, trip of stage 1.
7. If a second stage is used, repeat steps [2](#) to [6](#) for the second stage.

13.6.10.2

Completing the test

Continue to test another function or end the test by changing the *Test mode* setting to *Off*. Restore connections and settings to their original values, if they were changed for testing purposes.

13.6.11

Directional overpower protection GOPPDOP (32)

Prepare the IED for verification of settings as outlined in section ["Overview"](#) and section ["Preparing for test"](#) in this chapter.

13.6.11.1 Verifying the settings

The overpower protection shall be set to values according to the real set values to be used. The test is made by means of injection of voltage and current where the amplitude of both current and voltage and the phase angle between the voltage and current can be controlled. During the test the analog outputs of active and reactive power shall be monitored.

1. Connect the test set for injection of voltage and current corresponding to the mode to be used in the application. If a three phase test set is available this could be used for all the modes. If a single phase current/voltage test set is available the test set should be connected to a selected input for one phase current and voltage.
2. Adjust the injected current and voltage to the set rated values in % of I_{Base} and V_{Base} (converted to secondary current and voltage). The angle between the injected current and voltage shall be set equal to the set direction $Angle1$, angle for stage 1 (equal to 0° for low forward power protection and equal to 180° for reverse power protection). Check that the monitored active power is equal to 100% of rated power and that the reactive power is equal to 0% of rated power.
3. Change the angle between the injected current and voltage to $Angle1 + 90^\circ$. Check that the monitored active power is equal to 0% of rated power and that the reactive power is equal to 100% of rated power.
4. Change the angle between the injected current and voltage back to $Angle1$ value. Increase the current slowly from 0 until the PICKUP1 signal, start of stage 1, is activated. Check the injected power and compare it to the set value $Power1$, power setting for stage 1 in % of S_{base} .
5. Increase the current to 100% of I_{Base} and switch the current off.
6. Switch the current on and measure the time for activation of TRIP1, trip of stage 1.
7. If a second stage is used, repeat steps [2](#) to [6](#) for the second stage.

13.6.11.2 Completing the test

Continue to test another function or end the test by changing the *Test mode* setting to *Off*. Restore connections and settings to their original values, if they were changed for testing purposes.

13.6.12 Broken conductor check BRCPTOC (46)

Prepare the IED for verification of settings as outlined in section ["Overview"](#) and section ["Preparing for test"](#) in this chapter.

13.6.12.1 Measuring the operate and time limit of set values

Procedure

1. Check that the input logical signal BLOCK to the BRCPTOC (46) function block is logical zero and note on the local HMI that the output signal TRIP from the BRCPTOC (46) function block is equal to the logical 0.
2. Set the measured current (fault current) in one phase to about 110% of the set operating current $IP>$.
Observe to not exceed the maximum permitted overloading of the current circuits in the terminal.
3. Switch on the fault current and measure the operating time of BRCPTOC (46).
Use the TRIP signal from the configured binary output to stop the timer.
4. Compare the measured time with the set value $tOper$.
5. Activate the BLOCK binary input.
6. Switch on the fault current (110% of the setting) and wait longer than the set value $tOper$.
No TRIP signal should appear.
7. Switch off the fault current.
8. Set the measured current (fault current) in same phase to about 90% of the set operating current $IP>$. Switch off the current.
9. Switch on the fault current and wait longer than the set value $tOper$.
No TRIP signal should appear.
10. Switch off the fault current.

13.6.12.2 Completing the test

Continue to test another function or end the test by changing the *Test mode* setting to *Off*. Restore connections and settings to their original values, if they were changed for testing purposes.

13.7 Voltage protection

13.7.1 Two step undervoltage protection UV2PTUV (27)

Prepare the IED for verification of settings as outlined in section ["Overview"](#) and section ["Preparing for test"](#) in this chapter.

13.7.1.1 Verifying the settings

Verification of PICKUP value and time delay to operate for Step1

1. Check that the IED settings are appropriate, especially the PICKUP value, the definite time delay and the *1 out of 3* operation mode.
2. Supply the IED with three-phase voltages at their rated values.
3. Slowly decrease the voltage in one of the phases, until the PICKUP signal appears.
4. Note the operate value and compare it with the set value.
5. Increase the measured voltage to rated load conditions.
6. Check that the PICKUP signal resets.
7. Instantaneously decrease the voltage in one phase to a value about 20% lower than the measured operate value.
8. Measure the time delay for the TRIP signal, and compare it with the set value.

Extended testing

1. The test above can now be repeated for step [2](#).
2. The tests above can be repeated for *2 out of 3* and for *3 out of 3* operation mode.
3. The tests above can be repeated to check security, that is, the PICKUP and operate signals, that are not supposed to appear, - do not.
4. The tests above can be repeated to check the time to reset.
5. The tests above can be repeated to test the inverse time characteristic.

13.7.1.2

Completing the test

Continue to test another function or end the test by changing the *Test mode* setting to *Off*. Restore connections and settings to their original values, if they were changed for testing purposes.

13.7.2

Two step overvoltage protection OV2PTOV (59)

Prepare the IED for verification of settings as outlined in section ["Overview"](#) and section ["Preparing for test"](#) in this chapter.

13.7.2.1

Verifying the settings

Procedure

1. Apply single-phase voltage below the set value *Pickup1*.
2. Slowly increase the voltage until the PU_ST1 signal appears.
3. Note the operate value and compare it with the set value.
4. Switch the applied voltage off.

5. Set and apply about 20% higher voltage than the measured operate value for one phase.
6. Measure the time delay for the TRST1 signal and compare it with the set value.
7. Repeat the test for step [2](#).

13.7.2.2 Completing the test

Continue to test another function or end the test by changing the *Test mode* setting to *Off*. Restore connections and settings to their original values, if they were changed for testing purposes.

13.7.3 Two step residual overvoltage protection ROV2PTOV (59N)

Prepare the IED for verification of settings as outlined in section ["Overview"](#) and section ["Preparing for test"](#) in this chapter.

13.7.3.1 Verifying the settings

1. Apply the single-phase voltage either to a single phase voltage input or to a residual voltage input with the pickup value below the set value *Pickup1*.
2. Slowly increase the value until PU_ST1 appears.
3. Note the operate value and compare it with the set value.
4. Switch the applied voltage off.
5. Set and apply about 20% higher voltage than the measured operate value for one phase.
6. Measure the time delay for the TRST1 signal and compare it with the set value.
7. Repeat the test for step [2](#).

13.7.3.2 Completing the test

Continue to test another function or end the test by changing the *Test mode* setting to *Off*. Restore connections and settings to their original values, if they were changed for testing purposes.

13.7.4 Overexcitation protection OEXPVPH (24)

Prepare the IED for verification of settings as outlined in section ["Overview"](#) and section ["Preparing for test"](#) in this chapter.

13.7.4.1 Verifying the settings

1. Enable frequency measuring (FRME) function.
2. Connect a symmetrical three-phase voltage input from the test set to the appropriate connection terminals of the overexcitation protection OEXPVPH (24) is configured for a three-phase voltage input.
A single-phase injection voltage is applied if the function is configured for a phase-to-phase voltage input.
The OEXPVPH (24) is conveniently tested using rated frequency for the injection voltage and increasing the injection voltage to get the desired overexcitation level.
3. Connect the alarm contact to the timer and set the time delay t_{Alarm} temporarily to zero.
4. Increase the voltage and note the operate value $Pickup1$.
5. Reduce the voltage slowly and note the reset value.
6. Set the alarm time delay to the correct value according to the setting plan and check the time delay, injecting a voltage corresponding to $1.2 \cdot Pickup1$.
7. Connect a trip output contact to the timer and temporarily set the time delay $t_{MinTripDelay}$ to 0.5s.
8. Increase the voltage and note the $Pickup2$ operate value
9. Reduce the voltage slowly and note the reset value.
10. Set the time delay to the correct value according to the setting plan and check the time delay $t_{MinTripDelay}$, injecting a voltage corresponding to $1.2 \cdot Pickup2$.
11. Check that trip and alarm contacts operate according to the configuration logic.
12. Set the cooling time constant temporarily to min value (1min.) to quickly lower the thermal content.
13. Wait for a period equal to 6 times $t_{CoolingK}$ switch 20 minutes on a voltage $1.15 \cdot Pickup1$ and check the inverse operate time.
Wait until the thermal memory is emptied, set the cooling time constant according to the setting plan and check another point on the inverse time curve injecting a voltage $1.3 \cdot Pickup1$.
14. Finally check that PICKUP and TRIP information is stored in the event menu.

13.7.4.2

Completing the test

Continue to test another function or end the test by changing the *Test mode* setting to *Off*. Restore connections and settings to their original values, if they were changed for testing purposes.

13.7.5

Voltage differential protection VDCPTOV (60)

Prepare the IED for verification of settings as outlined in section ["Overview"](#) and section ["Preparing for test"](#) in this chapter.

13.7.5.1 Check of undervoltage levels

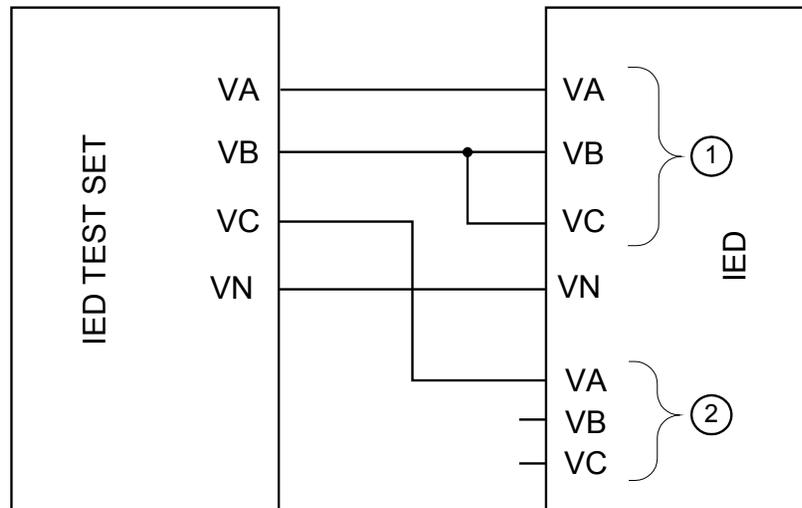
This test is relevant if the setting *BlkDiffAtVLow* = *Yes*.

Check of *V1Low*

Procedure

1. Connect voltages to the IED according to valid connection diagram and figure 70.
2. Apply voltage higher than the highest set value of *VDTrip*, *V1Low* and *V2Low* to the V1 three-phase inputs and to one phase of the V2 inputs according to figure 70.

The voltage differential PICKUP signal is set.



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Figure 70: Connection of the test set to the IED for test of V1 block level

where:

- 1 is three-phase voltage group1 (V1)
- 2 is three-phase voltage group2 (V2)

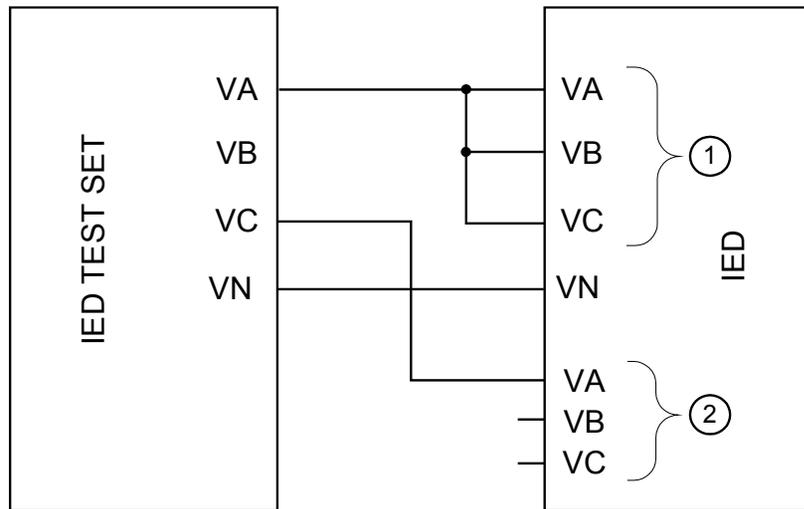
3. Decrease slowly the voltage in phase VL1 of the test set until the PICKUP signal resets.
4. Check V1 blocking level by comparing the voltage level at reset with the set undervoltage blocking *V1Low*.
5. Repeat steps 2 to 4 to check *V1Low* for the other phases.



The connections to V1 must be shifted to test another phase. (VL1 to VL2, VL2 to VL3, VL3 to VL1)

Check of $V2Low$ Procedure

1. Connect voltages to the IED according to valid connection diagram and figure 71.



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Figure 71: Connection of the test set to the IED for test of $V2$ block level

where:

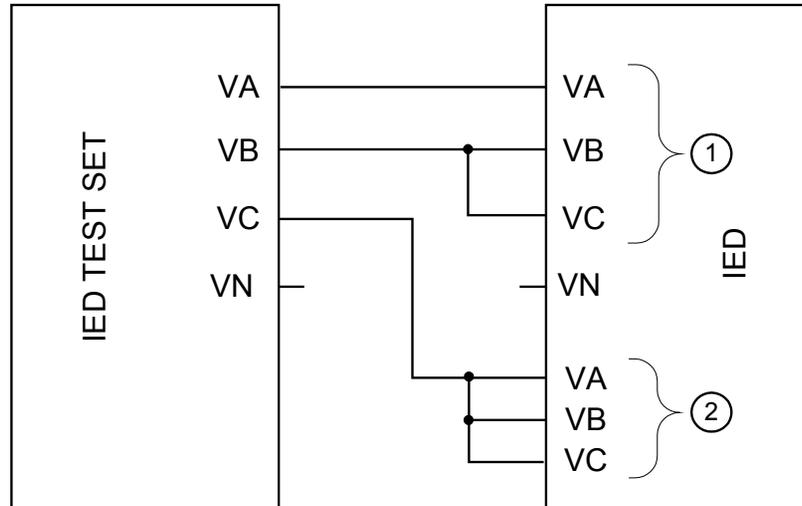
- 1 is three-phase voltage group1 (V1)
- 2 is three-phase voltage group2 (V2)

2. Apply voltage higher than the highest set value of $VDTrip$, $V1Low$ and $V2Low$ to the V1 three-phase inputs and to one phase of the V2 inputs according to figure 71.
The voltage differential PICKUP signal is set.
3. Decrease slowly the voltage in phase VL3 of the test set until the PICKUP signal resets.
4. Check V2 blocking level by comparing the voltage level at reset with the set undervoltage blocking $V2Low$.

13.7.5.2 Check of voltage differential trip and alarm levels

Procedure

1. Connect voltages to the IED according to valid connection diagram and figure 72.



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Figure 72: Connection of the test set to the IED for test of alarm levels, trip levels and trip timer

where:

- 1 is three-phase voltage group1 (V1)
- 2 is three-phase voltage group2 (V2)

2. Apply $1.2 \cdot V_n$ (rated voltage) to the V1 and V2 inputs.
3. Decrease slowly the voltage of in phase VL1 of the test set until the ALARM signal is activated.



The ALARM signal is delayed with timer t_{Alarm}

4. Check the alarm operation level by comparing the differential voltage level at ALARM with the set alarm level VD_{Alarm} .

5. Continue to slowly decrease the voltage until PICKUP signal is activated.
6. Check the differential voltage operation level by comparing the differential voltage level at PICKUP with the set trip level $VDTrip$.
7. Repeat steps [1](#) to [2](#) to check the other phases.
Observe that the connections to V1 must be shifted to test another phase. (VL1 to VL2, VL2 to VL3, VL3 to VL1)

13.7.5.3 Check of trip and trip reset timers

Procedure

1. Connect voltages to the IED according to valid connection diagram and figure [72](#).
2. Set V_n (rated voltage) to the V1 inputs and increase V2 voltage until differential voltage is $1.5 \cdot$ operating level ($VDTrip$).
3. Switch on the test set. Measure the time from activation of the PICKUP signal until TRIP signal is activated.
4. Check the measured time by comparing it to the set trip time $tTrip$.
5. Increase the voltage until PICKUP signal resets. Measure the time from reset of PICKUP signal to reset of TRIP signal.
6. Check the measured time by comparing it to the set trip reset time $tReset$.

13.7.5.4 Final adjustment of compensation for VT ratio differences

Procedure

1. With the protection in test mode, view the differential voltage service values in each phase on the local HMI under **Main menu/Test/Function status/Voltage protection/VoltageDiff(PTOV,60)/VDCx**.



The IED voltage inputs should be connected to the VTs according to valid connection diagram.

2. Record the differential voltages.
3. Calculate the compensation factor RF_x for each phase.
For information about calculation of the compensation factor, see the application manual.
4. Set the compensation factors on the local HMI under **Main menu/Settings/Settings group N/Voltage protection/VoltageDiff(PTOV,60)/VDCx**
5. Check that the differential voltages are close to zero.

13.7.5.5 Completing the test

Continue to test another function or end the test by changing the *Test mode* setting to *Off*. Restore connections and settings to their original values, if they were changed for testing purposes.

13.7.6 Loss of voltage check LOVPTUV (27)

Prepare the IED for verification of settings as outlined in section ["Overview"](#) and section ["Preparing for test"](#) in this chapter.

13.7.6.1 Measuring the operate limit of set values

1. Check that the input logical signals BLOCK, CBOPEN and VTSU are logical zero.
2. Supply a three-phase rated voltage in all three phases and note on the local HMI that the TRIP logical signal is equal to the logical 0.
3. Switch off the voltage in all three phases.
After set *tTrip* time a TRIP signal appears on the corresponding binary output or on the local HMI.



Note that TRIP at this time is a pulse signal, duration should be according to set *tPulse*.

4. Inject the measured voltages to their rated values for at least set *tRestore* time.
5. Activate the CBOPEN binary input.
6. Simultaneously disconnect all the three-phase voltages from the IED.
No TRIP signal should appear.
7. Inject the measured voltages to their rated values for at least set *tRestore* time.
8. Activate the VTSU binary input.
9. Simultaneously disconnect all the three-phase voltages from the *tRestore*.
No TRIP signal should appear.
10. Reset the VTSU binary input.
11. Inject the measured voltages to their rated values for at least set *tRestore* time.
12. Activate the BLOCK binary input.
13. Simultaneously disconnect all the three-phase voltages from the terminal.
No TRIP signal should appear.
14. Reset the BLOCK binary input.

13.7.6.2 Completing the test

Continue to test another function or end the test by changing the *Test mode* setting to *Off*. Restore connections and settings to their original values, if they were changed for testing purposes.

13.8 Frequency protection

13.8.1 Underfrequency protection SAPTUF (81)

Prepare the IED for verification of settings as outlined in section ["Overview"](#) and section ["Preparing for test"](#) in this chapter.

13.8.1.1 Verifying the settings

Verification of PICKUP value and time delay to operate

1. Check that the IED settings are appropriate, especially the PICKUP value and the definite time delay.
2. Supply the IED with three-phase voltages at their rated values.
3. Slowly decrease the frequency of the applied voltage, until the PICKUP signal appears.
4. Note the operate value and compare it with the set value.
5. Increase the frequency until rated operating levels are reached.
6. Check that the PICKUP signal resets.
7. Instantaneously decrease the frequency of the applied voltage to a value about 20% lower than the operate value.
8. Measure the time delay of the TRIP signal, and compare it with the set value.

Extended testing

1. The test above can be repeated to check the time to reset.
2. The tests above can be repeated to test the voltage dependent inverse time characteristic.

Verification of the low voltage magnitude blocking

1. Check that the IED settings are appropriate, especially the *PUFrequency*, *IntBlockLevel*, and the *TimeDlyOperate*.
2. Supply the IED with three-phase voltages at rated values.
3. Slowly decrease the magnitude of the applied voltage, until the BLKDMAGN signal appears.
4. Note the voltage magnitude value and compare it with the set value *IntBlockLevel*.
5. Slowly decrease the frequency of the applied voltage, to a value below *PUFrequency*.
6. Check that the PICKUP signal does not appear.
7. Wait for a time corresponding to *TimeDlyOperate*, and make sure that the TRIP signal not appears.

13.8.1.2 Completing the test

Continue to test another function or end the test by changing the *Test mode* setting to *Off*. Restore connections and settings to their original values, if they were changed for testing purposes.

13.8.2 Overfrequency protection SAPTOF (81)

Prepare the IED for verification of settings as outlined in section ["Overview"](#) and section ["Preparing for test"](#) in this chapter.

13.8.2.1 Verifying the settings

Verification of PICKUP value and time delay to operate

1. Check that the settings in the IED are appropriate, especially the PICKUP value and the definite time delay.
2. Supply the IED with three-phase voltages at their rated values.
3. Slowly increase the frequency of the applied voltage, until the PICKUP signal appears.
4. Note the operate value and compare it with the set value.
5. Decrease the frequency to rated operating conditions.
6. Check that the PICKUP signal resets.
7. Instantaneously increase the frequency of the applied voltage to a value about 20% higher than the operate value.
8. Measure the time delay for the TRIP signal, and compare it with the set value.

Extended testing

1. The test above can be repeated to check the time to reset.

Verification of the low voltage magnitude blocking

1. Check that the settings in the IED are appropriate, especially the *PUFrequency*, *IntBlocklevel*, and the *TimeDlyOperate*.
2. Supply the IED with three-phase voltages at their rated values.
3. Slowly decrease the magnitude of the applied voltage, until the BLKDMAGN signal appears.
4. Note the voltage magnitude value and compare it with the set value, *IntBlocklevel*.
5. Slowly increase the frequency of the applied voltage, to a value above *PUFrequency*.
6. Check that the PICKUP signal does not appear.
7. Wait for a time corresponding to *TimeDlyOperate*, and make sure that the TRIP signal does not appear.

13.8.2.2

Completing the test

Continue to test another function or end the test by changing the *Test mode* setting to *Off*. Restore connections and settings to their original values, if they were changed for testing purposes.

13.8.3

Rate-of-change frequency protection SAPFRC (81)

Prepare the IED for verification of settings as outlined in section ["Overview"](#) and section ["Preparing for test"](#) in this chapter.

13.8.3.1

Verifying the settings

PICKUP value and time delay to operate

1. Check that the settings in the IED are appropriate, especially the PICKUP value and the definite time delay. Set *PickupFreqgrad*, to a rather small negative value.
2. Supply the IED with three-phase voltages at their rated values.
3. Slowly decrease the frequency of the applied voltage, with an increasing rate-of-change that finally exceeds the setting of *PickupFreqgrad*, and check that the PICKUP signal appears.
4. Note the operate value and compare it with the set value.
5. Increase the frequency to rated operating conditions, and zero rate-of-change.

6. Check that the PICKUP signal resets.
7. Instantaneously decrease the frequency of the applied voltage to a value about 20% lower than the nominal value.
8. Measure the time delay for the TRIP signal, and compare it with the set value.

Extended testing

1. The test above can be repeated to check a positive setting of *PickupFreqGrad*.
2. The tests above can be repeated to check the time to reset.
3. The tests above can be repeated to test the RESTORE signal, when the frequency recovers from a low value.

13.8.3.2

Completing the test

Continue to test another function or end the test by changing the *Test mode* setting to *Off*. Restore connections and settings to their original values, if they were changed for testing purposes.

13.9

Multipurpose protection

13.9.1

General current and voltage protection CVGAPC

Prepare the IED for verification of settings as outlined in section ["Overview"](#) and section ["Preparing for test"](#) in this chapter.

One of the new facilities within the general current and voltage protection function CVGAPC is that the value, which is processed and used for evaluation in the function, can be chosen in many different ways by the setting parameters *CurrentInput* and *VoltageInput*.

These setting parameters decide what kind of preprocessing the connected three-phase CT and VT inputs shall be subjected to. That is, for example, single-phase quantities, phase-to-phase quantities, positive sequence quantities, negative sequence quantities, maximum quantity from the three-phase group, minimum quantity from the three-phase group, difference between maximum and minimum quantities (unbalance) can be derived and then used in the function.

Due to the versatile possibilities of CVGAPC itself, but also the possibilities of logic combinations in the application configuration of outputs from more than one CVGAPC function block, it is hardly possible to define a fully covering general commissioning test.

13.9.1.1 Built-in overcurrent feature (non-directional)

Procedure

1. Go to **Main menu/Test/Function test modes/Multipurpose protection/GeneralCurrentVoltage(GAPC)/GFx** and make sure that CVGAPC to be tested is unblocked and other functions that might disturb the evaluation of the test are blocked.
2. Connect the test set for injection of three-phase currents to the appropriate current terminals of the IED in the 670 series.
3. Inject current(s) in a way that relevant measured current (according to setting parameter *CurrentInput*) is created from the test set. Increase the current(s) until the low set stage operates and check against the set operate value.
4. Decrease the current slowly and check the reset value.
5. Block high set stage if the injection current will activate the high set stage when testing the low set stage according to below.
6. Connect a TRIP output contact to the timer.
7. Set the current to 200% of the operate value of low set stage, switch on the current and check the time delay.
For inverse time curves, check the operate time at a current equal to 110% of the operate current at $t_{MinTripDelay}$.
8. Check that TRIP and PICKUP contacts operate according to the configuration logic.
9. Release the blocking of the high set stage and check the operate and reset value and the time delay for the high set stage in the same way as for the low set stage.
10. Finally check that PICKUP and TRIP information is stored in the event menu.



Information on how to use the event menu is found in the operator's manual.

13.9.1.2 Overcurrent feature with current restraint

The current restraining value has also to be measured or calculated and the influence on the operation has to be calculated when the testing of the operate value is done.

Procedure

1. Operate value measurement
The current restraining value has also to be measured or calculated and the influence on the operation has to be calculated when the testing of the operate value is done.

13.9.1.3 Overcurrent feature with voltage restraint

Procedure

1. Connect the test set for injection of three-phase currents and three-phase voltages to the appropriate current and voltage terminals of the IED.
2. Inject current(s) and voltage(s) in a way that relevant measured (according to setting parameter *CurrentInput* and *VoltageInput*) currents and voltages are created from the test set.
Overall check in principal as above (non-directional overcurrent feature)
3. Operate value measurement
The relevant voltage restraining value (according to setting parameter *VoltageInput*) has also to be injected from the test set and the influence on the operate value has to be calculated when the testing the operate value is done.
4. Operate time measurement
Definite times may be tested as above (non-directional overcurrent feature). For inverse time characteristics the PICKUP value (to which the overcurrent ratio has to be calculated) is the actual pickup value as got with actual restraining from the voltage restraining quantity.

13.9.1.4 Overcurrent feature with directionality

Please note that the directional characteristic can be set in two different ways either just dependent on the angle between current and polarizing voltage (setting parameter *DirPrinc_OC1* or *DirPrinc_OC2* set to or in a way that the operate value also is dependent on the angle between current and polarizing voltage according to the $I \cdot \cos(\Phi)$ law (setting parameter *DirPrincOC1* or *DirPrincOC2* set to $I \cdot \cos(\Phi)$). This has to be known if a more detailed measurement of the directional characteristic is made, than the one described below.

Procedure

1. Connect the test set for injection of three-phase currents and three-phase voltages to the appropriate current and voltage terminals of the IED.
2. Inject current(s) and voltage(s) in a way that relevant measured (according to setting parameter *CurrentInput* and *VoltageInput*) currents and voltages are created from the test set.
3. Set the relevant measuring quantity current to lag or lead (lag for negative RCA angle and lead for positive RCA angle) the relevant polarizing quantity voltage by an angle equal to the set IED characteristic angle (*rca-dir*) when forward directional feature is selected and the *CTWYEpoint* configuration parameter is set to *ToObject*.

If reverse directional feature is selected or *CTWYEpoint* configuration parameter is set to *FromObject*, the angle between current and polarizing voltage shall be set equal to $rca-dir+180^\circ$.

4. Overall check in principal as above (non-directional overcurrent feature)
5. Reverse the direction of the injection current and check that the protection does not operate.
6. Check with low polarization voltage that the feature becomes non-directional, blocked or with memory according to the setting.

13.9.1.5 Over/Undervoltage feature

Procedure

1. Connect the test set for injection three-phase voltages to the appropriate voltage terminals of the IED.
2. Inject voltage(s) in a way that relevant measured (according to setting parameter *VoltageInput*) voltages are created from the test set.
3. Overall check in principal as above (non-directional overcurrent feature) and correspondingly for the undervoltage feature.

13.9.1.6 Completing the test

Continue to test another function or end the test by changing the *Test mode* setting to *Off*. Restore connections and settings to their original values, if they were changed for testing purposes.

13.10 Secondary system supervision

13.10.1 Current circuit supervision CCSRDIF (87)

Prepare the IED for verification of settings as outlined in section ["Overview"](#) and section ["Preparing for test"](#) in this chapter.

The Current circuit supervision function CCSRDIF (87) is conveniently tested with the same three-phase test set as used when testing the measuring functions in the IED.

The condition for this procedure is that the setting of *IMinOp* is lower than the setting of *Pickup_Block*.

13.10.1.1 Verifying the settings

1. Check the input circuits and the operate value of the *IMinOp* current level detector by injecting current, one phase at a time.
2. Check the phase current blocking function for all three phases by injection current, one phase at a time. The output signals shall reset with a delay of 1 second when the current exceeds $1.5 \cdot I_{Base}$.
3. Inject a current $0.9 \cdot I_{Base}$ to phase A and a current $0.15 \cdot I_{Base}$ to the reference current input I5.
4. Decrease slowly the current to the reference current input and check that blocking is obtained when the current is about $0.1 \cdot I_{Base}$.

13.10.1.2 Completing the test

Continue to test another function or end the test by changing the *Test mode* setting to *Off*. Restore connections and settings to their original values, if they were changed for testing purposes.

13.10.2 Fuse failure supervision SDDRFUF

Prepare the IED for verification of settings as outlined in section ["Overview"](#) and section ["Preparing for test"](#) in this chapter.

The verification is divided in two main parts. The first part is common to all fuse failure supervision options, and checks that binary inputs and outputs operate as expected according to actual configuration. In the second part the relevant set operate values are measured.

13.10.2.1 Checking that the binary inputs and outputs operate as expected

Procedure

1. Simulate normal operating conditions with the three-phase currents in phase with their corresponding phase voltages and with all of them equal to their rated values.
2. Connect the nominal dc voltage to the 89bS binary input.
 - The signal BLKV should appear with almost no time delay.
 - No signals BLKZ and 3PH should appear on the IED.
 - Only the distance protection function operates.
 - No other undervoltage-dependent functions must operate.
3. Disconnect the dc voltage from the 89b binary input terminal.
4. Connect the nominal dc voltage to the MCBOP binary input.
 - The BLKV and BLKZ signals should appear without any time delay.
 - No undervoltage-dependent functions must operate.

5. Disconnect the dc voltage from the MCBOP binary input terminal.
6. Disconnect one of the phase voltages and observe the logical output signals on the binary outputs of the IED.. BLKV and BLKZ signals should simultaneously appear.
7. After more than 5 seconds disconnect the remaining two-phase voltages and all three currents.
 - There should be no change in the high status of the output signals BLKV and BLKZ.
 - The signal 3PH will appear.
8. Establish normal voltage and current operating conditions simultaneously and observe the corresponding output signals. They should change to logical 0 as follows:
 - Signal 3PH after about 25ms
 - Signal BLKV after about 50ms
 - Signal BLKZ after about 200ms

13.10.2.2

Measuring the operate value for the negative sequence function

Measure the operate value for the negative sequence function, if included in the IED.

Procedure

1. Simulate normal operating conditions with the three-phase currents in phase with their corresponding phase voltages and with all of them equal to their rated values.
2. Slowly decrease the measured voltage in one phase until the BLKV signal appears.
3. Record the measured voltage and calculate the corresponding negative-sequence voltage according to the equation.

Observe that the voltages in the equation are phasors.

$$3 \cdot \overline{V}_2 = \overline{V}_A + a^2 \cdot \overline{V}_B + a \cdot \overline{V}_C$$

(Equation 13)

Where:

$$\overline{V}_A, \overline{V}_B \text{ and } \overline{V}_C$$

= the measured phase voltages

$$a = 1 \cdot e^{j \frac{2 \cdot \pi}{3}} = -0,5 + j \frac{\sqrt{3}}{2}$$

4. Compare the result with the set value (consider that the set value $3V2PU$ is in percentage of the base voltage U_{Base}) of the negative-sequence operating voltage.

13.10.2.3 Measuring the operate value for the zero-sequence function

Measure the operate value for the zero-sequence function, if included in the IED.

Procedure

1. Simulate normal operating conditions with the three-phase currents in phase with their corresponding phase voltages and with all of them equal to their rated values.
2. Slowly decrease the measured voltage in one phase until the BLKV signal appears.
3. Record the measured voltage and calculate the corresponding zero-sequence voltage according to the equation.

Observe that the voltages in the equation are phasors.

$$3 \cdot \overline{V}_0 = \overline{V}_A + \overline{V}_B + \overline{V}_C$$

(Equation 16)

Where:

$$\overline{V}_A, \overline{V}_B \text{ and } \overline{V}_C$$

= the measured phase voltages.

4. Compare the result with the set value (consider that the set value $3V0Pickup$ is in percentage of the base voltage of the zero-sequence operating voltage).

13.10.2.4 Checking the operation of the dv/dt and di/dt based function

Check the operation of the dv/dt and di/dt based function, if included in the IED.

Procedure

1. Simulate normal operating conditions with the three-phase currents in phase with their corresponding phase voltages and with all of them equal to their rated values.
2. Connect the nominal dc voltage to the 52a binary input.
3. Change the voltages and currents in all three phases simultaneously.
The voltage change should be greater than set $DVPU$ and the current change should be less than the set $DIPU$.
 - The BLKV and BLKZ signals appear without any time delay. The BLKZ signal will be activated, only if the internal deadline detection is not activated at the same time.
 - 3PH should appear after 5 seconds, if the remaining voltage levels are lower than the set $VDDLPU$ of the DLD function.
4. Apply normal conditions as in step 3.
The BLKV, BLKZ and 3PH signals should reset, if activated, see step 1.
5. Change the voltages and currents in all three phases simultaneously.

The voltage change should be greater than set *DVPU* and the current change should be greater than the set *DIPU*.

The BLKV, BLKZ and 3PH signals should not appear.

6. Disconnect the dc voltage to the 52a binary input.
7. Apply normal conditions as in step [1](#).
8. Repeat step [3](#).
9. Connect the nominal voltages in all three phases and feed a current below the operate level in all three phases.
10. Keep the current constant. Disconnect the voltage in all three phases simultaneously.

13.10.2.5 Completing the test

Continue to test another function or end the test by changing the *Test mode* setting to *Off*. Restore connections and settings to their original values, if they were changed for testing purposes.

13.11 Control

13.11.1 Synchronism check, energizing check, and synchronizing SESRSYN (25)

This section contains instructions on how to test the synchronism check, energizing check, and synchronizing function SESRSYN (25) for single and double CB and for breaker-and-a-half arrangements.

This section contains instructions on how to test the synchrochecksynchronism check and energizing check for single CB with or without the synchronizing function.

Prepare the IED for verification of settings as outlined in section ["Overview"](#) and section ["Preparing for test"](#) in this chapter.

At commissioning and periodical checks, the functions shall be tested with the used settings. To test a specific function, it might be necessary to change some setting parameters, for example:

- *AutoEnerg* = *On/Off/DLLB/DBLL/Both*
- *ManEnerg* = *Off*
- *Operation* = *Off, On*
- Activation of the voltage selection function if applicable

The tests explained in the test procedures below describe the settings, which can be used as references during testing before the final settings are specified. After testing, restore the equipment to the normal or desired settings.

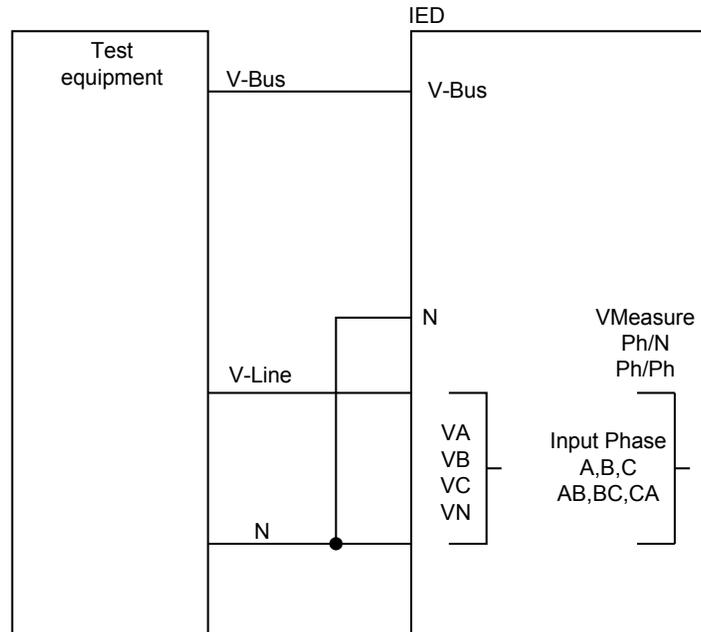
A secondary injection test set with the possibility to alter the phase angle by regulation of the resistive and reactive components is needed. The test set must also be able to generate different frequencies on different outputs.



The description below applies for a system with a nominal frequency of 60 Hz but can be directly transferred to 50 Hz. SESRSYN (25) can be set to use different phases, phase to earth or phase to phase. Use the set voltages instead of what is indicated below.

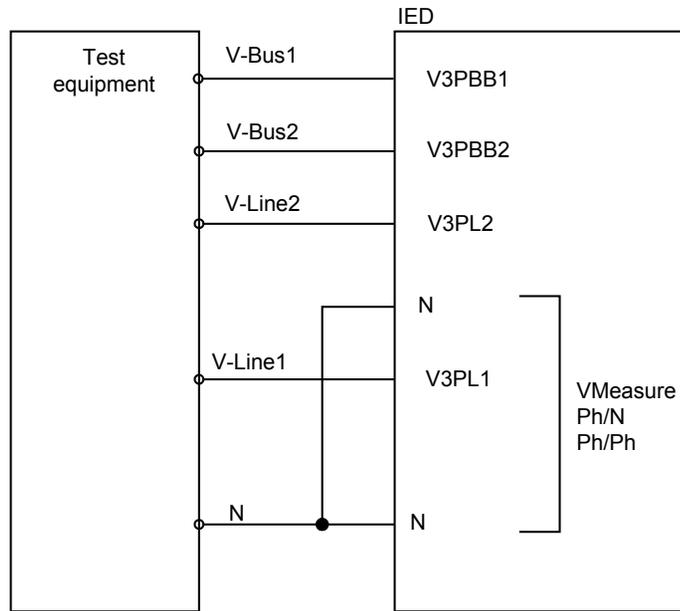
Figure 73 shows the general test connection principle, which can be used during testing. This description describes the test of the version intended for one bay.

Figure 74 shows the general test connection for a breaker-and-a-half diameter with one-phase voltage connected to the line side.



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Figure 73: General test connection with three-phase voltage connected to the line side



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Figure 74: General test connection for a breaker-and-a-half diameter with one-phase voltage connected to the line side

13.11.1.1

Testing the synchronizing function

This section is applicable only if the synchronizing function is included.

The voltage inputs used are:

V3PL1	VA, VB or VC line 1 voltage inputs on the IED
V3PBB1	Bus1 voltage input on the IED

Testing the frequency difference

The frequency difference is in the example set at 0.20 Hz on the local HMI, and the test should verify that operation is achieved when the *FreqDiffMax* frequency difference is lower than 0.20 Hz. The test procedure below will depend on the settings used.

1. Apply voltages

- 1.1. V-Line = 100% V_{Base}
- 1.2. f-line = 60.0 Hz and V-Bus = 100% V_{Base}
- 1.3. f-bus = 60.2 Hz
2. Check that a closing pulse is submitted and at closing angle less than 2 degrees from phase equality. Modern test sets will evaluate this automatically.
3. Repeat with
 - 3.1. V-Bus = 80% V_{Base}
 - 3.2. f-bus = 60.25 Hz, to verify that the function does not operate when frequency difference is above limit.
4. Repeat with different frequency differences for example, 100 mHz with f-bus nominal and line leading and for example 20 mHz (or just above $FreqDiffMin$) to verify that independent of frequency difference the closing pulse occurs within 2 degrees.
5. Verify that the closing command is not issued when the frequency difference is less than the set value $FreqDiffMin$.

13.11.1.2

Testing the synchronizing check

During the test of SESRSYN (25) for a single bay arrangement, these voltage inputs are used:

V-Line	VA, VB or VC voltage input on the IED
V-Bus	V5 voltage input on the IED

Testing the voltage difference

Set the voltage difference at 15% V_{Base} on the local HMI, and the test should check that operation is achieved when the voltage difference $VDiffSC$ is lower than 15% V_{Base} .

The settings used in the test shall be final settings. The test shall be adapted to site setting values instead of values in the example below.

Test with no voltage difference between the inputs.

Test with a voltage difference higher than the set $VDiffSC$

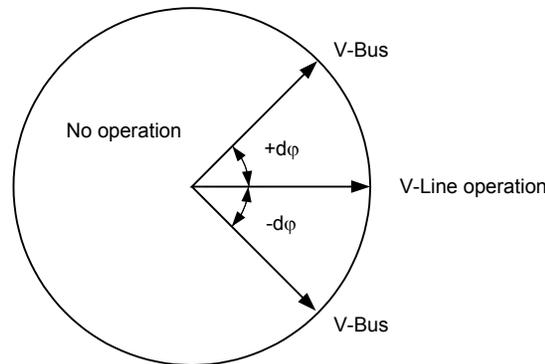
1. Apply voltages V-Line (for example) = 80% V_{Base} and V-Bus = 80% V_{Base} .
2. Check that the AUTOSYOK and MANSYOK outputs are activated.
3. The test can be repeated with different voltage values to verify that the function operates within the set V_{DiffSC} . Check with both V-Line and V-Bus respectively lower than the other.
4. Increase the V-Bus to 110% V_{Base} , and the V-Line = 90% V_{Base} and also the opposite condition.
5. Check that the two outputs for manual and auto synchronism are not activated.

Testing the phase angle difference

The phase angle differences $PhaseDiffM$ and $PhaseDiffA$ respectively are set to their final settings and the test should verify that operation is achieved when the phase angle difference is lower than this value both leading and lagging.

Test with no voltage difference

1. Apply voltages V-Line (for example) = 100% V_{Base} and V-Bus = 100% V_{Base} , with a phase difference equal to 0 degrees and a frequency difference lower than $FreqDiffA$ and $FreqDiffM$
2. Check that the AUTOSYOK and MANSYOK outputs are activated.
The test can be repeated with other phase difference values to verify that the function operates for values lower than the set ones, $PhaseDiffM$ and $PhaseDiffA$. By changing the phase angle on the voltage connected to V-Bus, between $\pm \varphi$ degrees, the user can check that the two outputs are activated for a phase difference lower than the set value. It should not operate for other values. See figure [75](#).



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Figure 75: Test of phase difference.

3. Change the phase angle between $+d\phi$ and $-d\phi$ and verify that the two outputs are activated for phase differences between these values but not for phase differences outside, see figure 75.

Testing the frequency difference

The frequency difference test should verify that operation is achieved when the *FreqDiffA* and *FreqDiffM* frequency difference is lower than the set value for manual and auto synchronizing check, *FreqDiffA* and *FreqDiffM* respectively and that operation is blocked when the frequency difference is bigger.

Test with frequency difference = 0 mHz

Test with a frequency difference outside the set limits for manual and auto synchronizing check respectively.

1. Apply voltages V-Line equal to 100% *VBase* and V-Bus equal to 100% *VBase*, with a frequency difference equal to 0 mHz and a phase difference lower than the set value.
2. Check that the AUTOSYOK and MANSYOK outputs are activated.
3. Apply voltage to the V-Line equal to 100% *VBase* with a frequency equal to 50 Hz and voltage V-Bus equal to 100% *VBase*, with a frequency outside the set limit.
4. Check that the two outputs are not activated. The test can be repeated with different frequency values to verify that the function operates for values lower than the set ones. If a modern test set is used, the frequency can be changed continuously.

Testing the reference voltage

1. Use the same basic test connection as in figure 73.

The voltage difference between the voltage connected to V-Bus and V-Line should be 0%, so that the AUTOSYOK and MANSYOK outputs are activated first.

2. Change the V-Line voltage connection to V-Line2 without changing the setting on the local HMI. Check that the two outputs are not activated.

13.11.1.3

Testing the energizing check

During the test of the energizing check function for a single bay arrangement, these voltage inputs are used:

V-Line	VA, VB or VC voltage input on the IED
V-Bus	Bus voltage input on the IED

General

When testing the energizing check function for the applicable bus, arrangement shall be done for the energizing check functions. The voltage is selected by activation of different inputs in the voltage selection logic.

The test shall be performed according to the settings for the station. Test the alternatives below that are applicable.

Testing the dead line live bus (DLLB)

The test should verify that the energizing check function operates for a low voltage on the V-Line and for a high voltage on the V-Bus. This corresponds to the energizing of a dead line to a live bus.

1. Apply a single-phase voltage 100% V_{Base} to the U-Bus, and a single-phase voltage 30% V_{Base} to the V-Line.
2. Check that the AUTOENOK and MANENOK outputs are activated.
3. Increase the V-Line to 60% V_{Base} and V-Bus to be equal to 100% V_{Base} . The outputs should not be activated.
4. The test can be repeated with different values on the V-Bus and the V-Line.

Testing the dead bus live line (DBLL)

The test should verify that the energizing check function operates for a low voltage on the V-Bus and for a high voltage on the V-Line. This corresponds to an energizing of a dead bus from a live line.

1. Verify the local HMI settings *AutoEnerg* or *ManEnerg* to be *DBLL*.
2. Apply a single-phase voltage of 30% *VBase* to the V-Bus and a single-phase voltage of 100% *VBase* to the V-Line.
3. Check that the AUTOENOK and MANENOK outputs are activated.
4. Decrease the V-Line to 60% *VBase* and keep the V-Bus equal to 30% *VBase*. The outputs should not be activated.
5. The test can be repeated with different values on the V-Bus and the V-Line.

Testing both directions (DLLB or DBLL)

Procedure

1. Verify the local HMI settings *AutoEnerg* or *ManEnerg* to be *Both*.
2. Apply a single-phase voltage of 30% *VBase* to the V-Line and a single-phase voltage of 100% *VBase* to the V-Bus.
3. Check that the AUTOENOK and MANENOK outputs are activated.
4. Change the connection so that the V-Line is equal to 100% *VBase* and the V-Bus is equal to 30% *VBase*. The outputs should still be activated.
5. The test can be repeated with different values on the V-Bus and the V-Line.

Testing the dead bus dead line (DBDL)

The test should verify that the energizing check function operates for a low voltage on both the V-Bus and the V-Line, that is, closing of the breaker in a non-energized system. Test is valid only when this function is used.

1. Verify the local HMI setting *AutoEnerg* to be *Disabled* and *ManEnerg* to be *DBLL*.
2. Set the parameter *ManEnergDBDL* to *Enabled*.
3. Apply a single-phase voltage of 30% *VBase* to the U-Bus and a single-phase voltage of 30% *VBase* to the V-Line.
4. Check that the MANENOK output is activated.
5. Increase the V-Bus to 80% *VBase* and keep the V-Line equal to 30% *VBase*. The outputs should not be activated.
6. Repeat the test with *ManEnerg* set to *DLLB* with different values on the V-Bus and the V-Line voltage.

13.11.1.4

Testing the voltage selection

Testing the voltage selection for single CB arrangements

This test should verify that the correct voltage is selected for the measurement in the energizing check function used in a double-bus arrangement. Apply a single-phase

voltage of 30% V_{Base} to the V-Line and a single-phase voltage of 100% V_{Base} to the V-Bus.

If the VB1/2OK inputs for the fuse failure are used, they must be activated, during tests below. Also verify that deactivation prevents operation and gives an alarm.

1. Connect the signals above to binary inputs and binary outputs.
2. Connect the voltage inputs to the analog inputs used for each bus or line depending of the type of busbar arrangement and verify that correct output signals are generated.

Testing the voltage selection for double breaker or 1½ circuit breaker diameter when applicable

This test should verify that correct voltage is selected for the measurement in the energizing function used for a diameter in a Breaker-and-a-half arrangement. Apply single-phase voltages to the inputs. H means a voltage of 100% V_{Base} and L means a voltage of 30% V_{Base} . Verify that correct output signals are generated.

1. Connect the analog signals to the voltage inputs, in pair of two for V1 and V2. (Inputs U3P - BB1, BB2, L1, L2)
2. Activate the binary signals according to the used alternative. Verify the measuring voltage on the synchronizing check function SESRSYN (25). Normally it can be good to verify synchronizing check with the same voltages and phase angles on both voltages. The voltages should be verified to be available when selected and not available when another input is activated so connect only one voltage transformer reference at each time.
3. Record the voltage selection tests in a matrix table showing read values and AUTOSYOK/MANSYOK signals to document the test performed.

13.11.1.5

Completing the test

Continue to test another function or end the test by changing the *Test mode* setting to *Off*. Restore connections and settings to their original values, if they were changed for testing purposes.

13.11.2

Autorecloser SMBRREC (79)

Verification of the autorecloser function SMBRREC (79) can be considered to consist of two parts.

- One part to verify the internal logic and timing of the function
- One part to verify its interaction with the protection system

This section deals with verification of SMBRREC (79) itself. However, it is practical to initiate SMBRREC (79) by activating a protection function, for example, by secondary injection tests.

Prepare the IED for verification of settings as outlined in the section ["Overview"](#) and section ["Preparing for test"](#) in this chapter.

The purpose of verification before commissioning is to check that entered selections, setting parameters and configuration render the intended result. The function is flexible with many options and facilities. At commissioning only the selections and settings intended for use are verified. If one chooses to reduce some time settings in order to speed up verification, be careful to set the parameters at intended operational values at the end of the verification procedure. One such parameter is the *tReset* time and could result in a long delay of reclosing shots, for example, shot 2 and later ones.

The verification test is performed together with protection and trip functions. Figure [76](#) illustrates a suggested testing arrangement, where the circuit-breaker (CB) is simulated by an external bi-stable relay (BR), for example a relay type RXMVB2 or RXMD or Breaker Simulator of ABB. The following manual switches are used:

- Switch or push-button to close (SC)
- Switch or push-button to trip (ST)
- Switch for CB ready condition (SRY)

If no bi-stable relay or breaker simulator is available, replace it with two self-reset auxiliary relays and use a self-holding connection.

Use a secondary injection IED test set to operate the protection function. The test set shall be switched off when a trip signal is given or when the BR comes to open position to simulate real conditions.

The CB simulation can be made more elaborate, including simulation of the operating gear condition, CBREADY of either the type ready for a Close-Open (CO) cycle, or the type ready for an Open-Close -Open (OCO) cycle.

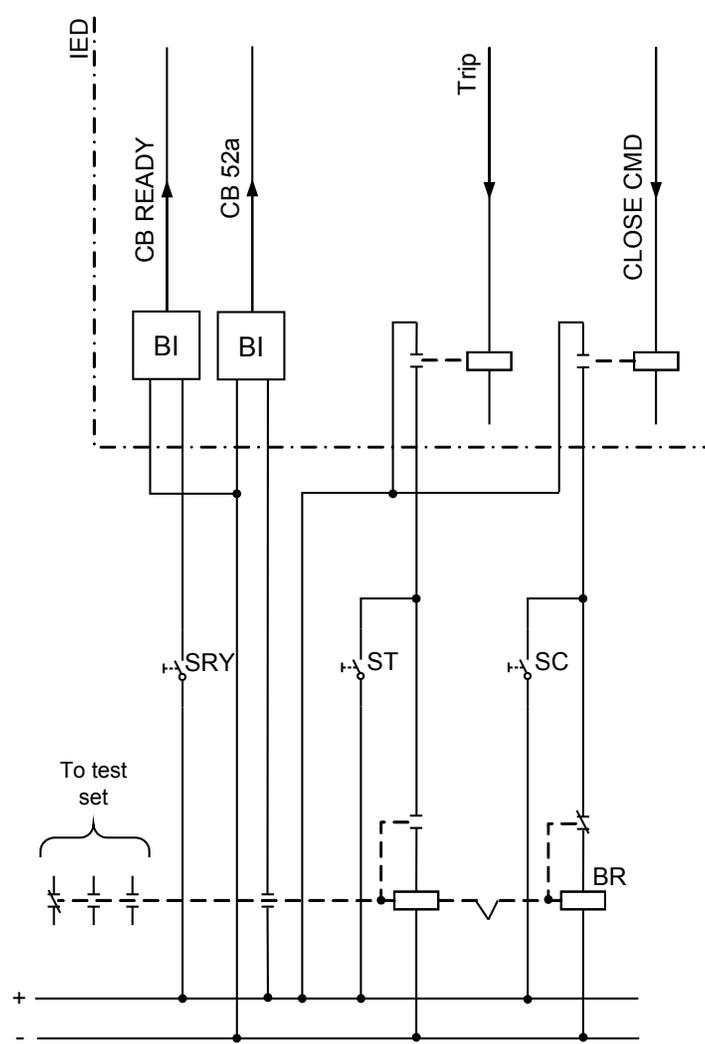
The CB condition CBREADY of a type, CO, shall be high (true) until a closing operation is performed. It then goes low (false) for a recharging time of about 5 - 10s. After that it is high again.

A CB condition CBREADY of a type, OCO shall be high (true) before and during tripping (Initiate reclosing). During tripping it goes low for a recharging time, for example, 10s. It may thus be low at the instant of reclosing. After each Open or Close operation it may need a recharging period before it goes high again.

In the example of CB simulation arrangement, the CBREADY condition is simulated by a manual switch, SRY.

Information and material for the verification:

- Protection or control unit, IED, configured and with settings entered.
- Configuration diagram for the IED
- Terminal diagram for the IED, or plant circuit diagram including the IED
- Technical reference manual for the IED
- IED test set for secondary injection
- Means to indicate, measure and record operation and times, for example an event recording facility
- A bi-stable relay (BR) or two auxiliary relays to simulate a CB
- Two push-buttons (SC, ST) to operate the BR and a change-over switch (SRY) to simulate CBREADY
- Possibly a switch simulation the synchronizing check (SYNC) condition



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Figure 76: *Simulating the CB operation by a bi-stable relay/breaker simulator and manual switches*

13.11.2.1

Preparation of the verification

1. Check the function settings on the local HMI under **Main menu/Settings/Setting group N/Control/Autorecloser(RREC,79)/AR0x**

If any timer settings are reduced to speed up or facilitate the testing, they shall be set to normal after testing. A temporary label on the IED can be a reminder to restore normal settings after which a verification test should be performed.

2. Decide if a synchronizing check function SESRSYN (25) shall be included in the test.

If SESRSYN (25) as an internal function or external device is not operated by the injection, it may be connected as a permanent high signal or controlled by a switch.

3. Read and make notes of the reclosing operation counters on the local HMI under **Main menu/Test/Function status/Control/AutoRecloser(RREC,79)/AR0x**. Possibly reset the counters to *Zero*. Counters are reset in the reset menu.
4. Make arrangements for the simulation of the CB, for example as in figure 76.
5. Make arrangements for indication, recording and time measurements. The signals for ,52a, RI, CLOSECMD, READY and other relevant signals should preferably be arranged for event recording with time tagging. If that is not possible, other means of time measurement and recording should be arranged.

13.11.2.2

Switching the autorecloser function to *Enabled* and *Disabled*

1. Set the *Operation* setting to *Disabled* and check the state.
2. Set the *Operation* setting to *Enabled* and check the state, including SETON and READY.
The CB should be closed and ready.
3. If external control Disabled/Enabled is connected, check that it works.
Set *Operation* to *ExternalCtrl* and use that control to switch Enabled and Disabled, and check the state of the function.

13.11.2.3

Verifying the autorecloser function SMBRREC (79)

Select the test cases to be run according to what is applicable to the particular application. It can be, for example,

- three-phase single-shot reclosing
- two-shot reclosing
- single-phase and three-phase single-shot reclosing

Below, a case with single-phase and three-phase single-shot reclosing is described.

1. Set *Operation* = *Enabled*.
2. If the autorecloser function SMBRREC (79) is not to be operated, ensure that the SMBRREC (79) input is activated. If SMBRREC (79) is to be included, ensure that it is supplied with the appropriate AC quantities.
3. Simulate CB closed position by closing switch SC to make the BR relay pick-up.

4. Simulate CBREADY by closing the switch SRY, and leave it closed.
5. Inject AC quantities to give a trip, for example, one-pole trip, to the BR and to the RI input.
Observe and preferably record the operation. The BR relay shall trip and reclose (pick-up). After reclosing, the SRY switch can be opened for about 5s and then closed again.
The autoreclosing open time and the sequence should be checked, for example in the event recording. Check also the operation indications (disturbance report) and the operation counters on the local HMI under **Main menu/Test/Function status/Control/AutoRecloser(RREC,79)/ARx**
Should the operation not be as expected, this should be investigated. It could be caused by an inappropriate setting or missing condition such as CBREADY (or SMBRREC (79) at three-phase reclosing).
6. Repeat the sequence by simulating a permanent fault.
Shortly after the reclosing shot, a new fault is applied. If a single-shot reclosing program is selected, there shall be one reclosing operation and then blocking of SMBRREC (79) for the set Reset time.
Before a new reclosing sequence can be run, the CBREADY and 52a (CB closed) must be set manually.
7. Repeat the sequence by simulating a three-phase transient and permanent faults, and other applicable cases, such as signal to RI_HS and high-speed reclosing.
If just single-phase reclosing is selected, *FirstShot = 1ph*, a check can be run to make sure that a three-pole trip does not result in any reclosing. Other similar cases can be checked as required.

13.11.2.4

Checking the reclosing conditions

When checking the influence of a releasing condition it is suggested to first run a sequence with the condition fulfilled. When the condition signal is removed, and a new sequence is run, it indicates that the result was due to the changed condition. In case of a blocking signal the procedure should be similar. Start without the blocking or inhibit signal, and then run a sequence with the blocking or inhibit signal added.

Checking the influence of the INHIBIT signal

1. Check that the autorecloser function SMBRREC (79) is operative, for example, by making a reclosing shot without the INHIBIT signal.
2. Apply a fault and thereby a RI signal. At the same time, or during the open time, apply a signal to the input INHIBIT.
3. Check that the reclosing sequence is interrupted and no reclosing takes place.

Check closing onto a fault

1. Check that the autorecloser function SMBRREC (79) is operative, for example by making a reclosing shot.
Keep the CBREADY signal high.
2. Set the breaker simulating relay BR in Open position.
3. Close the BR relay and apply immediately a fault and thereby a RI signal.
4. Check that no reclosing takes place.

Checking the influence of CB not ready for reclosing

1. Check that the autorecloser function SMBRREC (79) is operative, for example by making a reclosing shot.
Keep the CB simulator BR closed. Remove the CBREADY signal by opening SRY.
2. Apply a fault and thereby a RI signal.
3. Check that no reclosing takes place.

Checking the influence of synchronizing check (at three-pole reclosing)

1. Check that the autorecloser function SMBRREC (79) is operative, for example, by making a three-pole reclosing shot with the synchronizing check condition.
Remove the SMBRREC (79) signal.
2. Apply a fault causing three-phase trip and thereby a RI and a TR3P signal.
3. Wait for the t_{Sync} time out limit.
Check that no reclosing is made.

Checking the response when autoreclosing is *Off*

Procedure

1. Check that the autorecloser function SMBRREC (79) is operative, for example by making a reclosing shot.
Set the autoreclosing operation to *Off*, for example by external control.
The output READY shall be low, and PREP3P shall be high.
2. Apply a fault and thereby a RI signal.
3. Check that no reclosing takes place.

Testing autoreclosing in a multi-breaker arrangement

The usual arrangement is to have an autorecloser function SMBRREC (79) per circuit-breaker. They can be in different CB related IEDs or in a common IED.

- A master SMBRREC (79) function is set with *Priority = High*.
- A slave SMBRREC (79) function is set with *Priority = Low*.



See the application manual for an illustration of typical interconnections.

The two functions can be checked individually by carefully applying RI, WAIT, and INHIBIT signals.

It is also possible to verify the two functions together by using CB simulating equipment and two CB circuits. There should be interconnections from the master to the slave function, WFMMASTER - WAIT, and UNSUCCL - INHIBIT, as shown in the illustration referred to above.

Restoring equipment

After the tests, restore the equipment to normal or desired state. Check the following items in particular:

1. Check the operation counters.
Reset the counters to zero, if that is the user's preference. The counter reset function is found on the local HMI under **Main menu/Reset/Reset counters/AutoRecloser(RREC,79)/ARx**
2. Restore settings that may have been modified for the tests back to normal.
3. Disconnect the test switch, CB simulating arrangement and test circuits.
Reconnect any links or connection terminals, which may have been opened for the tests.
4. Reset indications, alarms and disturbance recordings.
Clearing of the disturbance report must be done via the Disturbance Handling in PCM600.

13.11.2.5

Completing the test

Continue to test another function or end the test by changing the *Test mode* setting to *Off*. Restore connections and settings to their original values, if they were changed for testing purposes.

13.11.3

Apparatus control APC

The apparatus control function consists of four types of function blocks, which are connected in a delivery-specific way between bays and to the station level. For that reason, test the total function in a system, that is, either in a complete delivery system as an acceptance test (FAT/SAT) or as parts of that system.



If a block/unblock command is sent from remote to function, while the IED is shut down, this command will not be recognized after the start up, thus the command that was sent prior to the shut down is used. In

such cases, where there is a mismatch, the user is advised to make a complete cycle of block/unblock operations to align the statuses.

13.11.4 Interlocking

Prepare the IED for verification of settings as outlined in section ["Overview"](#) and section ["Preparing for test"](#) in this chapter.

The interlocking function consists of a bay-level part and a station-level part. The interlocking is delivery specific and is realized by bay-to-bay communication over the station bus. For that reason, test the function in a system, that is, either in a complete delivery system as an acceptance test (FAT/SAT) or as parts of that system.

13.11.5 Single command SingleCommand16Signals

For the single command function block, it is necessary to configure the output signal to corresponding binary output of the IED. The operation of the single command function (SingleCommand16Signals) is then checked from the local HMI by applying the commands with *Mode = Off, Steady or Pulse*, and by observing the logic statuses of the corresponding binary output. Command control functions included in the operation of different built-in functions must be tested at the same time as their corresponding functions.

13.12 Scheme communication

13.12.1 Scheme communication logic for distance or overcurrent protection ZCPSCH (85)

Prepare the IED for verification of settings as outlined in section ["Overview"](#) and section ["Preparing for test"](#) in this chapter.

Check the scheme logic during the secondary injection test of the impedance or overcurrent protection functions.

Activating of the different zones verifies that the CS signal is issued from the intended zones. The CS signal from the independent tripping zone must have a *tSendMin* minimum time.

Check the tripping function by activating the CR and CR_GUARD inputs with the overreaching zone used to achieve the PLTR_CRD signal.

It is sufficient to activate the zones with only one type of fault with the secondary injection.

13.12.1.1 Testing permissive underreaching

Procedure

1. Activate the receive (CR) signal in the IED.
2. Apply healthy normal load conditions to the IED for at least two seconds.
3. Apply a fault condition within the permissive zone.
4. Check that correct trip outputs, external signals, and indications are obtained for the actual type of fault generated.
5. Check that other zones operate according to their zone timers and that the send (CS) signal is obtained only for the zone configured to generate the actual signal.
6. Deactivate the receive (CR) signal in the IED.
7. Check that the trip time complies with the zone timers and that correct trip outputs, external signals, and indications are obtained for the actual type of fault generated.

13.12.1.2 Testing permissive overreaching

Procedure

1. Activate the receive (CR) signal in the IED.
2. Apply healthy normal load conditions to the IED for at least two seconds.
3. Apply a fault condition within the permissive zone.
4. Check that correct trip outputs, external signals, and indication are obtained for the actual type of fault generated.
5. Check that the other zones operate according to their zone timer and that the send (CS) signal is obtained only for the zones that are configured to give the actual signal.
6. Deactivate the IED receive (CR) signal.
7. Apply healthy normal load conditions to the IED for at least two seconds.
8. Apply a fault condition within the permissive zone.
9. Check that trip time complies with the zone timers and that correct trip outputs, external signals, and indications are obtained for the actual type of fault generated.

13.12.1.3 Testing blocking scheme

Procedure

1. Deactivate the receive (CR) signal of the IED.
2. Apply healthy normal load conditions to the IED for at least two seconds.
3. Apply a fault condition within the forward directed zone used for scheme communication tripping.
4. Check that correct trip outputs and external signals are obtained for the type of fault generated and that the operate time complies with the *tCoord* timer (plus relay measuring time).
5. Check that the other zones operate according to their zone times and that a send (CS) signal is only obtained for the reverse zone.
6. Activate the IED receive (CR) signal.
7. Apply a fault condition in the forward directed zone used for scheme communication tripping.
8. Check that the no trip from scheme communication occurs.
9. Check that the trip time from the forward directed zone used for scheme communication tripping complies with the zone timer and that correct trip outputs, external signals, and indications are obtained for the actual type of fault generated.

13.12.1.4 Checking of unblocking logic

Check the unblocking function (if the function is required) when checking the communication scheme.

Command function with continuous unblocking (*Unblock* = 1)

Procedure

1. Activate the guard input signal (CR_GUARD) of the IED.
2. Using the scheme selected, check that a signal accelerated trip (TRIP) is obtained when the guard signal is deactivated.

13.12.1.5 Completing the test

Continue to test another function or end the test by changing the *Test mode* setting to *Off*. Restore connections and settings to their original values, if they were changed for testing purposes.

13.12.2 Current reversal and weak-end infeed logic for distance protection ZCRWPSCH (85)

Prepare the IED for verification of settings as outlined in section ["Overview"](#) and section ["Preparing for test"](#) in this chapter.

The current reversal logic and the weak-end infeed functions are tested during the secondary-injection test of the impedance or overcurrent protection zones together with the scheme communication logic for the distance protection function ZCPSCH (85).

13.12.2.1

Current reversal logic

It is possible to check the delay of the CS send signal with $tDelayRev$ by changing from a reverse to a forward fault.

By continuously activating the CR input and changing from a reverse to a forward fault, the delay $tDelayRev$ can be checked.

Checking of current reversal



The reverse zone timer must not operate before the forward zone fault is applied. The user might need to block the reverse zone timer during testing of current reversal.



The forward zone timer must be set longer than 90ms.

Procedure

1. Activate the receive (CRL) signal.
2. Set the healthy condition to an impedance at 50% of the reach of the reverse zone connected to IRVL.
3. After the pickup condition is obtained for reverse zone, apply a fault at 50% of the reach of the forward zone connected to WEIBLK1.
4. Check that correct trip outputs and external signals are obtained for the type of fault generated.
The operation time should be about the $tDelayRev$ setting longer than the carrier accelerated trip (TRIP) previously recorded for permissive scheme communication.
5. Restore the forward and reverse zone timer to its original setting.

13.12.2.2

Weak end infeed logic

Weak-end infeed logic at permissive schemes

Procedure

1. Check the blocking of the echo with the injection of a CRL signal >40ms after a reverse fault is applied.
2. Measure the duration of the echoed signal by applying a CRL receive signal.
3. Check the trip functions and the voltage level for trip by reducing a phase voltage and applying a CRL receive signal.

Testing conditions

Only one type of fault is sufficient, with the current reversal and weak-end infeed logic for distance protection function ZCRWPSCH (85). Apply three faults (one in each phase), when the phase segregated scheme communication logic for distance protection function ZC1PPSCH (85) is used. For phase A-G fault, set these parameters:

Table 28: Phase A-G parameter values

Phase	I (Amps)	Phase-angle (Deg)	V (Volts)	Phase-angle (Deg)
A	0	0	Set less than <i>UPN<PU27PN</i>	0
B	0	240	69.3	240
C	0	120	69.3	120

Change all settings cyclically for other faults (BG andCG).

Weak-end infeed set for trip

Weak-end infeed set for echo

1. Apply input signals according table [28](#).
2. Activate the receive (CR) signal.
3. After the IED has operated, turn off the input signals.
4. Check that trip, send signal, and indication are obtained.
(note: a 200mS pulse)
5. Apply input signals according table [28](#).
6. Activate the receive (CR) signal.
7. After the IED has operated turn off the input signals.
8. Check that the send signal is obtained.

13.12.2.3

Completing the test

Continue to test another function or end the test by changing the *Test mode* setting to *Off*. Restore connections and settings to their original values, if they were changed for testing purposes.

13.12.3 Local acceleration logic ZCLCPLAL

Prepare the IED for verification of settings as outlined in section ["Overview"](#) and section ["Preparing for test"](#) in this chapter.

The logic is checked during the secondary injection test of the impedance measuring zones.

13.12.3.1 Verifying the settings

Procedure

1. Provide the IED with conditions equivalent to normal load for at least two seconds.
2. Deactivate the conditions for accelerated function.
3. Apply a phase-to-ground fault at 100% of line impedance.
4. Check that the fault is tripped with the second zone time delay.
5. Provide the IED with conditions equivalent to normal load for at least two seconds.
6. Activate the condition for accelerated function either by the autorecloser or by the loss-of-load.
7. Apply a phase-to-ground fault at 100% of line impedance.
8. Check that the fault is tripped instantaneously.

13.12.3.2 Completing the test

Continue to test another function or end the test by changing the *Test mode* setting to *Off*. Restore connections and settings to their original values, if they were changed for testing purposes.

13.12.4 Scheme communication logic for residual overcurrent protection ECPSCH (85)

Prepare the IED for verification of settings as outlined in section ["Overview"](#) and section ["Preparing for test"](#) in this chapter.

Before testing the communication logic for residual overcurrent protection function ECPSCH (85), the four step residual overcurrent protection function EF4PTOC (51N/67N) has to be tested according to the corresponding instruction. Once this is done, continue with the instructions below.

If the current reversal and weak-end infeed logic for ground-fault protection is included, proceed with the testing according to the corresponding instruction after the testing the communication logic for residual overcurrent protection. The current reversal and weak-end-infeed functions shall be tested together with the permissive scheme.

13.12.4.1**Testing the directional comparison logic function****Blocking scheme**

Procedure

1. Inject the polarizing voltage $3V_0$ at 5% of V_{Base} (EF4PTOC, 51N67N) where the current is lagging the voltage by 65° .
2. Inject current (65° lagging the voltage) in one phase at about 110% of the set operating current, and switch the current off with the switch.
3. Switch the fault current on and measure the operating time of the communication logic.
Use the TRIP signal from the configured binary output to stop the timer.
4. Compare the measured time with the set value t_{Coord} .
5. Activate the CR binary input.
6. Check that the CRL output is activated when the CR input is activated.
7. Switch the fault current on (110% of the set operating current) and wait longer than the set value t_{Coord} .



No TRIP signal should appear.

8. Switch the fault current off.
9. Reset the CR binary input.
10. Activate the BLOCK digital input.
11. Switch the fault current on (110% of the set operating current) and wait for a period longer than the set value t_{Coord} .



No TRIP signal should appear.

12. Switch the fault current and the polarizing voltage off.
13. Reset the BLOCK digital input.

Permissive scheme

Procedure

1. Inject the polarizing voltage $3V_0$, which is 5% of $U_{Base}V_{Base}$ (EF4PTOC, 51N67N) where the current is lagging the voltage by 65° .
2. Inject current (65° lagging the voltage) into one phase at about 110% of the set operating current, and switch the current off with the switch.
3. Switch the fault current on, (110% of the set operating current) and wait longer than the set value t_{Coord} .



No TRIP signal should appear, and the CS binary output should be activated.

4. Switch the fault current off.
5. Activate the CR binary input.
6. Switch the fault current on (110% of the set operating current) and measure the operating time of the ECPSCH (85) logic.
Use the TRIP signal from the configured binary output to stop the timer.
7. Compare the measured time with the setting for t_{Coord} .
8. Activate the BLOCK digital input.
9. Switch the fault current on (110% of the set operating current) and wait for a period longer than the set value t_{Coord} .



No TRIP signal should appear.

10. Switch the fault current and the polarizing voltage off.
11. Reset the CR binary input and the BLOCK digital input.

13.12.4.2

Completing the test

Continue to test another function or end the test by changing the *Test mode* setting to *Off*. Restore connections and settings to their original values, if they were changed for testing purposes.

13.12.5

Current reversal and weak-end infeed logic for residual overcurrent protection ECRWPSCH (85)

Prepare the IED for verification of settings as outlined in section ["Overview"](#) and section ["Preparing for test"](#) in this chapter.

First, test the four step residual overcurrent protection function EF4PTOC (51N/67N) and then the current reversal and weak-end infeed logic according to the corresponding instructions. Then continue with the instructions below.

13.12.5.1

Testing the current reversal logic

1. Inject the polarizing voltage 3V0 to 5% of V_{Base} (EF4PTOC, 51N67N) and the phase angle between voltage and current to 155° , the current leading the voltage.
2. Inject current (155° leading the voltage) in one phase to about 110% of the set operating current of the four step residual overcurrent protection ($INDir$).
3. Check that the IRVL output is activated after the set time ($tPickUpRev$).
4. Abruptly reverse the current to 65° lagging the voltage, to operate the forward directional element.
5. Check that the IRVL output still is activated after the reversal with a time delay that complies with the setting ($tDelayRev$).
6. Switch off the polarizing voltage and the current.

13.12.5.2

Testing the weak-end infeed logic

If setting $WEI = Echo$

1. Inject the polarizing voltage 3V0 to 5% of V_{Base} and the phase angle between voltage and current to 155° , the current leading the voltage.
2. Inject current (155° leading the voltage) in one phase to about 110% of the setting operating current ($INDir$).
3. Activate the CRL binary input.



No ECHO and CS should appear.

4. Abruptly reverse the current to 65° lagging the voltage, to operate the forward directional element.



No ECHO and CS should appear.

5. Switch off the current and check that the ECHO and CS appear on the corresponding binary output or on the local HMI, about 200ms after resetting the directional element.
6. Switch off the CRL binary input.
7. Activate the BLOCK binary input.
8. Activate the CRL binary input.



No ECHO and CS should appear.

9. Switch off the polarizing voltage and reset the BLOCK and CRL binary input.

If setting *WEI = Echo & Trip*

Procedure

1. Inject the polarizing voltage 3V0 to about 90% of the setting (*3V0PU*) operating voltage.
2. Activate the CRL binary input.



No ECHO, CS and TRWEI outputs should appear.

3. Increase the injected voltage to about 110% of the setting (*3V0PU*) operating voltage.
4. Activate the CRL binary input.
5. Check that the ECHO, CS and TRWEI appear on the corresponding binary output or on the local HMI.
6. Reset the CRL binary input.
7. Activate the BLOCK binary input.
8. Activate the CRL binary input.



No ECHO, CS and TRWEI outputs should appear.

9. Reset the CRL and BLOCK binary input.
10. Inject the polarizing voltage 3V0 to about 110% of the setting (*3V0PU*) and adjust the phase angle between the voltage and current to 155° , the current leading the voltage.
11. Inject current (155° leading the voltage) in one phase to about 110% of the setting operating current (*INDir*).
12. Activate the CRL binary input.



No ECHO, CS and TRWEI should appear.

13. Abruptly reverse the current to 65° lagging the voltage, to operate the forward directional element.



No ECHO, CS and TRWEI should appear.

14. Switch the current off and check that the ECHO, CS and TRWEI appear on the corresponding binary output or on the local HMI, about 200ms after resetting the directional element.
15. Switch the polarizing voltage off and reset the CRL binary input.

13.12.5.3

Completing the test

Continue to test another function or end the test by changing the *Test mode* setting to *Off*. Restore connections and settings to their original values, if they were changed for testing purposes.

13.13

Logic

13.13.1

Tripping logic SMPPTRC (94)

Prepare the IED for verification of settings as outlined in section ["Overview"](#) and section ["Preparing for test"](#) in this chapter.

This function is functionality tested together with other protection functions (line differential protection, ground-fault overcurrent protection, and so on) within the IED. It is recommended that the function is tested together with the autorecloser function, when built into the IED or when a separate external unit is used for reclosing purposes. The instances of SMPPTRC (94) are identical except for the name of the function block SMPPTRC (94). The testing is preferably done in conjunction with the protection system and autoreclosing function.

13.13.1.1

Three phase operating mode

1. Check that *AutoLock* and *TripLockout* are both set to *Off*.
2. Initiate a three-phase fault

An adequate time interval between the faults should be considered, to overcome areset time caused by the possible activation of the Autorecloser function SMBRREC (79). The function must issue a three-pole trip in all cases, when trip is initiated by any protection or some other built-in or external function. The following functional output signals must always appear simultaneously: TRIP, TR_A, TR_B, TR_C and TR3P.

13.13.1.2 1ph/3ph operating mode

In addition to various other tests, the following tests should be performed. They depend on the complete configuration of an IED:

Procedure

1. Make sure that *TripLockout* and *AutoLock* are both set to *Off*.
2. Initiate different single-phase-to-ground faults one at a time.
3. Initiate different phase-to-phase and three-phase faults.
Consider using an adequate time interval between faults, to overcome a reset time, which is activated by SMBRREC (79). A three-pole trip should occur for each separate fault and all of the trips. Functional outputs TRIP, all TR_A, TR_B, TR_C and TR3P should be active at each fault.



No other outputs should be active.

4. Initiate a single-phase-to-ground fault and switch it off immediately when the trip signal is issued for the corresponding phase. Initiate the same fault once again within the reset time of the used SMBRREC (79).
5. Initiate a single phase-to-ground fault and switch it off immediately when the trip signal is issued for the corresponding phase. Initiate the second single phase-to-ground fault in one of the remaining phases within the time interval, shorter than *tEvolvingFault* (default setting 2.0s) and shorter than the dead-time of SMBRREC (79), when included in the protection scheme.
Check that the second trip is a three-pole trip and that a three-phase autoreclosing attempt is given after the three-phase dead time. Functional outputs TRIP, TR_A, TR_B, TR_C and TR1P should be active during the first fault. No other outputs should be active. Functional outputs TRIP, all TR_A, TR_B, TR_C and TR3P should be active during second fault.

13.13.1.3 1ph/2ph/3ph operating mode

In addition to other tests, the following tests, which depend on the complete configuration of an IED, should be carried out.

Procedure

1. Make sure that *AutoLock* and *TripLockout* are both set to *Off*.
2. Initiate different single-phase-to-ground faults one at a time.
Take an adequate time interval between faults into consideration, to overcome a reset time, which is activated by the autorecloser function SMBRREC (79). Only

a single-pole trip should occur for each separate fault and only one of the trip outputs (TR_A, TR_B, TR_C) should be activated at a time. Functional outputs TRIP and TR1P should be active at each fault. No other outputs should be active.

3. Initiate different phase-to-phase faults one at a time.
Take an adequate time interval between faults into consideration, to overcome a reset time which is activated by SMBRREC (79). Only a two-phase trip should occur for each separate fault and only corresponding two trip outputs (TR_A, TR_B, TR_C) should be activated at a time. Functional outputs TRIP and TR2P should be active at each fault. No other outputs should be active.
4. Initiate a three-phase fault.
5. Initiate a single-phase-to-ground fault and switch it off immediately when the trip signal is issued for the corresponding phase. Initiate the same fault once again within the reset time of the used SMBRREC (79).
A single-phase fault shall be given at the first fault. A three-pole trip must be initiated for the second fault. Check that the corresponding trip signals appear after both faults. Functional outputs TRIP, TR_A, TR_B, TR_C and TR1P should be active during first fault. No other outputs should be active. Functional outputs TRIP, all TR_A, TR_B, TR_C and TR3P should be active during second fault.
6. Initiate a single-phase-to-ground fault and switch it off immediately when the trip signal is generated for the corresponding phase. Initiate the second single-phase-to-ground fault in one of the remaining phases within the time interval, shorter than *tEvolvingFault* (default setting 2.0s) and shorter than the dead-time of SMBRREC (79), when included in the protection scheme.
7. Check, that the output signals, issued for the first fault, correspond to a two-phase trip for included phases. The output signals generated by the second fault must correspond to the three-phase tripping action.

13.13.1.4

Circuit breaker lockout

The following tests should be carried out when the built-in lockout function is used in addition to possible other tests, which depends on the complete configuration of an IED.

1. Check that *AutoLock* and *TripLockout* are both set to *Off*.
2. Activate shortly the set lockout (SETLKOUT) signal in the IED.
3. Check that the circuit breaker lockout (CLLKOUT) signal is set.
4. Activate shortly thereafter, the reset lockout (RSTLKOUT) signal in the IED.
5. Check that the circuit breaker lockout (CLLKOUT) signal is reset.
6. Initiate a three-phase fault.
A three- trip should occur and all trip outputs TR_A, TR_B, TR_C should be activated. Functional outputs TRIP and TR3P should be active at each fault. The output CLLKOUT should not be set.
7. Activate the automatic lockout function, set *AutoLock* = *On* and repeat
Beside the TRIP outputs, CLLKOUT should be set.

8. Reset the lockout signal by shortly thereafter activating the reset lockout (RSTLKOUT) signal.
9. Activate the trip signal lockout function, set *TripLockout = On* and repeat. All trip outputs (TR_A, TR_B, TR_C) and functional outputs TRIP and TR3P must be active and stay active after each fault, CLLKOUT should be set.
10. Repeat.
All functional outputs should reset.
11. Deactivate the TRIP signal lockout function, set *TripLockout = Off* and the automatic lockout function, set *AutoLock = Off*.

13.13.1.5 Completing the test

Continue to test another function or end the test by changing the *Test mode* setting to *Off*. Restore connections and settings to their original values, if they were changed for testing purposes.

13.14 Monitoring

13.14.1 Event counter CNTGGIO

The event counter function CNTGGIO can be tested by connecting a binary input to the counter under test and from outside apply pulses to the counter. The speed of pulses must not exceed 10 per second. Normally the counter will be tested in connection with tests on the function that the counter is connected to, such as trip logic. When configured, test it together with the function that operates it. Trig the function and check that the counter result is the same the number of operations.

13.14.2 Event function EVENT

Prepare the IED for verification of settings as outlined in section ["Overview"](#) and section ["Preparing for test"](#) in this chapter.

During testing, the IED can be set when in test mode from PST. The functionality of the event reporting during test mode is set in the Parameter Setting tool in PCM600.

- Use event masks
- Report no events
- Report all events

In test mode, individual event blocks can be blocked from PCM600.

Individually, event blocks can also be blocked from the local HMI under

Main menu/Test/Function test modes/Monitoring/EventCounter(GGIO)/CNTx

13.14.3

Fault locator LMBRFLO

Prepare the IED for verification of settings as outlined in section ["Overview"](#) and section ["Preparing for test"](#) in this chapter.

The fault locator function LMBRFLO depends on other functions to work properly, that is, phase selection information from distance protection function and analog information supplied by the trip value recorder function. Check that proper binary initiate (pickup or tripping) and phase selection signals are connected and voltage and current signals are configured (parameter settings).

The result is displayed on the local HMI or via PCM600. Distances to faults for the last 100 recorded disturbances can be found on the local HMI under **Main menu/ Disturbance Records/ Disturbance #n(n = 1–100)/ General Information**

If PCM600 is used, the result is displayed on the recording list after upload, including loop selection information.

Table 29: Test settings

Parameter	Condition
I	
Healthy conditions	$V = 69.3 \text{ V}$, $I = 0 \text{ A}$ & $ZF = 0^\circ$
Impedance Z	Test point Note: <ul style="list-style-type: none"> • $Z_x \leq (X_0 + 2 \cdot X_1)/3$ For single-phase faults • $Z_x \leq X_1$ For three and two phase faults • $Z_x \leq (X_0 + 2 \cdot X_1 X_M)/3$ For single-phase fault with mutual zero-sequence current
Impedance angle $Z\Phi$	Test angle <ul style="list-style-type: none"> • $Z\Phi \arctan[(X_0 + 2 \cdot X_1) / (R_0 + 2R_1)]$ For single-phase faults • $Z\Phi \arctan(X_1/R_1)$ For two-phase faults

13.14.3.1

Measuring the operate limit

Procedure

1. Set the test point (|Z| fault impedance and $Z\Phi$ impedance phase angle) for a condition that meets the requirements in table [29](#).
2. Subject the IED to healthy normal load conditions for at least two seconds.
3. Apply a fault condition.

Check that the distance-to-fault value displayed on the HMI complies with the following equations (the error should be less than five percent):

$$p = \frac{Z_x}{X1} \cdot 100$$

(Equation 18)

in % for two- and three-pole faults

$$p = \frac{3 \cdot Z_x}{X0 + 2 \cdot X1} \cdot 100$$

(Equation 19)

in % for single-phase-to-ground faults

$$p = \frac{3 \cdot Z_x}{X0 + 2 \cdot X1 \pm XM} \cdot 100$$

(Equation 20)

in % for single-phase-to-ground faults with mutual zero sequence current.

Where:

- p = the expected value of a distance to fault in percent
- Z_x = set test point on the test set
- X0 = set zero-sequence reactance of a line
- X1 = set positive-sequence reactance of a line
- XM = set mutual zero-sequence impedance of a line

13.14.3.2 Completing the test

Continue to test another function or end the test by changing the *Test mode* setting to *Off*. Restore connections and settings to their original values, if they were changed for testing purposes.

13.15 Metering

13.15.1 Pulse counter PCGGIO

The test of Pulse counter function (PCGGIO) requires the Parameter Setting tool in PCM600 or an appropriate connection to the local HMI with the necessary functionality. A known number of pulses with different frequencies are connected to the pulse counter input. The test should be performed with settings *Operation = On* or

Operation = Off and the function blocked or unblocked. The pulse counter value is then checked in PCM600 or on the local HMI.

13.16 Station communication

13.16.1 Multiple command and transmit MultiCmd/MultiTransm

The multiple command and transmit function (MultiCmd/MultiTransm) is only applicable for horizontal communication.

Test of the multiple command function block and multiple transmit is recommended to be performed in a system, that is, either in a complete delivery system as an acceptance test (FAT/SAT) or as parts of that system, because the command function blocks are connected in a delivery-specific way between bays and the station level and transmit.

Command and transmit function blocks included in the operation of different built-in functions must be tested at the same time as their corresponding functions.

13.17 Remote communication

13.17.1 Binary signal transfer BinSignReceive, BinSignTransm

Prepare the IED for verification of settings as outlined in section ["Overview"](#) and section ["Preparing for test"](#) in this chapter.

To perform a test of Binary signal transfer function (BinSignReceive/BinSignTransm), the hardware (LDCM) and binary input and output signals to transfer must be configured as required by the application.

There are two types of internal self supervision of BinSignReceive/BinSignTransm

- The I/O-circuit board is supervised as an I/O module. For example it generates FAIL if the board is not inserted. I/O-modules not configured are not supervised.
- The communication is supervised and the signal COMFAIL is generated if a communication error is detected.

Status for inputs and outputs as well as self-supervision status are available from the local HMI under

- Self-supervision status: **Main menu/Diagnostics/Internal events**
- Status for inputs and outputs: **Main menu/Test/Function status**, browse to the function group of interest.
- Remote communication related signals: **Main menu/Test/Function status/Communication/Remote communication**

Test the correct functionality by simulating different kind of faults. Also check that sent and received data is correctly transmitted and read.

A test connection is shown in figure 77. A binary input signal (BI) at End1 is configured to be transferred through the communication link to End2. At End2 the received signal is configured to control a binary output (BO). Check at End2 that the BI signal is received and the BO operates.

Repeat the test for all the signals configured to be transmitted over the communication link.

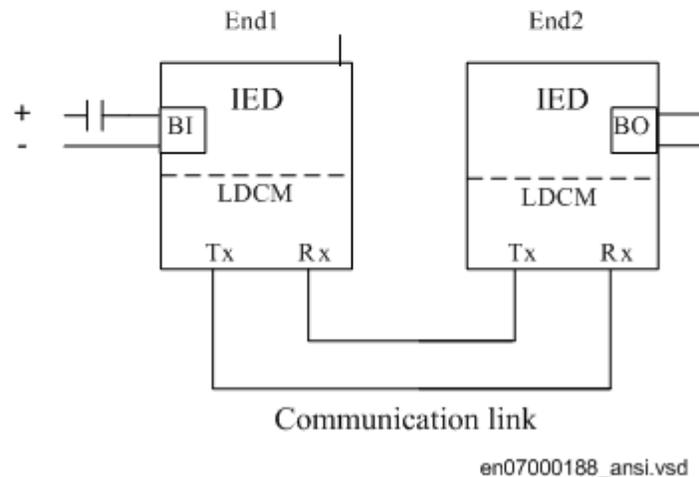


Figure 77: Test of RTC with I/O

Section 14 Commissioning and maintenance of the fault clearing system

About this chapter

This chapter discusses maintenance tests and other periodic maintenance measures.

14.1 Installation and commissioning

The protection IED is in an on-guard situation where the IED can be inactive for several years and then suddenly be required to operate within fractions of a second. This means that maintenance testing with certain time intervals should be performed to detect failures of the protection IED or the surrounding circuits. This is a complement to the advanced self supervision in the modern protection IED.

IEDs are not expected to deteriorate with usage but extreme conditions, such as mechanical shocks, AC or DC transients, high ambient temperatures, and high air humidity always have a certain likelihood of causing damages.

Delivered equipment undergoes extensive testing and quality control in the ABB manufacturing program. All types of IEDs and their integral components have been subject to extensive laboratory testing during the development and design work. Prior to series production of a specific IED, it is type tested according to national and international standards. Each individual IED in normal production is individually tested and calibrated before delivery.

Protection IEDs installed in an apparatus cubicle shall be checked in various ways before delivery. Insulation test (to check for bad wiring) and complete testing of all equipment with injection of currents and voltages is performed.

During the design of the station, certain steps shall be taken to limit the risk of failures, for example, all IED coils are connected to negative potential to ground to prevent contact corrosion due to electrolyte.

Certain circuits are continuously supervised to improve their availability. Examples of such supervisions are:

- Trip circuit supervision
- Protection DC supply supervision
- DC system ground fault supervision
- Busbar protection CT-circuit supervision

Protection IEDs shall be encapsulated according to environment requirements. In tropical climates, cubicles are provided with glass-door and ventilation louvres. Heaters for anti-condensation, often thermostatically controlled, are provided. Cubicle power-loss is limited not to exceed protection IED temperature limits, which is 55°C .

14.2 Commissioning tests

During commissioning all protection functions shall be verified with the setting values used at each plant. The commissioning tests must include verification of all circuits by highlighting the circuit diagrams and the configuration diagrams for the used functions.

Further, the settings for protection functions are tested and recorded carefully as outlined for the future periodic maintenance tests.

The final testing includes primary verification of all directional functions where load currents is checked on the local HMI and in PCM600.. The magnitudes and angles of all currents and voltages should be checked and the symmetry verified.

Directional functions have information about the measured direction and, for example, measured impedance. These values must be checked and verified as correct with the export or import of power available.

Finally, final trip tests must be performed. This involves activation of protection functions or tripping outputs with the circuit breaker closed and the tripping of the breaker verified. When several breakers are involved, each breaker must be checked individually and it must be verified that the other involved breakers are not tripped at the same time.

14.3 Periodic maintenance tests

The periodicity of all tests depends on several factors, for example the importance of the installation, environment conditions, simple or complex equipment, static or electromechanical IEDs, and so on.

The normal maintenance practices of the user should be followed. However ABB proposal is to test:

Every second to third year

- Visual inspection of all equipment.
- Removal of dust on ventilation louvres and IEDs if necessary.
- Periodic maintenance test for protection IEDs of object where no redundant protections are provided.

Every four to six years

- Periodic maintenance test for protection IEDs of objects with redundant protection system.



First maintenance test should always be carried out after the first half year of service.



When protection IEDs are combined with built-in control, the test interval can be increased drastically, up to for instance 15 years, because the IED continuously reads service values, operates the breakers, and so on.

14.3.1

Visual inspection

Prior to testing, the protection IEDs should be inspected to detect any visible damage that may have occurred (for example, dirt or moisture deposits, overheating). Should burned contacts be observed when inspecting the IEDs, a diamond file or an extremely fine file can be used to polish the contacts. Emery cloth or similar products must not be used as insulating grains of abrasive may be deposited on the contact surfaces and cause failure.

Make sure that all IEDs are equipped with covers.

14.3.2

Maintenance tests

To be made after the first half year of service, then with the cycle as proposed above and after any suspected maloperation or change of the IED setting.

Testing of protection IEDs shall preferably be made with the primary circuit de-energized. The IED cannot protect the circuit during testing. Trained personnel may test one IED at a time on live circuits where redundant protection is installed and de-energization of the primary circuit is not allowed.

ABB protection IEDs are preferably tested by aid of components from the COMBITEST testing system or FT test systems described in information B03-9510 E. Main components are RTXP 8/18/24 test switch located to the left in each protection IED and RTXH 8/18/24 test handle, which is inserted in test switch at secondary testing. All necessary operations such as opening of trip circuits, short-circuiting of current circuits and opening of voltage circuits are automatically performed in the right order to allow for simple and safe secondary testing even with the object in service.

Important components of FT test system are FT1, FTx, FT19, FT19RS, FR19RX switches and assemblies as well as FT-1 test plug.

14.3.2.1 Preparation

Before starting maintenance testing, the test engineers should scrutinize applicable circuit diagrams and have the following documentation available:

- Test instructions for protection IEDs to be tested
- Test records from previous commissioning and maintenance tests
- List of valid settings
- Blank test records to fill in measured values

14.3.2.2 Recording

It is of utmost importance to carefully record the test results. Special test sheets covering the frequency of test, date of test and achieved test values should be used. IED setting list and protocols from previous tests should be available and all results should be compared for differences. At component failures, spare equipment is used and set to the requested value. A note of the exchange is made and the new measured values are recorded. Test records for several years of testing should be stored in a common file for a station, or a part of a station, to give a simple overview of the period of testing and achieved test values. These test records are valuable when analysis of service disturbances shall be done.

14.3.2.3 Secondary injection

The periodic maintenance test is done by secondary injection from a portable test set. Each protection shall be tested according to the secondary injection test information for the specific protection IED. Only the setting values adopted shall be checked for each protection function. If the discrepancy between obtained value and requested set value is too big the setting should be adjusted, the new value recorded and a note should be made in the test record.

14.3.2.4

Alarm test

When inserting the test handle of RTXP or using FT plugs, the alarm and event signalling is normally blocked. This is done in the IED by setting the event reporting to *Off* during the test. This can be done when the test handle is inserted or the IED is set to test mode from the local HMI. At the end of the secondary injection test it should be checked that the event and alarm signalling is correct by activating the events and performing some selected tests.

14.3.2.5

Self supervision check

Once secondary testing has been completed, it should be checked that no self-supervision signals are activated continuously or sporadically. Especially check the time synchronization system, GPS or other, and communication signals, both station communication (61850/SPA/LON, and so on) and remote communication, for example, the line differential communication system.

14.3.2.6

Trip circuit check

When the protection IED undergoes an operational check, a tripping pulse is normally obtained on one or more of the output contacts and preferably on the test switch. The healthy circuit is of utmost importance for the protection operation. If the circuit is not provided with a continuous trip-circuit supervision, it is possible to check that circuit is really closed when the test-plug handle has been removed by using a high-ohmic voltmeter and measuring between the plus and the trip output on the panel. The measurement is then done through the tripping magnet of the circuit breaker and therefore the complete tripping circuit is checked.



Note, that the breaker must be closed.



Please observe that the test system does not have its built-in security during this test. If the instrument should be set on Amp instead of Volts, the circuit breaker naturally is tripped, therefore, greatest care is necessary.

Trip circuit from trip IEDs to circuit breaker is often supervised by trip-circuit supervision IED. It can then be checked that a circuit is healthy by opening tripping output terminals in the cubicle. When the terminal is opened, an alarm shall be achieved on the signal system after a delay of some seconds.



However, remember to close the circuit directly after the test and tighten the terminal carefully!

14.3.2.7 Measurement of service currents

After a maintenance test it is recommended to measure the service currents and service voltages recorded by the protection IED. The service values are checked on the local HMI or in PCM600. Ensure that the correct values and angles between voltages and currents are recorded. Also check the direction of directional functions such as Distance and directional overcurrent functions.

For transformer differential protection, the achieved differential current value is dependent on the tap changer position and can vary between less than 1% up to perhaps 10% of rated current. For line differential functions, the capacitive charging currents can normally be recorded as a differential current.

The zero-sequence current to ground-fault protection IEDs should be measured. The current amounts normally very small but normally it is possible to see if the current circuit is "alive".

The neutral-point voltage to an ground-fault IED is checked. The voltage is normally 0.1 to 1V secondary. However, voltage can be considerably higher due to harmonics. Normally a CVT secondary can have around 2.5 - 3% third-harmonic voltage.

14.3.2.8 Restoring

Maintenance is very important to improve the availability of the protection system by detecting failures before the protection is required to operate. There is however little point in testing healthy equipment and then putting it back into service with an open terminal, with a removed fuse or open miniature circuit breaker with an open connection, wrong setting, and so on.

Thus a list should be prepared of all items disturbed during test so that all can be put back into service quickly and without overlooking something. It should be put back into service item by item and signed by the responsible engineer.

Section 15 Fault tracing and repair

About this chapter

This chapter describes how to carry out fault tracing and if necessary, a change of circuit board.

15.1 Fault tracing

15.1.1 Information on the local HMI

If an internal fault has occurred, the local HMI displays information under **Main menu/Diagnostics/IED status/General**

Under the Diagnostics menus, indications of a possible internal failure (serious fault) or internal warning (minor problem) are listed.

Indications regarding the faulty unit are outlined in table [30](#).

Table 30: *Self-supervision signals on the local HMI*

HMI Signal Name:	Status	Description
INT Fail	OFF / ON	This signal will be active if one or more of the following internal signals are active; INT--NUMFAIL, INT--LMDERROR, INT--WATCHDOG, INT--APPERROR, INT--RTEERROR, INT--FTFERROR, or any of the HW dependent signals
INT Warning	OFF / ON	This signal will be active if one or more of the following internal signals are active; INT--RTCERROR, INT--IEC61850ERROR, INT--TIMESYNCHERROR
NUM Fail	OFF / ON	This signal will be active if one or more of the following internal signals are active; INT--WATCHDOG, INT--APPERROR, INT--RTEERROR, INT--FTFERROR
NUM Warning	OFF / ON	This signal will be active if one or more of the following internal signals are active; INT--RTCERROR, INT--IEC61850ERROR
Table continues on next page		

HMI Signal Name:	Status	Description
ADMnn	READY / FAIL	Analog input module n failed. Signal activation will reset the IED
BIMnn	READY / FAIL	BIM error. Binary input module Error status. Signal activation will reset the IED
BOMn	READY / FAIL	BOM error. Binary output module Error status.
IOMn	READY / FAIL	IOM-error. Input/Output Module Error status.
MIMn	READY / FAIL	mA input module MIM1 failed. Signal activation will reset the IED
RTC	READY / FAIL	This signal will be active when there is a hardware error with the real time clock.
Time Sync	READY / FAIL	This signal will be active when the source of the time synchronization is lost, or when the time system has to make a time reset.
Application	READY / FAIL	This signal will be active if one or more of the application threads are not in the state that Runtime Engine expects. The states can be CREATED, INITIALIZED, RUNNING, etc.
RTE	READY / FAIL	This signal will be active if the Runtime Engine failed to do some actions with the application threads. The actions can be loading of settings or parameters for components, changing of setting groups, loading or unloading of application threads.
IEC61850	READY / FAIL	This signal will be active if the IEC61850 stack did not succeed in some actions like reading IEC61850 configuration, startup etc.
LMD	READY / FAIL	LON network interface, MIP/DPS, is in an unrecoverable error state.
LDCMxxx	READY / FAIL	Line Differential Communication Error status
OEM	READY / FAIL	Optical Ethernet Module error status.

Also the internal signals, such as INT--FAIL and INT--WARNING can be connected to binary output contacts for signalling to a control room.

In the IED Status - Information, the present information from the self-supervision function can be viewed. Indications of failure or warnings for each hardware module are provided, as well as information about the external time synchronization and the internal clock. All according to table 30. Loss of time synchronization can be considered as a warning only. The IED has full functionality without time synchronization.

15.1.2 Using front-connected PC or SMS

Here, two summary signals appear, self-supervision summary and numerical module status summary. These signals can be compared to the internal signals as:

- Self-supervision summary = INT--FAIL and INT--WARNING
- CPU-module status summary = INT--NUMFAIL and INT--NUMWARN

When an internal fault has occurred, extensive information about the fault can be retrieved from the list of internal events available in the SMS part:

TRM-STAT TermStatus - Internal Events

The list of internal events provides valuable information, which can be used during commissioning and fault tracing.

The internal events are time tagged with a resolution of 1ms and stored in a list. The list can store up to 40 events. The list is based on the FIFO principle, when it is full, the oldest event is overwritten. The list cannot be cleared and its content cannot be erased.

The internal events in this list not only refer to faults in the IED, but also to other activities, such as change of settings, clearing of disturbance reports, and loss of external time synchronization.

The information can only be retrieved from the Parameter Setting software package. The PC can be connected either to the port at the front or at the rear of the IED.

These events are logged as internal events.

Table 31: Events available for the internal event list in the IED

Event message:		Description	Generating signal:
INT--FAIL	Off	Internal fail status	INT--FAIL (reset event)
INT--FAIL			INT--FAIL (set event)
INT--WARNING	Off	Internal warning status	INT--WARNING (reset event)
INT--WARNING			INT--WARNING (set event)
INT--NUMFAIL	Off	Numerical module fatal error status	INT--NUMFAIL (reset event)
INT--NUMFAIL			INT--NUMFAIL (set event)
INT--NUMWARN	Off	Numerical module non-fatal error status	INT--NUMWARN (reset event)
INT--NUMWARN			INT--NUMWARN (set event)
IOn--Error	Off	In/Out module No. n status	IOn--Error (reset event)
IOn--Error			IOn--Error (set event)

Table continues on next page

Event message:		Description	Generating signal:
ADMn-Error	Off	Analog/Digital module No. n status	ADMn-Error (reset event)
ADMn-Error			ADMn-Error (set event)
MIM1-Error	Off	mA-input module status	MIM1-Error (reset event)
MIM1-Error			MIM1-Error (set event)
INT--RTC	Off	Real Time Clock (RTC) status	INT--RTC (reset event)
INT--RTC			INT--RTC (set event)
INT--TSYNC	Off	External time synchronization status	INT--TSYNC (reset event)
INT--TSYNC			INT--TSYNC (set event)
INT--SETCHGD		Any settings in IED changed	
DRPC-CLEARED		All disturbances in Disturbance report cleared	

The events in the internal event list are time tagged with a resolution of 1ms.

This means that, when using the PC for fault tracing, it provides information on the:

- Module that should be changed.
- Sequence of faults, if more than one unit is faulty.
- Exact time when the fault occurred.

15.2

Repair instruction



Never disconnect the secondary connection of a current transformer circuit without short-circuiting the transformer's secondary winding. Operating a current transformer with the secondary winding open will cause a massive potential build up that may damage the transformer and may cause injuries to humans.



Never connect or disconnect a wire and/or a connector to or from a IED during normal service. Hazardous voltages and currents are present that may be lethal. Operation may be disrupted and IED and measuring circuitry may be damaged.

An alternative is to open the IED and send only the faulty circuit board to ABB for repair. When a printed circuit board is sent to ABB, it must always be placed in a

metallic, ESD-proof, protection bag. The user can also purchase separate replacement modules.



Strictly follow the company and country safety regulations.

Most electronic components are sensitive to electrostatic discharge and latent damage may occur. Please observe usual procedures for handling electronics and also use an ESD wrist strap. A semi-conducting layer must be placed on the workbench and connected to ground.

Disassemble and reassemble the IED accordingly:

1. Switch off the dc supply.
2. Short-circuit the current transformers and disconnect all current and voltage connections from the IED.
3. Disconnect all signal wires by removing the female connectors.
4. Disconnect the optical fibers.
5. Unscrew the main back plate of the IED.
6. If the transformer module is to be changed:
 - Remove the IED from the panel if necessary.
 - Remove the rear plate of the IED.
 - Remove the front plate.
 - Remove the screws of the transformer input module, both front and rear.
7. Pull out the faulty module.
8. Check that the new module has a correct identity number.
9. Check that the springs on the card rail are connected to the corresponding metallic area on the circuit board when the new module is inserted.
10. Reassemble the IED.

If the IED has been calibrated with the system inputs, the calibration procedure must be performed again to maintain the total system accuracy.

15.3 Repair support

If an IED needs to be repaired, the whole IED must be removed and sent to an ABB Logistic Center. Please contact the local ABB representative to get more details.

15.4 Maintenance

The IED is self-supervised. No special maintenance is required.

Instructions from the power network company and other maintenance directives valid for maintenance of the power system must be followed.

Section 16 Glossary

About this chapter

This chapter contains a glossary with terms, acronyms and abbreviations used in ABB technical documentation.

AC	Alternating current
ACT	Application configuration tool within PCM600
A/D converter	Analog to digital converter
ADBS	Amplitude dead-band supervision
ADM	Analog digital conversion module, with time synchronization
ANSI	American National Standards Institute
AR	Autoreclosing
AngNegRes	Setting parameter/ZD/
ArgDirAngDir	Setting parameter/ZD/
ASCT	Auxiliary summation current transformer
ASD	Adaptive signal detection
AWG	American Wire Gauge standard
BBP	Busbar protection
BFP	Breaker failure protection
BIM	Binary input module
BOM	Binary output module
BR	External bi-stable relay
BS	British standard
BSR	Binary signal transfer function, receiver blocks
BST	Binary signal transfer function, transmit blocks
C37.94	IEEE/ANSI protocol used when sending binary signals between IEDs
CAN	Controller Area Network. ISO standard (ISO 11898) for serial communication
CB	Circuit breaker

CBM	Combined backplane module
CCITT	Consultative Committee for International Telegraph and Telephony. A United Nations sponsored standards body within the International Telecommunications Union.
CCM	CAN carrier module
CCVT	Capacitive Coupled Voltage Transformer
Class C	Protection Current Transformer class as per IEEE/ ANSI
CMPPS	Combined mega pulses per second
CO cycle	Close-open cycle
Co-directional	Way of transmitting G.703 over a balanced line. Involves two twisted pairs making it possible to transmit information in both directions
COMTRADE	Standard Common Format for Transient Data Exchange format for Disturbance recorder according to IEEE/ANSI C37.111, 1999 / IEC60255-24
Contra-directional	Way of transmitting G.703 over a balanced line. Involves four twisted pairs of which two are used for transmitting data in both directions, and two pairs for transmitting clock signals
CPU	Central processor unit
CR	Carrier receive
CRC	Cyclic redundancy check
CS	Carrier send
CT	Current transformer
CVT or CCVT	Capacitive voltage transformer
DAR	Delayed auto-reclosing
DARPA	Defense Advanced Research Projects Agency (The US developer of the TCP/IP protocol etc.)
DBDL	Dead bus dead line
DBLL	Dead bus live line
DC	Direct current
DFT	Discrete Fourier transform
DIP-switch	Small switch mounted on a printed circuit board
DLLB	Dead line live bus
DNP	Distributed Network Protocol as per IEEE/ANSI Std. 1379-2000

DR	Disturbance recorder
DRAM	Dynamic random access memory
DRH	Disturbance report handler
DSP	Digital signal processor
DTT	Direct transfer trip scheme
EHV network	Extra high voltage network
EIA	Electronic Industries Association
EMC	Electro magnetic compatibility
EMF	Electro motive force
EMI	Electro magnetic interference
EnFP	End fault protection
ESD	Electrostatic discharge
FOX 20	Modular 20 channel telecommunication system for speech, data and protection signals
FOX 512/515	Access multiplexer
FOX 6Plus	Compact, time-division multiplexer for the transmission of up to seven duplex channels of digital data over optical fibers
G.703	Electrical and functional description for digital lines used by local telephone companies. Can be transported over balanced and unbalanced lines
GCM	Communication interface module with carrier of GPS receiver module
GDE	Graphical display editor within PCM600
GI	General interrogation command
GIS	Gas insulated switchgear
GOOSE	Generic object oriented substation event
GPS	Global positioning system
GSM	GPS time synchronization module
HDLC protocol	High level data link control, protocol based on the HDLC standard
HFBR connector type	Plastic fiber connector
HMI	Human machine interface
HSAR	High speed auto reclosing

HV	High voltage
HVDC	High voltage direct current
IDBS	Integrating dead band supervision
IEC	International Electrical Committee
IEC 60044-6	IEC Standard, Instrument transformers – Part 6: Requirements for protective current transformers for transient performance
IEC 60870-5-103	Communication standard for protective equipment. A serial master/slave protocol for point-to-point communication
IEC 61850	Substation Automation communication standard
IEEE	Institute of Electrical and Electronics Engineers
IEEE 802.12	A network technology standard that provides 100 Mbits/s on twisted-pair or optical fiber cable
IEEE P1386.1	PCI Mezzanine card (PMC) standard for local bus modules. References the CMC (IEEE P1386, also known as Common mezzanine card) standard for the mechanics and the PCI specifications from the PCI SIG (Special Interest Group) for the electrical EMF Electro Motive Force.
IED	Intelligent electronic device
I-GIS	Intelligent gas insulated switchgear
IOM	Binary input/output module
Instance	When several occurrences of the same function are available in the IED they are referred to as instances of that function. One instance of a function is identical to another of the same kind but will have a different number in the IED user interfaces. The word instance is sometimes defined as an item of information that is representative of a type. In the same way an instance of a function in the IED is representative of a type of function.
IP	<ol style="list-style-type: none"> 1. Internet protocol. The network layer for the TCP/IP protocol suite widely used on Ethernet networks. IP is a connectionless, best-effort packet switching protocol. It provides packet routing, fragmentation and re-assembly through the data link layer. 2. Ingression protection according to IEC standard
IP 20	Ingression protection, according to IEC standard, level IP20- Protected against solidforeign objects of12.5mm diameter andgreater.

IP 40	Ingression protection, according to IEC standard, level IP40-Protected against solid foreign objects of 1mm diameter and greater.
IP 54	Ingression protection, according to IEC standard, level IP54-Dust-protected,protected againstsplashing water.
IRF	Internal fail signal
IRIG-B:	InterRange Instrumentation Group Time code format B, standard 200
ITU	International Telecommunications Union
LAN	Local area network
LIB 520	High voltage software module
LCD	Liquid crystal display
LDCM	Line differential communication module
LDD	Local detection device
LED	Light emitting diode
LNT	LON network tool
LON	Local operating network
MCB	Miniature circuit breaker
MCM	Mezzanine carrier module
MIM	Milli-ampere module
MPM	Main processing module
MVB	Multifunction vehicle bus. Standardized serial bus originally developed for use in trains.
NCC	National Control Centre
NUM	Numerical module
OCO cycle	Open-close-open cycle
OCP	Overcurrent protection
OEM	Optical ethernet module
OLTC	On load tap changer
OV	Over voltage
Overreach	A term used to describe how the relay behaves during a fault condition. For example a distance relay is over-reaching when the impedance presented to it is smaller than the apparent impedance to the fault applied to the balance point, i.e. the set

	reach. The relay “sees” the fault but perhaps it should not have seen it.
PCI	Peripheral component interconnect, a local data bus
PCM	Pulse code modulation
PCM600	Protection and control IED manager
PC-MIP	Mezzanine card standard
PISA	Process interface for sensors & actuators
PMC	PCI Mezzanine card
POTT	Permissive overreach transfer trip
Process bus	Bus or LAN used at the process level, that is, in near proximity to the measured and/or controlled components
PSM	Power supply module
PST	Parameter setting tool within PCM600
PT ratio	Potential transformer or voltage transformer ratio
PUTT	Permissive underreach transfer trip
RASC	Synchrocheck relay, COMBIFLEX
RCA	Relay characteristic angle
REVAL	Evaluation software
RFPP	Resistance for phase-to-phase faults Resistance for phase-to-ground faults
RISC	Reduced instruction set computer
RMS value	Root mean square value
RS422	A balanced serial interface for the transmission of digital data in point-to-point connections
RS485	Serial link according to EIA standard RS485
RTC	Real time clock
RTU	Remote terminal unit
SA	Substation Automation
SC	Switch or push-button to close
SCS	Station control system
SCT	System configuration tool according to standard IEC 61850
SLM	Serial communication module. Used for SPA/LON/IEC communication.

SMA connector	Subminiature version A, A threaded connector with constant impedance.
SMT	Signal matrix tool within PCM600
SMS	Station monitoring system
SNTP	Simple network time protocol – is used to synchronize computer clocks on local area networks. This reduces the requirement to have accurate hardware clocks in every embedded system in a network. Each embedded node can instead synchronize with a remote clock, providing the required accuracy.
SPA	Strömberg protection acquisition, a serial master/slave protocol for point-to-point communication
SRY	Switch for CB ready condition
ST	Switch or push-button to trip
Starpoint	Neutral/Wye point of transformer or generator
SVC	Static VAr compensation
TC	Trip coil
TCS	Trip circuit supervision
TCP	Transmission control protocol. The most common transport layer protocol used on Ethernet and the Internet.
TCP/IP	Transmission control protocol over Internet Protocol. The de facto standard Ethernet protocols incorporated into 4.2BSD Unix. TCP/IP was developed by DARPA for internet working and encompasses both network layer and transport layer protocols. While TCP and IP specify two protocols at specific protocol layers, TCP/IP is often used to refer to the entire US Department of Defense protocol suite based upon these, including Telnet, FTP, UDP and RDP.
TEF	Time delayed ground-fault protection function
TNC connector	Threaded Neill Concelman, A threaded constant impedance version of a BNC connector
TPZ, TPY, TPX, TPS	Current transformer class according to IEC
Underreach	A term used to describe how the relay behaves during a fault condition. For example a distance relay is under-reaching when the impedance presented to it is greater than the apparent impedance to the fault applied to the balance point, i.e. the set

	reach. The relay does not “see” the fault but perhaps it should have seen it. See also Overreach.
U/I-PISA	Process interface components that deliver measured voltage and current values
UTC	Coordinated universal time. A coordinated time scale, maintained by the Bureau International des Poids et Mesures (BIPM), which forms the basis of a coordinated dissemination of standard frequencies and time signals. UTC is derived from International Atomic Time (TAI) by the addition of a whole number of "leap seconds" to synchronize it with Universal Time 1 (UT1), thus allowing for the eccentricity of the Earth's orbit, the rotational axis tilt (23.5 degrees), but still showing the Earth's irregular rotation, on which UT1 is based. The Coordinated Universal Time is expressed using a 24-hour clock and uses the Gregorian calendar. It is used for aeroplane and ship navigation, where it also sometimes known by the military name, "Zulu time". "Zulu" in the phonetic alphabet stands for "Z" which stands for longitude zero.
UV	Undervoltage
WEI	Weak end infeed logic
VT	Voltage transformer
X.21	A digital signalling interface primarily used for telecom equipment
3I₀	Three times zero-sequence current. Often referred to as the residual or the -fault current
	Three times the zero sequence voltage. Often referred to as the residual voltage or the neutral point voltage

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